

Datacenter NVMe® SSD Specification

Version 2.5r9 (11042022)

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Table of Contents

1	OCP.	5	
	1.1	LICENSE OWF OPTION5	
	1.2	System Firmware	
	1.3	HARDWARE MANAGEMENT6	
	1.3.1	Compliance	6
	1.3.2	BMC Source Availability (if applicable)	6
	1.4	SECURITY6	
2	OVER	VIEW6	
3	SCOP	E6	
4	NVM	EXPRESS REQUIREMENTS6	
	4.1	Overview6	
	4.2	NVME RESET SUPPORTED	
	4.3	NVME CONTROLLER CONFIGURATION AND BEHAVIOR	
	4.4	NVMe Admin Command Set7	
	4.4.1	Namespace Management/Attachment Commands	8
	4.4.2	Namespace Utilization (NUSE)	
	4.4.3	UUID for DSSD Specific Information	10
	4.5	NVME I/O COMMAND SET	
	4.6	OPTIONAL NVME FEATURE SUPPORT	
	4.7	COMMAND TIMEOUT	
	4.8	LOG PAGE REQUIREMENTS	
	4.8.1	Standard Log Page Requirements	13
	4.8.2	Telemetry Logging and Interface for Failure Analysis	
	4.8.3	DSSD Log Page Requirements	
	4.8.4	SMART / Heath Information Extended (Log Identifier C0h) Requirements	16
	4.8.5	SMART / Health Information Extended (Log Identifier C0h)	17
	4.8.6	Error Recovery (Log Identifier C1h)	23
	4.8.7	Firmware Activation History (Log Identifier C2h) Requirements	
	4.8.8	Latency Monitor Log and Feature Set Requirements	
	4.8.9		
	4.8.1		
	4.8.1		
	4.8.1.		
	4.8.1.		
	4.8.1		
	4.8.1.		
	4.8.1		66
	4.9	HOST AND CONTROLLER INITIATED TELEMETRY LOGS	74
	4.9.1	Theory of Operation	
	4.9.2 4.9.3	Data Partitioning OverviewStatistic Area	
	4.9.3 4.9.4	Event FIFO	
	4.9.4 4.9.5	Existing NVMe Logs	
	4.9.5 4.9.6	Existing NVMe LogsDebug Structure Overview Summary	
	4.9.6 4.9.7	Telemetry Data Requirements	
	4.9.7	Telemetry Reason Identifier Format	
	4.9.8 4.9.9	Debug Profiles	
	4.9.9	0 ,	
	4.9.1	F	
	T. J. 1	t Juitistic tucitajiot 3	/ 0

	4.9.1	2 Statistic Descriptor Location		79
	4.9.1.			
	4.9.1	4 Event FIFO Requirements		81
	4.9.1.			
	4.9.1	•		94
	4.10	SELF-TEST REQUIREMENTS		
	4.11	FIRMWARE UPDATE REQUIREMENTS		
	1.12	DE-ALLOCATION REQUIREMENTS		
	1.13	SECTOR SIZE AND NAMESPACE SUPPORT		
	1.14	SET/GET FEATURES REQUIREMENTS		
4	1.15	GENERAL FEATURE REQUIREMENTS		
	4.15.			
	4.15.			
	4.15			110
	4.15.			
	4.15	- /		
	4.15.	- / (
	4.15.			
	4.15.			
	4.15.			
	4.15.			
	4.15.			
	4.15.			
	4.15.			
	4.15. 4.15.			
	4.15.	15 Set Telemetry Profile (Feature Identifier C8h) Set Feature		120
5	PCIE	REQUIREMENTS	127	
	- 1	BOOT REQUIREMENTS	120	
	5.1 5.2	PCIE ERROR LOGGING		
-	5.3	LOW POWER MODES		
_	5.4	PCIE EYE CAPTURE		
	0.4	PGIE EYE GAPTURE	129	
6	RELIA	\BILITY	129	
,	5.1	UNCORRECTABLE BIT ERROR RATE	120	
_				
t	5.2	POWER ON/OFF REQUIREMENTS		400
	6.2.1			
	6.2.2	,		130
	5.3	END TO END DATA PROTECTION		
	5.4	BEHAVIOR ON FIRMWARE CRASH, PANIC OR ASSERT		
	5.5	ANNUAL FAILURE RATE (AFR)		
	5.6	BACKGROUND DATA REFRESH		
	5.7	WEAR-LEVELING		
	5.8	Power Loss Protection		
6	5.9	DEVICE LIMITS	138	
7	ENDL	JRANCE	138	
_	7.1	ENDURANCE DATA	120	
-				
-	7.2	RETENTION CONDITIONS		
	7.3	SHELF LIFE		
7	7.4	END-OF-LIFE (EOL)	139	
8	THER	MAL	140	
	2 1	DATA CENTED ALTITUDE	140	

	8.2	THERMAL THROTTLING	141	
	8.3	TEMPERATURE REPORTING	142	
	8.4	THERMAL SHUTDOWN	143	
9	FOR	M FACTOR REQUIREMENTS	143	
	9.1	GENERIC FORM FACTOR REQUIREMENTS	143	
	9.2	POWER CONSUMPTION MEASUREMENT METHODOLOGY		
	9.3	Power Levels	144	
	9.4	M.2 FORM FACTOR REQUIREMENTS	144	
	9.5	E1.S FORM FACTOR REQUIREMENTS	145	
	9.6	E1.L FORM FACTOR REQUIREMENTS	146	
	9.7	E3 FORM FACTOR REQUIREMENTS	146	
	9.8	SFF-8639 (U.2/U.3) FORM FACTOR REQUIREMENTS	147	
10	OUT	-OF-BAND MANAGEMENT SUPPORT	148	
	10.1	NVME BASIC MANAGEMENT COMMAND (APPENDIX A) REQUIREMENTS	148	
	10.2	NVME BASIC MANAGEMENT COMMAND (APPENDIX A) DATA FORMAT		
	10.3	NVME-MI 1.1B REQUIREMENTS	153	
11	l SEC	URITY		
	11.1	BASIC SECURITY REQUIREMENTS	154	
	11.2	Secure Boot		
	11.3	DISTRIBUTED MANAGEMENT TASK FORCE (DMTF) SECURITY PROTOCOL AND DATA MODEL (SPD	M)160	
	11.4	DATA ENCRYPTION AND ERADICATION	161	
12	2 DEV	/ICE PROFILES	161	
13	3 LAE	BELING	162	
	13.1	LABEL REQUIREMENTS	163	
14	CON	//PLIANCE	167	
	14.1	ROHS COMPLIANCE	167	
	14.2	ESD COMPLIANCE	168	
15	SHO	CK AND VIBRATION	168	
16	5 SUS	TAINABILITY REQUIREMENTS	168	
17		ME LINUX CLI PLUG-IN REQUIREMENTS		
	17.1	NVME CLI MANAGEMENT UTILITY		
	17.2	NVME CLI PLUGIN REQUIREMENTS		
	17.2			defined
	17.2			
18		/ISION HISTORY		107
AI		IX A - FACEBOOK SPECIFIC ITEMS		
		NFIGURATION SPECIFICS		
		RFORMANCE REQUIREMENTS		
		1 Performance Targets for FB-FIO Synth Flash - HE_Flash_Short_TRIM_2H20 (for all capa		
		2 Performance Targets for FB-FIO Synth Flash – Cache_2H20		
		3 Performance Targets for FB-FIO Synth Flash – Search_2H2O		
		4 Performance Targets for FB-FIO Synth Flash – WSF		174
		M RATE TARGETS		
		go Benchmark Targets		
	Δ 5 File	ADDENID RENCHMARK TARGETS	17/	

A.6 SEQUENTIAL WRITE BANDWIDTH	175	
A.6 SEQUENTIAL WRITE BANDWIDTH	175	
A.8 Max Latency Targets	175	
APPENDIX B - MICROSOFT SPECIFIC ITEMS	176	
B.1 Configuration Specifics	176	
APPENDIX C - LATENCY MONITORING FEATURE SET THEORY OF OPERATION	176	
C.1 Overview	176	
C.2 FUNCTIONAL OPERATION	176	
C.2.1 Latency Monitoring Feature Description C.2.2 Bucket Description Overview C.2.3 Active Bucket Description C.3 Persistence Across Power Cycles C.4 Debug Logs		176
C.2.2 Bucket Description Overview		176
C.2.3 Active Bucket Description		177
C.3 Persistence Across Power Cycles	183	
C.4 Debug Logs	183	
C.5 LATENCY MONITORING FEATURE - CHALLENGING EVENT HANDLING	184	
C.5.1 Power Off/On When Latency Monitoring Feature is Enabled		184
C.5.2 Power Off/On When Latency Monitoring Feature is Disabled		184
C.5.3 Moving Information from Active to Static Buckets		184
C.5.2 Power Off/On When Latency Monitoring Feature is Disabled		184
C 6 CONFIGURING LATENCY MONITORING	184	

1 OCP

1.1 License OWF Option

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NONE

1.2 System Firmware

All products seeking OCP AcceptedTM Product Recognition must complete the Open System Firmware (OSF) Tab in the 2021 Supplier Requirements Checklist. The completed checklist shall be uploaded and available

at: https://github.com/opencomputeproject/OpenSystemFirmware/[vendor_name]/[product_name]/

Note to author: replace [vendor_name] and [product_name] with actual company name and product identifier.

1.3 Hardware Management

1.3.1 Compliance

All products seeking OCP InspiredTM or OCP Accepted TM Product Recognition shall comply with the OCP Hardware Management Baseline Profile V1.0 and provide such evidence by completing the Hardware Management Tab in the 2021 Supplier Requirements Checklist.

1.3.2 BMC Source Availability (if applicable)

All Products seeking OCP AcceptedTM Product Recognition shall have source code and binary blobs submitted for BMC, if applicable. The BMC management source code shall be uploaded at: https://github.com/opencomputeproject/Hardware Management/[vendor_name]/[product_name]/.

1.4 Security

All products seeking OCP InspiredTM or OCP AcceptedTM Product Recognition shall have a completed Security Profile in the 2021 Supplier Requirements Checklist. Whether the answer is a yes or no, the profile must be completed. For Additional Security Badges (Bronze/Silver/Gold), please fill out the Security Profile in accordance with the requirements for that level. Security Badges will be reassessed on an annual basis as requirements are subject to change.

2 Overview

This document is to define the requirements for a Datacenter NVMe SSD (DSSD) for use in datacenters.

3 Scope

This document covers PCIe-attached SSDs using NVM Express.

4 **NVM Express Requirements**

4.1 Overview

Requirement ID	Description
NVMe-1	The device shall comply with all required features of the NVMe 2.0 Specification except as overridden by this specification. Optional features shall be implemented per the requirements of this specification.
NVMe-2	Any optional features supported by the device not described in this document shall be clearly documented and disclosed to the customer.
NVMe-3	Any vendor unique features supported by the device not described in this document shall be clearly documented and disclosed to the customer.

4.2 NVMe Reset Supported

Requirement ID	Description
NVMeR-1	NVMe Subsystem Reset (NSSR) shall be supported.
NVMeR-2 NVMe Controller Reset (CC.EN cleared to 0b) shall be supported.	

4.3 NVMe Controller Configuration and Behavior

Requirement ID	Description			
NVMe-CFG-1	The default arbitration shall be Round-Robin. Weighted Round Robin with Urgent Class Priority shall be supported.			
NVMe-CFG-2 The device shall support a Maximum Data Transfer Size (MDTS) value of at least 256KB.				
NVMe-CFG-3	The device firmware shall support reporting of CSTS.CFS.			
NVMe-CFG-4	NVMe-CFG-4 Obsolete. Replaced by <u>LABL-11 (Model Number shall match).</u>			
NVMe-CFG-5 The minimum supported queue depth shall be 1024 per submission queue.				
NVMe-CFG-6 The minimum number of I/O Queue Pairs shall be 128.				
NVMe-CFG-7 Device shall support EUI64 (Extended Unique Identifier) to differentiate namespaces.				
NVMe-CFG-8	Device shall support an NGUID per Namespace.			
NVMe-CFG-9 The CAP.DSTRD field in the Controller Capabilities data structure shall be zero.				
NVMe-CFG-10 The device shall place all Doorbells in a single 4096-byte page.				
NVMe-CFG-11 The device shall not support Controller Memory Buffer. The CAP.CMBLOC and CAP.CMBSZ registers in BAR0/1 shall both be cleared to zero.				
NVMe-CFG-12 The device shall not implement a Feature with ID D0h.				

4.4 NVMe Admin Command Set

The device shall support the following mandatory and optional NVMe Admin commands:

Requirement ID	Description	
NVMe-AD-1	he device shall support all mandatory NVMe Admin commands.	
NVMe-AD-2 Identify – In addition to supporting all the mandatory CNS values and the mandatory fields within the CNS, the following optional fields in the CNS supported:		
	Format progress indicator (FPI).I/O Performance and Endurance Hints:	

Requirement ID	Description			
	○ NSFEAT bit 4 = 1b.			
NVMe-AD-3	Namespace Management command shall be supported.			
NVMe-AD-4	Namespace Attachment command shall be supported.			
NVMe-AD-5	Format NVM command shall be supported. Secure Erase Settings (SES) values 000b, 001b and 010b shall be supported.			
NVMe-AD-6	The device shall support NVMe-MI Send and Receive.			
NVMe-AD-7 The device shall support the Sanitize command and meet NIST SP800-88r1 Purge requirements. Block Erase (010b) and Crypto Erase (100b) sanitize operations shall be supported. If Overwrite (011b) is supported, it shall meet NIST SP800-88r1 Purg requirements.				
NVMe-AD-8 The device shall enable reads to sanitized LBAs to meet validation of sani per NIST SP800-88r1 (i.e., return data from media). Specifically, LBAs shatos or all 1s after a Block Erase (010b) and LBAs shall return the data gene decryption using the new MEK after a Crypto Erase (100b) (garbage data)				
NVMe-AD-9 If a read operation occurs to a Sanitized LBA prior to that LBA being written, the read operation shall not report a media error because the LBA has not been wr				
NVMe-AD-10	The device shall support Identify command UUID List functionality (CNS value 17h).			
NVMe-AD-11 If the Namespace Identifier (NSID) is not used for a specific NVMe Admin and the host specifies a non-zero NSID, then the controller shall abort the with status Invalid Field in Command.				
NVMe-AD-12 The Self-Test command shall be supported.				
NVMe-AD-13 The Self-Test command shall not fail solely due to the Percentage Used field be equal to or greater than 100%.				
NVMe-AD-14 The Lockdown command shall be supported.				
NVMe-AD-15	The Lockdown command shall support locking down all supported Admin commands including the Lockdown command itself.			
NVMe-AD-16 The Lockdown command shall support locking down all supported Features.				
NVMe-AD-17 The Lockdown command shall support locking down all supported Logs.				

4.4.1 Namespace Management/Attachment Commands

The namespace management command along with the attach/detach commands is used to increase device over-provisioning beyond the default minimum over-provisioning.

Requirement ID	Description
NSM-1	The namespace management commands shall be supported on all namespaces.

Commented [LP1]: Add requirement to return all zeros. Add Set/Get Feature to change this.

Requirement ID	Description		
NSM-2	When creating a namespace, the default "Formatted LBA Size" parameter (FLBAS = 0) in the Identify Namespace Data Structure (Byte 26) shall correspond to the default sector size set at the factory.		
NSM-3	When formatting the device with the Format NVM command, the default "LBA Format" parameter (LBAF = 0) in Command Dword 10 bits 3:0 shall correspond to the default sector size set at the factory.		
NSM-4	The device shall support Profiles).	a minimum of 16 Namespaces (see <u>Section 12 Device</u>	
NSM-5	namespaces shall be at least 128 Namespaces at 7TB based on 16 Namespaces per TB of usable capacity. The number of Namespaces shall be based on the device usable capacity as follows:		
	Device Usable Minimum Number of Namespaces Capacity		
	<= 1TB	16	
	> 1TB but <= 2TB	32	
	> 2TB but <= 3TB	48	
	> 3TB but <= 4TB	64	
	> 7TB	128	
NSM-6	The device shall report at least one Namespace Granularity Descriptor in the Namespace Granularity List.		
NSM-7	The device shall support the TNVMCAP and UNVMCAP fields in the Identify Controller Data Structure.		

4.4.2 Namespace Utilization (NUSE)

Requirement ID	Description
NUSE-1	The NUSE shall be equal to the number of logical blocks currently allocated in the namespace. NUSE cannot be hardcoded to be equal to NCAP. Here is an example for a 200GB device: 1. After a Format NVM command User Data Erase (SES = 001b), NUSE would be zero. And the usage data would reflect that: 0.00GB. 2. After writing 1 GB worth of data, the usage data is expected to show the following: 1.00GB. 3. After filling the device, the usage data is expected to show the following: 200.00GB.

Requirement ID	Description					
	4. If the host issues a 10GB de-allocate command and the device completes de-allocation of the data, the usage data would show the following: 190.00GB.					

4.4.3 UUID for DSSD Specific Information

A UUID has been defined for use in commands to ensure that the vendor specific Log Identifiers and Feature Identifiers used in this specification access the functionality defined in this specification (i.e., do not access other vendor specific functionality that may use the same vendor specific identifiers).

Requirement ID	Description
UUID-1	The UUID List (NVMe-AD-10) shall contain a UUID List Entry that contains the UUID value C194D55BE0944794A21D29998F56BE6F. The Identifier Association field in that UUID List Entry shall be cleared to 00b. For clarity: UUIDDw0 (bytes 51:48) = 0xC194D55B UUIDDw1 (bytes 55:52) = 0xE0944794 UUIDDw2 (bytes 59:56) = 0xA21D299 UUIDDw3 (bytes 63:60) = 0x8F56BE6F
UUID-2	The Get Features and Set Features commands shall support UUID Index functionality.
UUID-3	A Get Features command or a Set Features command with: the UUID Index of the UUID (UUID-1) in the UUID List (NVMe-AD-10) or a zero UUID Index; and a vendor-specific Feature Identifier that is used in this specification (see Section 4.12 Set/Get Feature Requirements) shall access the vendor specific Feature defined in this specification.
UUID-4	The Get Log Page command shall support UUID Index functionality.
UUID-5	A Get Log Page command with: the UUID Index of the UUID (UUID-1) in the UUID List (NVMe-AD-10) or a zero UUID Index; and a vendor-specific Log Page Identifier that is used in this specification (see Section 4.8 Log Page Requirements) shall access the vendor specific Log Page defined in this specification.

4.5 NVMe I/O Command Set

Requirement ID	Description			
NVMe-IO-1	The device	e shall su	ipport all mandatory NVMe I/O commands.	
NVMe-IO-2			upport the Dataset Management command. The device shall ute – Deallocate (AD) bit.	
NVMe-IO-3	Since the device is power fail safe (e.g., has Power Loss Protection (PLP)) the performance shall not be degraded by any of the following: • FUA – i.e., forced unit access shall not incur a performance penalty. • Flush Cache – i.e., flush cache shall have no effect as the PLP makes any cache non-volatile. • Volatile Write Cache (Feature Identifier 06h) Set Feature to disable write-cache. This command shall be failed as described in the NVMe Standard 1.4b as there is no volatile write cache.			
NVMe-IO-4	The device shall support the Write Zeroes command. The following bits of the Write Zeroes command shall be supported: • De-allocate (DEAC) bit. • Force Unit Access (FUA) bit.			
NVMe-IO-5	The Write	Zeroes	command shall have the following behavior:	
	DEAC	FUA	Behavior	
	0b	0b	The device shall follow the NVMe Specification.	
	0b	1b	The device shall follow the NVMe Specification.	
	1b	1b	The device shall follow the NVMe Specification.	
	1b	0b	See NVMe-IO-6 (Write Zeroes DEAC bit).	
NVMe-IO-6	If the Write Zeroes DEAC bit is set to 1b and the FUA bit is cleared to 0b, the device shall deallocate the specified blocks and shall return a zero value for any subsequent read to the specified blocks regardless of the behavior of the Dataset Management command.			
NVMe-IO-7	With the DEAC bit set to 1b and the FUA bit cleared to 0b one or more Write Zeros command(s) shall be able to completely update the FTL map of the entire device in less than one minute.			
NVMe-IO-8	The device shall support the Compare command.			
NVMe-IO-9	The device shall support the Compare and Write fused command pair.			
NVMe-IO-10	For some models (see <u>Section 12 Device Profiles</u>), the device shall support the Write Uncorrectable command.			
NVMe-IO-11		granula	ectable command shall support marking LBAs uncorrectable at a rity regardless of the number of LBAs in the FTL indirection	

Requirement ID	Description
NVMe-IO-12	The device shall not limit the number of LBAs that the host is able to specify in a Write Uncorrectable command beyond the minimum and maximum allowed by NVMe. The host shall be able to send a single LBA.
NVMe-IO-13	There shall be no limit on the total media capacity that can be marked uncorrectable by Write Uncorrectable commands.
NVMe-IO-14	Uncorrectable errors (e.g., read errors) that are a consequence of a prior Write Uncorrectable command shall not be counted in the Smart / Health Information (Log Identifier O2h) Media and Data Integrity Errors field.

4.6 Optional NVMe Feature Support

The device shall also support the following NVMe features:

Requirement ID	Description
NVMe-OPT-1	Obsolete. Duplicate of <u>STD-LOG-7 (Telemetry Host-Initiated (Log Identifier 07h))</u> and <u>STD-LOG-8 (Telemetry Controller-Initiated (Log Identifier 08h))</u> .
NVMe-OPT-2	Timestamp (Feature Identifier 0Eh) shall be supported to align the devices internal logs.
NVMe-OPT-3	Background data collection by the device needed for populating either Telemetry Host-Initiated (Log Identifier 07h) or Telemetry Controller-Initiated (Log Identifier 08h) shall not impact I/O latency or throughput.
NVMe-OPT-4	The device shall only clear the Timestamp Origin field to 000b in the Timestamp (Feature Identifier 0Eh) on a main power cycle or NVM Subsystem Reset (e.g., NSSR). The device shall not clear the Timestamp Origin field on a power cycle of only AUX power.
NVMe-OPT-5	The device shall never set the Synch field bit to 1b in the Timestamp (Feature Identifier OEh).
NVMe-OPT-6	The device shall only generate a Controller initiated Telemetry AER on an error condition and shall not generate a Controller initiated Telemetry AER for periodic logging.
NVMe-OPT-7	The device shall report its Indirection Unit (IU) size in the NPWG field in the Identify Namespace Data Structure.

4.7 Command Timeout

Requirement ID	Description
CTO-1	NVMe Admin commands and TCG Commands shall take no more than 10 seconds from submission to completion. CTO-1 does not apply to the time taken by background operations initiated by the Self-Test and Sanitize commands.
CTO-2	The only exceptions to CTO-1 shall be Format NVM Command and the TCG commands Revert, RevertSP and GenKey.
CTO-3	Once TTR-2 is satisfied, an individual I/O command (QD1) shall take no more than 8 seconds from submission to completion. The device shall not have more than 7 I/Os take more than 2 seconds in one hour.
CTO-4	I/O command processing time shall not be a function of device capacity.
CTO-5	Device supplier shall disclose any I/O scenario that could violate the timeout requirements in CTO-1 through CTO-4.
CTO-6	The device shall set MDTS and Max Queue Depth such that CTO-3 cannot be violated.

4.8 Log Page Requirements

4.8.1 Standard Log Page Requirements

Requirement ID	Description				
STD-LOG-1	Error Information	(Log Identifi	er 01h) shall be supported.		
STD-LOG-2	SMART / Health In	formation (l	og Identifier 02h) shall be supporte	d.	
STD-LOG-3			Percentage Used field in the SMART n) decrease to a lower value than pr	•	
STD-LOG-4	The Percentage Used field in the SMART / Health Information (Log Identifier 02h) shall be based on the average P/E cycle of the device. In addition, this field shall be based on the actual P/E cycle count of the media and not on the Power on Hours (POH) of the device.				
STD-LOG-5	Firmware Slot Info	Firmware Slot Information (Log Identifier 03h) shall be supported.			
STD-LOG-6	Commands Suppo	Commands Supported and Effects (Log Identifier 05h) shall be supported.			
STD-LOG-7	Telemetry Host-Initiated (Log Identifier 07h) shall be supported.				
STD-LOG-8	Telemetry Controller-Initiated (Log Identifier 08h) shall be supported.				
STD-LOG-9	Persistent Event Log (Log Identifier 0Dh) shall be supported.				
STD-LOG-10	The following Persistent Event Log types shall be supported:				
		Туре	Event		
		01h	SMART / Health Log Snapshot		
	02h Firmware Commit				

Requirement ID	Description					
			03h	Timestar	np Change	
			04h	Power-o	n or Reset	
			05h	NVM Sub	osystem Hardware Erro	or
			06h	Change N	Namespace	
			07h	Format N	IVM Start	
			08h	Format N	IVM Completion	
			09h	Sanitize S	Start	
			0Ah	Sanitize (Completion	
			0Ch	Telemetr	y Log Created	
			0Dh	Thermal	Excursion	
STD-LOG-11	LBA Status Information (Log Identifier 0Eh) shall be supported.					
STD-LOG-12	Persistence Type	Sa	turating Co	unter¹	Reset ² Persistent	Power Cycle/PERST Persistent
	0				Reserved	
	1	N	o (Runtime	Value)	No (Runtime Value)	No (Runtime Value)
	2		No		Yes	Yes
	3		Yes		Yes	No
	4		Yes		Yes	Yes
	5		Yes		No	No
1	3					
	6		No		Yes	No
					Yes Reserved	No
	6		No ating counte		Reserved	No

4.8.2 Telemetry Logging and Interface for Failure Analysis

The following applies to telemetry logging as the ability to quickly debug failures is required:

Requirement ID	Description
TEL-1	The device shall track the operational/event history and any critical parameters that can be used to debug issues.
TEL-2	The supplier shall provide a table that categorizes the reason identifiers that are a super set of the panic IDs in EREC-4 (Panic ID).
TEL-3	The device shall not lose debug data relevant to the current operating state due to any legal operation. Telemetry data including SMART / Health Information (Log Identifier O2h) and SMART / Health Information Extended (Log Identifier C0h) shall

Requirement ID	Description						
		be persisted across power loss, all resets, Format command, Sanitize command, or device entering any protected mode (e.g., read only or panic mode).					
TEL-4			ntifier field shall be the most recent failure io wer cycle or reset.	dentifier and	I shall not be		
TEL-5			provides the specifications for the controlle ge "data areas":	er-initiated a	nd the host-		
		Data Area Purpose Data Area Size Latency Impact to					
	1 Periodic logging for monitoring Vendor- trends/problems specific typ 10m						
	Implementation of Data areas 2 and 3 are optional and shall not be used for periodic logging.						
TEL-6	Obsolete.						
TEL-7	0	bsolete.					

4.8.3 DSSD Log Page Requirements

The table below defines the scope for all DSSD specific log pages:

Log Identifier	Scope	Log Page Name	Reference Section
COh	NVM subsystem	SMART / Health Information Extended	4.8.5
C1h	NVM subsystem	Error Recovery	<u>4.8.6</u>
C2h	NVM subsystem	Firmware Activation History	4.8.7
C3h	Controller	Latency Monitor	<u>4.8.9</u>
C4h	NVM subsystem	Device Capabilities	<u>4.8.10</u>
C5h	NVM subsystem	Unsupported Requirements	4.8.11
C6h	NVM subsystem	Hardware Revision	
C7h	NVM subsystem	TCG Configuration	
C8h	NVM subsystem	TCG History	
C9h	NVM subsystem	Set Telemetry Profile	
CAh	NVM subsystem	Latency Monitor Debug Telemetry	
KEY:			

Log Identifier	Scope	Log Page Name	Reference Section				
Namespace = The log page contains information about a specific namespace.							
Controller = The log page contains information about the controller that is processing the command.							
NVM subsystem = The log page contains information about the NVM subsystem							

4.8.4 SMART / Heath Information Extended (Log Identifier C0h) Requirements Below are the requirements for the SMART / Health Information Extended (Log Identifier C0h):

Requirement ID	Description			
SLOG-1	All values in the DSSD log pages defined by this specification shall be persistent across power cycles unless otherwise specified.			
SLOG-2	All counters defined by this specification shall be saturating counters (i.e., if the counter reaches the maximum allowable size, it stops incrementing and does NOT roll back to 0) unless otherwise specified.			
SLOG-3	All fields in DSSD log pages shall be little endian format.			
SLOG-4	A normalized counter defined by this specification, unless otherwise specified, shall be reported as the following: 100% shall represent the number at factory exit. 1% shall represent the minimum amount to be reliable. A value of 0% means the device shall no longer be considered reliable. 100% shall be represented as 64h.			
SLOG-5	Devices shall support the attributes listed in Section 5.14.1.2 of the NVMe specification version 1.4b.			
SLOG-6	A Get Log of either the SMART /Health Information (Log Identifier 02h) or SMART / Health Information Extended (Log Identifier C0h) shall not require an update of the SMART values other than the temperature values in SLOG-8. It shall be a simple read of the current data and shall not block IO.			
SLOG-7	Unless otherwise specified, the device shall update the values of the SMART / Health Information (Log Identifier 02h) or SMART / Health Information Extended (Log Identifier C0h) in the background at least once every ten minutes.			
SLOG-8	The composite and raw temperature sensor values shall be updated when the log page is accessed.			
SLOG-9	All assert events and controller-initiated log captures will require an associated vendor-specific "Reason Identifier" that uniquely identifies the assert /controller condition.			
SLOG-10	The device shall not lose any data in either the SMART / Health Information (Log Identifier 02h) or SMART / Health Information Extended (Log Identifier C0h) which is more than 10 minutes old including across power cycles/resets.			
SLOG-11	The device shall not lose any back up energy source failure information or SMART / Health Information (Log Identifier 02h) critical warnings or SMART / Health Information Extended (Log Identifier C0h) critical warnings including across power cycles/resets.			

4.8.5 SMART / Health Information Extended (Log Identifier C0h)
This vendor-specific log page, C0h shall be 512 bytes with the following functional requirements and field format:

Requirement ID	Byte Address	Field	# of Bytes			Field Description
SMART-1	15:0	Physical Media Units Written	16	n n It	nedia; this v netadata wr : shall be po	the number of bytes written to the value includes both user and ritten to the user and system areas. ssible to use this attribute to the Write Amplification Factor (WAF).
SMART-2	31:16	Physical Media Units Read	16			the number of bytes read from the both the user and system areas.
SMART-3	39:32	Bad User NAND Blocks			IAND blocks eason (e.g., vents). The fuser spare ormalized vount shall be no ormalized a	int specifies the number of user is that have been retired for any program fails, erase fails or other is Normalized value is the percentage is blocks still available. The value shall be set to 64h and the Raw is cleared to zero on factory exit. It oted there are 2 bytes for and 6 bytes for raw count. See malized counter) definition above.
					Byte Address	Field Description
					39:38	Normalized value
					37:32	Raw count
SMART-4	47:40	Bad System NAND Blocks		N re e o n co sl	IAND blocks eason (e.g., vents). The f system sp ormalized vount shall bhould be no ormalized a	int specifies the number of system is that have been retired for any program fails, erase fails or other in Normalized value is the percentage are blocks still available. The value shall be set to 64h and the Raw is cleared to zero on factory exit. It beted there are 2 bytes for and 6 bytes for raw count. See malized counter) definition above.
					Address	Field Description
					47:46	Normalized value

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				A value of FFFF_FFFF_FFFF indicates that the Bad User NAND block count field above represents all blocks on the device and Bad System NAND block count field is invalid.
SMART-5	55:48	XOR Recovery Count	8	Total number of times XOR was invoked to recover data in NAND. This shall cover all reads from NAND. Data recovery may have succeeded or failed. This shall be cleared to zero on factory exit.
SMART-6	63:56	Uncorrectabl e Read Error Count	8	Total count of NAND reads that were not correctable by read retries, all levels of ECC, or XOR. This shall be a count of the number of times data recovery fails and an uncorrectable read error is returned to the host.
SMART-7	71:64	Soft ECC Error Count	8	Total count of NAND reads that were not correctable by first level ECC and requires invoking additional recovery. This shall cover all NAND read accesses. Data recovery may have succeeded or failed. If the device has more than one intermediate recovery level, then this counter only increments once. The recovery path and point at which this counter is invoked within it is vendor-specific.
SMART-8	79:72	End to End Correction Counts	8	A count of the detected and corrected errors by the end-to-end error correction which includes DRAM, SRAM, or other storage element ECC/CRC protection mechanism (not NAND ECC). All correctable errors shall result in a counter increase no matter what type of data the memory is protecting. All detected errors shall result in a counter increase unless the error is uncorrectable and occurred in the system region. In the latter case, the incomplete shutdown flag shall be flagged/incremented on the next power up. It should be noted there are 4 bytes for count of detected errors and 4 bytes for count of corrected errors.

Requirement ID	Byte Address	Field	# of Bytes			Field Description
					Byte Address	Field Description
					79:76	Corrected Errors
					75:72	Detected Errors
SMART-9	80	System Data % Used	1	f St V S n St d C n C d	erase cycles or the syste tarts at 0 ar he estimate allue may exhall incrementation of the ystem data his shall replevice wear ounter has normalized conormalized levice many	d cumulative count of the number of per block since leaving the factory m (firmware and metadata) area. In dincrements. 100 indicates that dendurance has been consumed. Exceed 100 up to 255. This count ent regardless of what the backing blocks are (e.g., SLC and TLC). If its split between media types, then nort the worst-case count so that the out is clearly understood. This a different behavior than the counter definition in SLOG-4 counter), 100% (64h) represents the roo longer function reliably as the roles has been hit.
SMART-10	87:81	Refresh Counts	7	b T s	een re-alloo his counter pace due to	nt of the number of blocks that have cated to maintain data integrity. does not include creating free agarbage collection or block due to wear leveling.
SMART-11	95:88	User Data Erase Counts	8	t s b 4 c a r	he user NAM hall not be a be noted the bytes for the Data Erase C block goes ecover the l	m and minimum erase counts across ND blocks in the device. The host able to reset this counter. It should are are 4 bytes for the maximum and the minimum. The Minimum User ount shall not include bad blocks. If bad, any subsequent attempts to block shall not increment the ser Data Erase Count field.
					Address	Field Description
					95:92	Minimum User Data Erase Count
					91:88	Maximum User Data Erase Count

Requirement ID	Byte Address	Field	# of Bytes		Field Description
SMART-12	97:96	Thermal Throttling Status and Count	2	(throttled o number of t there is 1 by for the cour throttle poi	r not throttled) and a count of the thermal throttling events. Note that yte for the current status and 1 byte nt. For devices that only have 1 nt only the first level throttle value orted. This shall be cleared to zero exit.
				Byte Address	Field Description
				97	Current Throttling Status
					Current Status definition: • 00h = unthrottled • 01h = first level throttle • 02h = 2 nd level throttle • 03h = 3 rd level throttle • 04h - FFh = Reserved
				96	Number of thermal throttling events
SMART-13	103:98	DSSD Specification	6	Version of t	he DSSD Specification that this orms to.
		Version		Byte Address	Field Description
				103	Major Version Field. Shall be 02h.
				102:101	Minor Version Field. Shall be 0005h.
				100:99	Point Version Field. Shall be 0000h.
				98	Errata Version Field. Shall be 00h.
SMART-14	111:104	PCIe Correctable Error Count	8	(bad TLP, batimeouts, re only increming	counter of all PCIe correctable errors ad DLLP, receiver error, replay eplay rollovers). These counts shall lent during run time. They shall not during training or power fail. This ared to zero on factory exit.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
SMART-15	115:112	Incomplete Shutdowns	4	A count of the number of shutdowns that have occurred that did not completely flush all required user data and metadata to non-volatile memory for any reason. This shall be cleared to zero on factory exit.
SMART-16	119:116	Reserved	4	Shall be cleared to zero.
SMART-17	120	% Free Blocks	1	A normalized count of the number of blocks that are currently free (available) out of the total pool of spare blocks in the spare area. Free blocks means both blocks that have been erased and do not contain data. Invalid blocks are blocks that are marked invalid and have not been erased. Thus %Free Blocks = Erased Blocks/ (Erased + blocks in spare area not erased yet). Where the total free pool is erased blocks plus blocks in other stages in the spare pool.
SMART-18	127:121	Reserved	7	Shall be cleared to zero.
SMART-19	129:128	Capacitor Health	2	This field is an indicator of the capacitor health and represents the capacitor holdup energy margin during operation. If no PLP protection is present a value of FFFFh shall be reported. 100% represents the passing hold up energy threshold when a device leaves manufacturing. Thus, a device will typically report greater than 100% in this field after leaving manufacturing at beginning of life. 1% is the minimum hold up energy required to conduct a proper shutdown reliably. A value of 0% may or may not result in a device failing to shutdown properly. This value shall never go negative. Zero is the minimum.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				Typically Device's hold up energy measured at beginning of life Manufacturing exit threshold for hold up energy Device expected to shutdown properly. Minimum hold up energy needed to shutdown reliably Device may or may not shutdown properly. (Less than 1%) Capacitor Health Value = Amount of hold up energy currently on the drive
SMART-20	130	NVMe Errata Version	1	The device shall report the most recent NVMe Errata revision (a, b, c, etc.) in ASCII that the device has implemented breaking changes to. If the device does not implement any breaking changes due to errata, this field shall be cleared to zero.
SMART-30	135:131	Reserved	5	Shall be cleared to zero.
SMART-21	143:136	Unaligned I/O	8	This is a count of the number of write IOs performed by the device that are not aligned to the indirection unit size (IU) of the device. Alignment indicates only the start of each IO. The length does not affect this count. This counter shall reset on power cycle. This counter shall not wrap. This shall be cleared to zero on factory exit.
SMART-22	151:144	Security Version Number	8	This is the Security Version Number of the currently running firmware image. The supplier increments this number any time a firmware includes a fix for a security issue or critical firmware fix that customer agrees rollback prevention is required.
SMART-23	159:152	Total NUSE	8	Total Namespace Utilization. For a device with a single Namespace, this shall be a copy of the Namespace Utilization field defined in the Identify Namespace Data Structure bytes 23:16. For a device with multiple Namespaces, this shall reflect the total utilization based on all the Namespaces.
SMART-24	175:160	PLP Start Count	16	This is a count of the number of times the device has initiated its power loss protection process

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				due to supply voltage drop. This counter shall be incremented on the initial detection of the power loss condition. This does not include PLP health check operations.
SMART-25	191:176	Endurance Estimate	16	This field is an estimate of the total number of data bytes that may be written to the device over its lifetime assuming a write amplification of 1. (i.e., no increase in the number of write operations performed by the device beyond the number of write operations requested by a host). This value shall be equivalent to the Endurance Estimate field in the Endurance Group Log (Log Identifier 09h).
SMART-29	199:192	PCIe Link Retraining Count	8	This is a count of the number of PCIe Link Retraining events. This count shall only increment during run time. It shall not increment during training or power fail. This shall be cleared to zero on factory exit.
SMART-31	207:200	Power State Change Count	8	Summation counter of the number of NVMe Power State changes whether host or device initiated, including NVMe Power State changes caused by DSSD Power State changes (see Section 4.8.10.1 DSSD Power State Requirements). This count shall only increment during run time. This shall be cleared to zero on factory exit.
SMART-32	223:208	Hardware Revision	16	Shall be set to the hardware revision of the device.
SMART-26	493:224	Reserved	270	Shall be cleared to zero.
SMART-27	495:494	Log Page Version	2	This indicates the version of the mapping this log page uses. Shall be set to 0003h.
SMART-28	511:496	Log Page GUID	16	Shall be set to AFD514C97C6F4F9CA4f2BFEA2810AFC5h.

4.8.6 Error Recovery (Log Identifier C1h)

Below are the requirements for the Error Recovery (Log Identifier C1h) AEN requirements:

Requirement ID	Description
EREC-AEN-1	If the device uses Panic AEN to report a Panic condition and the device encounters a Panic condition, it shall complete an outstanding Asynchronous Event Request (AER) command with an Asynchronous Event Notification (AEN) with Completion Queue Entry Dword 0 set as follows:
	 The Log Page Identifier field shall be set to C1h. The Asynchronous Event Information field shall be cleared to zero.
	 The Asynchronous Event Type field shall be set to 111b (Vendor Specific).

4.8.6.1 Error Recovery Theory of Operations
Error Recovery Workflow using Asynchronous Event Notifications.

Panic Workflow - AEN

Panic	Workflow – AEN						
#	Task	Description					
Pre-	Pre-Failure Parameter Exchange						
1	Boot time controller	During boot time controller initialization, the host					
	initialization	reads the Error Recovery (Log Identifier C1h) and					
		caches the Panic Reset Wait Time and the Panic Reset					
		Action bitfield. The host also sends an Asynchronous					
		Event Request (AER) command to device and waits					
		for the device to complete the command when there					
		is an asynchronous event.					
Re-E	Stablishing Comms When Failure	Occurs					
2	Device hits panic condition	The device detects panic condition					
3	Device saves panic related data	The device saves the following info					
		- Panic ID					
		- Device Recovery Action					
		 Debug data for Telemetry log 					
4	Device generates AEN	The device generates AEN to let the host know that a					
		panic was detected it then starts its panic handling					
		workflow. The device is not required to handle any					
		NVMe command(s) after sending the AEN.					
		The AEN Completion Queue Entry Dword 0 is filled in					
		per EREC-AEN-1.					
5	Host AEN handling	The host services the AEN and logs an event for the					
		panic condition.					
6	Host waits for device panic	The host waits for Panic Reset Wait Time to allow the					
	handling to complete	device to finish its panic handling workflow.					
Extr	acting Debug Info After Failure an	d Recovery					
7	Host resets device	The host tries one or more of the resets specified in					
		the Panic Reset Action bitfield to attempt to bring the					

		device back to a state where it can service NVMe commands.
8	Host initiates controller initialization	The host starts controller initialization. If the controller fails to initialize, the host will attempt the next Panic Reset Action as specified in the Panic Reset Action bitfield.
9	Host reads 0xC1 log page	The host reads the Error Recovery (Log Identifier C1h) to retrieve the following info: Panic ID Device Recovery Action A non-zero Panic ID indicates the device is in panic mode. The device fails IO commands while it is in panic mode and cannot safely complete commands: Status Code (SC) = 06h (Internal Error) Status Code Type (SCT) = 00h (Generic Command Status)
10	Host retrieves Controller- Initiated Telemetry Log if device in panic mode	Host retrieves Telemetry Controller-Initiated (Log Identifier 08h) for later use in debugging.
11	Device Recovery Action	The recommended Device Recovery Action is taken. This is most likely done during the offline recovery workflow.

Panic Workflow - CFS

#	Task	Description
Pre	-Failure Parameter Exchange	•
1	Boot time controller	During boot time controller initialization, driver reads
	initialization	0xC1 log page and caches Panic Reset Wait Time and
		Panic Reset Action. Driver also saves info that Panic
		CFS Supported is set.
Re-	Establishing Comms When Failure	Occurs
2	Device hits panic condition	Device detects panic condition
3	Device saves panic related data	Device saves the following info
		- Panic ID
		- Device Recovery Action
		Debug data for controller initiated log
4	Device asserts CFS	Device asserts CFS to let host know that a panic was
		detected and starts panic handling workflow. Device
		is not expected to be able to handle any NVMe
		command(s) after asserting CFS.
5	Driver detects CFS after	On first command timeout after CFS bit is set, driver
	command timeout	will check and detect CFS bit is set.

handling to complete to finish its panic handling workflow.			T
Extracting Debug Info After Failure and Recovery 7 Driver initiates a NVMe Controller Reset 8 Driver resets device if NVMe Controller Reset fails 8 Driver resets device if NVMe Controller Reset fails 9 Driver initiates controller initialization 9 Driver initiates controller initialization 10 Driver reads 0xC1 log page 11 Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 12 Device Recovery Action 13 Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 14 Device Recovery Action 15 Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 16 Driver recommended Device Recovery Action is taken	6	Driver waits for device panic	Driver waits for Panic Reset Wait Time to allow device
Driver initiates a NVMe Controller Reset as recommended in NVMe Spec for CFS.			
Controller Reset Driver resets device if NVMe Controller Reset fails Driver resets device if NVMe Controller Reset fails Driver resets device if NVMe Controller Reset fails Driver initiates controller initialization Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the followin info Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mode fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete comman Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV The recommended Device Recovery Action is taken	Extra	acting Debug Info After Failure ar	nd Recovery
8 Driver resets device if NVMe Controller Reset fails Or more resets specified in Panic Reset Action to attempt to bring device back to a state that can service NVMe command(s). 9 Driver initiates controller initialization Driver starts controller initialization. If controller fato initialize, driver may attempt a different Panic Reset Action. 10 Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the followin info Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mode (undrive is brick) and cannot safely complete comman Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV Device Recovery Action The recommended Device Recovery Action is taken	7	Driver initiates a NVMe	Driver initiates a NVMe Controller Reset as
Controller Reset fails or more resets specified in Panic Reset Action to attempt to bring device back to a state that can service NVMe command(s). Driver initialization Driver starts controller initialization. If controller fails to initialize, driver may attempt a different Panic Reset Action. Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the following info Panic ID Panic ID A non-zero Panic ID indicates device is in panic mode Fail IO Commands while drive is in panic mode (und drive is brick) and cannot safely complete commands and cannot safely complete commands Status) Driver retrieves Controller-Initiated Telemetry Log if device in panic mode The recommended Device Recovery Action is taken		Controller Reset	recommended in NVMe Spec for CFS.
attempt to bring device back to a state that can service NVMe command(s). 9 Driver initiates controller initialization Driver starts controller initialization. If controller for to initialize, driver may attempt a different Panic Reset Action. 10 Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the following info • Panic ID • Device Recovery Action A non-zero Panic ID indicates device is in panic mode fail IO Commands while drive is in panic mode (undrive is brick) and cannot safely complete commant Status Code (SC) = 0x06 (Internal Error) • Status Code Type (SCT) = 0x0 (Generic Command Status) 11 Driver retrieves Controller-Initiated Telemetry Log indevice in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken	8	Driver resets device if NVMe	If prior NVMe Controller Reset fails, driver tries one
service NVMe command(s). Driver initialization		Controller Reset fails	or more resets specified in Panic Reset Action to
9 Driver initiates controller initialization 10 Driver reads 0xC1 log page 10 Driver reads 0xC1 log page 10 Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the followin info Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mode fail IO Commands while drive is in panic mode (undrive is brick) and cannot safely complete commander is brick) and cannot safely complete commander is brick (SC) = 0x06 (Internal Error) Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV 12 Device Recovery Action The recommended Device Recovery Action is taken			
initialization to initialize, driver may attempt a different Panic Reset Action. Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the followin info Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mode fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete commander is brick) and cannot safely complete commander Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV The recommended Device Recovery Action is taken			```
Reset Action. Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the followin info Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mo Fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete commander is Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log in device in panic mode Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV The recommended Device Recovery Action is taken	9		
Driver reads 0xC1 log page Driver reads 0xC1 log page to retrieve the following info Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mode fail IO Commands while drive is in panic mode (undrive is brick) and cannot safely complete commander is brick) and cannot safely complete commander is Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV Device Recovery Action The recommended Device Recovery Action is taken		initialization	• • • •
info Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mo Fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete comman Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log in device in panic mode The recommended Device Recovery Action is taken			Reset Action.
Panic ID Device Recovery Action A non-zero Panic ID indicates device is in panic mo Fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete comman Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken	10	Driver reads 0xC1 log page	Driver reads 0xC1 log page to retrieve the following
Device Recovery Action A non-zero Panic ID indicates device is in panic mo Fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete comman Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) 11 Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken			info
A non-zero Panic ID indicates device is in panic mo Fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete commar Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller- Initiated Telemetry Log if device in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken			Panic ID
Fail IO Commands while drive is in panic mode (un drive is brick) and cannot safely complete command. Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken			Device Recovery Action
drive is brick) and cannot safely complete commar • Status Code (SC) = 0x06 (Internal Error) • Status Code Type (SCT) = 0x0 (Generic Command Status) 11 Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken			A non-zero Panic ID indicates device is in panic mode.
Status Code (SC) = 0x06 (Internal Error) Status Code Type (SCT) = 0x0 (Generic Command Status) 11 Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 12 Device Recovery Action Status Code (SC) = 0x06 (Internal Error) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV The recommended Device Recovery Action is taken			Fail IO Commands while drive is in panic mode (unless
Status Code Type (SCT) = 0x0 (Generic Command Status) 11 Driver retrieves Controller-Initiated Telemetry Log if device in panic mode 12 Device Recovery Action Status Code Type (SCT) = 0x0 (Generic Command Status) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV The recommended Device Recovery Action is taken			drive is brick) and cannot safely complete commands
Command Status) 11 Driver retrieves Controller- Initiated Telemetry Log if device in panic mode 12 Device Recovery Action Command Status) Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV The recommended Device Recovery Action is taken			 Status Code (SC) = 0x06 (Internal Error)
11 Driver retrieves Controller- Initiated Telemetry Log if device in panic mode 12 Device Recovery Action Driver retrieves Controller-Initiated Telemetry Log and uploads the log for sharing with IHV The recommended Device Recovery Action is taken			 Status Code Type (SCT) = 0x0 (Generic
Initiated Telemetry Log if device in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken			Command Status)
device in panic mode 12 Device Recovery Action The recommended Device Recovery Action is taken	11	Driver retrieves Controller-	Driver retrieves Controller-Initiated Telemetry Log
12 Device Recovery Action The recommended Device Recovery Action is taken		Initiated Telemetry Log if	and uploads the log for sharing with IHV
		device in panic mode	
	12	Device Recovery Action	The recommended Device Recovery Action is taken.
This is most likely done during the offline recovery			This is most likely done during the offline recovery
workflow.			workflow.

This vendor-specific log page, C1h shall be 512 bytes with the following functional requirements and field format:

Requirement ID	Byte Address	Field	# of Bytes	Field Description
EREC -1	1:0	Panic Reset Wait Time	2	The amount of time the host should wait for th device panic workflow to complete in msec.
EREC-2	2	Panic Reset Action	1	Bit field indicating potential reset actions that may need to be taken. More than 1 bit can be set, and it is up to the host to decide the sequence of action(s) to take. Use Bit 0 if possible. If Bit 0 is not possible use Bit 1, etc. Bit Description

Requirement ID	Byte Address	Field	# of Bytes		Field Description
				7:6	Reserved. Shall be cleared to zero.
				5	PCIe Conventional Hot Reset.
				4	Main Power Cycle.
				3	PERST#.
				2	PCIe Function Level Reset.
				1	NVM Subsystem Reset.
				0	NVMe Controller Reset.
EREC-3	3	Device Recovery Action 1	1	panic cor panic cor if data in 6 to 1b if device sh	very action to take for handling a device dition. Value is dependent on the device shall set bit 0 to 1b tegrity is intact. The device shall set bit f data integrity is compromised. The all only set bit 3 to 1b or bit 4 to 1b if persistent hardware failure.
				Bit	Description
				7	Reserved. Shall be cleared to zero.
				6	User data loss. The device shall populate LBA Status Information (Log Identifier 0Eh) with the lost/corrupted LBAs.
				5	Sanitize Required.
				4	Device Replacement Required.
				3	Vendor Analysis Required.
				2	Vendor Specific Command Required.
				1	Format NVM Required (Any SES value, any supported combination of other parameters - PIL, PI, MSET, LBAF).
				0	No Action Required.
EREC-4	11:4	Panic ID	8	A Zero va depended The follow Host defi condition	ntify the panic condition encountered. Ilue indicates no panic. Value is nt on the panic condition. Illustration wing Panic ID values are reserved for ned fault codes for known panic IS: INDOOO000_0000000000000000000000000000000

Commented [LP2]: Add requirement to use 06h. Add requirement for Watchdog on hard hang. Add requirement for internal reset on soft hang. Add requirement to document asserts.

Requirement ID	Byte Address	Field	# of Bytes			Field Description
					Byte	Field Description
					11:4	Panic ID definition:
						• 00000000_00000001h -
						Panic caused by flush
						failures or data loss during
				<u> L</u>		power loss handling.
EREC-5	15:12	Device	4	Fi	eld to ir	ndicate device capabilities.
		Capabilities			Bit	Description
					31:2	Reserved. Shall be cleared to zero.
					1	Panic CFS Supported: If set, indicates
						device supports using CFS to notify
						host of a panic condition*.
					0	Panic AEN Supported: If set,
						indicates device supports using AEN
						to notify host of a panic condition*.
						is valid for a device to indicate support
						Panic AEN Supported and Panic
						r Fatal Status Supported. If the device
						both, the device shall only use one of notification mechanisms when
					•	a given panic event.
EREC-6	16	Vendor	1	_		pecific command opcode to recover
LILLE O	10	Specific	_			om panic condition. Only valid when
		Recovery				ecovery Action field value is 04h. When
		Opcode				ecovery Action 1 field value is not 04h,
		·		th	nis field	shall be cleared to zero.
EREC-7	19:17	Reserved	3	Sł	nall be c	leared to zero.
EREC-8	23:20	Vendor	4	CI	DW12 v	alue for the Vendor Specific command
		Specific		to	recove	r device from panic condition. Only
		Command				n bit 2 of the Device Recovery Action
		CDW12				t to 1b. When bit 2 of the Device
						Action 1 field value is not set, this field
				sł	nall be c	leared to zero.
EREC-9	27:24	Vendor	4			alue for the Vendor Specific command
		Specific				r device from panic condition. Only
		Command				en bit 2 of the Device Recovery Action 1
		CDW13				e is set to 1b. When Device Recovery
						field value is not set, this field shall be
				cl	eared to	o zero.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
EREC-13	28	Vendor Specific Command Timeout	1	The amount of time the host should wait for the device to complete the recovery command in seconds.
EREC-14	29	Device Recovery Action 2	1	Bit field indicating potential post reset actions that may need to be taken. If no reset action needed, do not set any of the bits. More than 1 bit can be set, and it is up to the host to decide the sequence of action(s) to take. Use Bit 0 if possible. If Bit 0 is not possible use Bit 1, etc.
				Bit Description
				7:6 Reserved. Shall be cleared to zero.
				5 PCIe Conventional Hot Reset.
				4 Main Power Cycle.
				3 PERST#.
				2 PCIe Function Level Reset.
				1 NVM Subsystem Reset.
				0 NVMe Controller Reset.
EREC-15	30	Device Recovery Action 2 Timeout	1	The amount of time the host should wait for the device to complete the Device Recovery Action 2 in seconds (overrides CAP.TO value).
EREC-16	31	Panic Count	1	The number of Panics the device has
				encountered during its lifetime. This is a
				saturating counter.
EREC-16	63:32	Previous	32	Byte Field Description
		Panic IDs		39:32 Panic ID N-1
				47:40 Panic ID N-2 55:48 Panic ID N-3
				63:56 Panic ID N-4
EREC-10	493:64	Reserved	463	Shall be cleared to zero.
EREC-11	495:494	Log Page Version	2	This indicates the version of the mapping this log page uses. Shall be set to 0003h.
EREC-12	511:496	Log Page GUID	16	Shall be set to 5A1983BA3DFD4DABAE3430FE2131D944h.

4.8.7 Firmware Activation History (Log Identifier C2h) Requirements

This defines the requirements for recording the Firmware Activation History.

Requirement ID	Description						
FWHST-LOG-1	The device shall list the last twenty firmware images that were committed (not downloaded) on the device. This is a circular buffer where the 21st entry is placed in entry 0 (byte offset 8 decimal).						
FWHST-LOG-2	The device	shall have no entries recorded at factory exit.					
FWHST-LOG-3	whenever a	A Firmware Activation History Entry shall be recorded as shown in the table below whenever a new firmware is activated by the device. Firmware downloads shall not generate an entry.					
	Commit Action	Response					
	000b	No Firmware Activation History Entry is recorded.					
	001b	A Firmware Activation History Entry is recorded after the next					
		Controller Level Reset.					
	010b A Firmware Activation History Entry is recorded after the next Controller Level Reset.						
	011b	A Firmware Activation History Entry is recorded immediately.					
FWHST-LOG-4	Redundant activation events shall not generate a new entry to prevent the scrollin out of useful information. An entry shall be considered redundant if it meets ALL the criteria below: 1. Timestamp is within 1 minute from the last RECORDED entry; and 2. Power cycle count is the same; and 3. Current firmware is the same; and 4. New firmware activated is the same; and 5. Slot number is the same; and 6. Commit Action Type is the same; and 7. The Result field has not changed.						
FWHST-LOG-5	Firmware A	ctivation History's log page format shall follow the requirements below.					

4.8.7.1 Firmware Activation History (Log Identifier C2h)

This vendor-specific log page, C2h shall be 4096 bytes with the following functional requirements and field format:

Requirement ID	Byte Address	Field	# of Bytes	Field Description
FAHL-1	0	Log Identifier	1	This field shall be set to C2h.
FAHL-2	3:1	Reserved	3	Shall be cleared to zero.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
FAHL-3	7:4	Valid Firmware Activation History Entries	4	Contains the number of event entries in the log that are valid. Starts at 0 from the factory or after a Clear Firmware Update History (Feature Identifier C1h) Set Feature (see Section 4.12.4 Clear Firmware Update History (Feature Identifier C1h) Set Feature). Increments on each new log entry up to the maximum of 20 entries (see FWHST-LOG-4 (Redundant activation events shall not generate a new entry)).
FAHL-4	71:8	Firmware Activation History Entry 0	64	This field contains the first firmware activation entry.
	1287:122 4	Firmware Activation History Entry 19	64	This field contains the last firmware activation entry.
FAHL-5	4077:128 8	Reserved	2790	Shall be cleared to zero.
FAHL-6	4079:407 8	Log Page Version	2	This indicates the version of the mapping this log page uses. Shall be set to 0001h.
FAHL-7	4095:408 0	Log Page GUID	16	Shall be set to D11CF3AC8AB24DE2A3F6DAB4769A796Dh.

4.8.7.2 *Firmware Activation History Entry Format*This defines the History Entry format for recording Firmware Activation History events.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
FAHE-1	0	Entry Version Number	1	Indicates the version of this entry format used in the device. Shall be set to 01h.
FAHE-2	1	Entry Length (EL)	1	This field indicates the length in bytes of the entry log event data. Shall be set to 40h.
FAHE-3	3:2	Reserved	2	Shall be cleared to zero.
FAHE-4	5:4	Firmware Activation Count	2	This field shall increment every time a firmware activation is attempted regardless of the result. This value shall be cleared to zero when the device is shipped from the factory. This field

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				shall be a saturating counter. This field is not affected by a Clear Firmware History (Feature Identifier C1h) Set Feature and continues counting from the next integer on the next Firmware Activation.
FAHE-5	13:6	Timestamp	8	This field shall indicate the Timestamp of when the new firmware activation is completed, and the device is running with the new firmware. The format of this field shall be as defined in Section 5.21.1.14 Timestamp (Feature Identifier 0Eh) of the NVMe 1.4b specification.
FAHE-6	21:14	Reserved	8	Shall be cleared to zero.
FAHE-7	29:22	Power Cycle Count	8	This field shall indicate the power cycle count in which the firmware activation occurred.
FAHE-8	37:30	Previous Firmware	8	This field shall indicate the previous firmware version running on the device before this firmware activation took place. The format of this field shall be as defined in field Firmware Revision (FR) Section 5.15.2.2 Identify Controller Data Structure of the NVMe 1.4b specification.
FAHE-9	45:38	New Firmware Activated	8	This field shall indicate the activated firmware version that is running on the device after the firmware activation took place. If firmware activation failed, then this field shall display the same information as FAHE-8. The format of this field shall be as defined in field Firmware Revision (FR) Section 5.15.2.2 Identify Controller Data Structure of the NVMe 1.4b specification.
FAHE-10	46	Slot Number	1	This field shall indicate the slot that the activated firmware is in.
FAHE-11	47	Commit Action Type	1	This field shall indicate the Commit action type associated with the firmware activation event.
FAHE-12	49:48	Result	2	This field shall indicate the results of the firmware activation event. A value of 0000h shall represent the firmware commit was successful. A non-zero value shall represent the firmware commit was unsuccessful and the value represents the status code associated with the failure.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
FAHE-13	63:50	Reserved	14	Shall be cleared to zero.

4.8.8 Latency Monitor Log and Feature Set Requirements

The following are requirements for the Latency Monitor Log and Feature Set. For more information about the Latency Monitoring Feature Set (see <u>Appendix C Latency Monitoring Feature Set Theory of</u> Operation).

Requirement ID	Description
LMLOG-1	All values in the Latency Monitor Log Page shall be persistent across power cycles and resets unless otherwise specified.
LMLOG-2	All counters shall be saturating counters (i.e., if the counter reaches the maximum allowable size, it stops incrementing and does NOT roll back to 0).
LMLOG-3	All values in the Latency Monitor Log shall be little endian format.
LMLOG-4	A read of the Latency Monitor Log shall be a simple read of the active data and shall not block IO.
LMLOG-5	Data in the Latency Monitor Log which is read by the host shall be no more than 10 minutes old.
LMLOG-6	When configuring the Latency Monitoring Feature with Set Features the Active Buckets and Static Buckets shall be reset.
LMLOG-7	When powering on, the counters shall run based on the previously configured values. If the values have never been configured, they shall run based on the default values.
LMLOG-8	The Latency Stamp shall be based on the NVMe timestamp set by the last Timestamp (Feature 0Eh) Set Feature command if any. If a NVMe Timestamp (Feature 0Eh) has not been received then the Latency Stamp shall be based on the device power on hours.
LMLOG-9	When the device provides a Latency Stamp of latency outliers, the Latency Stamp shall be based on command completion.
LMLOG-10	When generating a Latency Monitoring Log, the latency shall be no greater than the latency associated with generating a Telemetry log.
LMLOG-11	When configuring this feature, the thresholds shall always be configured such that Active Threshold A < Active Threshold B < Active Threshold C < Active Threshold D. If the host attempts to configure the device in such a way that violates the above rules, the device shall return Invalid Field in Command.
LMLOG-12	The device shall support the Latency Monitoring Feature Set.
LMLOG-13	The Latency Monitor Log page shall be 512 bytes.

Requirement ID	Description
LMLOG-14	Executing a Set Feature command for Latency Monitor (Feature Identifier C5h) shall reset all the contents in the Active/Static Buckets.

4.8.9 Latency Monitor (Log Identifier C3h)

This vendor-specific log page, C3h shall be 512 bytes with the following functional requirements and field format (see <u>Appendix C Latency Monitoring Feature Set Theory of Operation</u> for additional details):

Byte Address	Field	# of Bytes		Field Description		
0	Latency	1		Bit	Description	
	Monitor			7:3	Reserved. Shall be cleared to zero.	
	Status			2	Active Measured Latency Supported.	
					When set to 1b the Active Measured Latency field is supported and shall be populated based on the Active Latency Configuration settings. When cleared to 0b the Active Measured Latency is not supported.	
				1	Active Latency Configuration/Active Latency Mode 1 Supported.	
					When set to 1b the device shall support the Active Latency Configuration with the Active Latency Mode = 1b. When cleared to 0b the device does not support Active Latency Mode =1b.	
			•	0	Latency Monitoring Feature Enabled	
					This is a global feature enable. When set to 1b the Latency	
					Monitoring Feature for this device is enabled. When cleared to 0b all features in the Latency Monitoring Log page are disabled for this device and can be ignored. When cleared to 0b the other fields in this log page	
	Address	Address O Latency Monitor Feature	Address Field Bytes 0 Latency 1 Monitor Feature	Address Field Bytes 0 Latency 1 Monitor Feature	Address Field Bytes 0 Latency 1 7:3 Feature Status 2	

Requirement ID	Byte Address	Field	# of Bytes	Field Description		
				are not power loss safe and may be lost. The default value shall be 07h.		
LMDATA-2	1	Reserved	1	Shall be cleared to zero.		
LMDATA-3	3:2	Active Bucket Timer	2	The Active Bucket Timer is in 5-minute increments. Thus, a value of 0001h is 5 minutes and a value of 0002h is 10 minutes. This represents the amount of time the Active Buckets have been accumulating data. The Active Bucket Timer will saturate at FFFFh. When the Active Bucket Timer reaches the Active Bucket Timer Threshold then the data specified in Appendix C – Latency Monitoring Feature Set Theory of Operation is moved into the Static Buckets, the Active Bucket Timer is cleared to 0000h and restarts counting. If the Active Bucket Timer is running and there is a power cycle the Active Bucket Timer value from before the power cycle shall be restored into the Active Bucket Timer and the Active Bucket Timer shall continue when the device is powered on.		
LMDATA-5	5:4	Active Bucket Timer Threshold	2	Active Bucket Timer Threshold is the threshold used to compare with the Active Bucket Timer. When cleared to 0000h this threshold is not used, the Active Bucket Timer will saturate, and the Static Buckets will not be loaded. This threshold is in 5-minute increments. The factory default value of the Active Bucket Timer Threshold shall be set to 07E0h.		
LIVIDATA-5	6	Active Threshold A	1	This defines Active Threshold A. This is in 5ms increments. A value of 00h represents 5ms. A value of FFh represents 1.280 seconds. The factory default is 05h.		
LMDATA-6	7	Active Threshold B	1	This is in 5ms increments. The factory default is 13h.		
LMDATA-7	8	Active Threshold C	1	This is in 5ms increments. The factory default is 1Eh.		

Requirement ID	Byte Address	Field	# of Bytes	Field Description				
LMDATA-8	9	Active Threshold D	1	This is in 5ms increments. The factory default is 2Eh.				
LMDATA-9	11:10	Active Latency Configuratio n	2	This configures how both the Active Later Stamp, and the Active Measured Latence are updated on a per I/O command (Rea Write, Deallocate) counter basis. When the Active Latency Mode is cleare the Active Latency Stamp and the Active Measured Latency will trigger and updat first time the associated command counter the Active Measured Latency will trigger and updat first time the associated command counter the Active Measured Latency will trigger and updat first time the associated command counter the Active Measured Latency will trigger and updat first time the Active Measured Latency will trigger and updat first time the Active Measured Latency will trigger and updated the Active Measured Latency will trigger and updated the Active Measured Latency will trigger and updated the Active Measured Latency will be active the Active the Active the Active Measured Latency will be active the Active t				
				increments. Once this trigger happens the fields shall not be updated until the Active Latency Stamp and Active Measured Latency fields are reset based on the Active Bucket Timer expiring.				
				When the Active Latency Mode is set to 1b the Active Latency Stamp and the Active Measured Latency fields shall update to show the largest measured latency based on the associated command counter.				
				Bit	Bucket	Counter	Description	
				15:12	N/A	N/A	Reserved. Shall be cleared to zero.	
				11	3	De- allocate/T RIM	Active Latency Mode [11]	
				10	3	Write	Active Latency Mode [10]	
				9	3	Read	Active Latency Mode [9]	
				8	2	De- allocate/T RIM	Active Latency Mode [8]	
				7	2	Write	Active Latency Mode [7]	

Requirement ID	Byte Address	Field	# of Bytes	Field Description					
				6	2	Read	Active Latency Mode [6]		
				5	1	De- allocate/T RIM	Active Latency Mode [5]		
				4	1	Write	Active Latency Mode [4]		
				3	1	Read	Active Latency Mode [3]		
				2	0	De- allocate/T RIM	Active Latency Mode [2]		
				1	0	Write	Active Latency Mode [1]		
				0	Active Latency Mode [0]				
				The defa	ult value s	hall be OFFFI	n.		
LMDATA-10	12	Active Latency Minimum Window	1	This is the minimum number of 100 milliseconds increments between Latency Events for a single Active Latency Stamp and Active Measured Latency. When cleared to 0 this feature is disabled. This count is in 100 millisecond increments, thus a value of 01h is 100 milliseconds and 02h is 200 milliseconds. Once a Latency Stamp/Measured Latency is updated if the Active Latency Minimum Window time has not expired and an event the is configurated to generate a Latency Stamp/Measured Latency occurs the Latency Stamp/Measured Latency will not be recorded.					
LMDATA-11	31:13	Reserved	19	Shall be	cleared to	zero.			
LMDATA-12	47:32	Active Bucket	16	Byte Description					
		Counter 0		47:44 Read Command Counter.					
				43:40 Write Command Counter.					
				39:36 De-Allocate/TRIM Command Counter.					

Requirement ID	Byte Address	Field	# of Bytes		Field Description				
					35:32	Reserve zero.	d. Shall be	e cleared to	
LMDATA-13	63:48	Active Bucket	16		Byte Address	Description			
		Counter 1			63:60	Read Co	ommand C	ounter.	
					59:56	Write C	ommand (Counter.	
					55:52	De-Allo Counte	•	Command	
					51:48	Reserve zero.	d. Shall b	e cleared to	
LMDATA-14	79:64	Active Bucket	16		Byte Address		Descri	otion	
		Counter 2			79:76	Read Co	mmand Co	ounter.	
					75:72	Write Co	ommand C	Counter.	
					71:68	De-Alloc Counter	•	Command	
					67:64	Reserve zero.	d. Shall be	e cleared to	
LMDATA-15	95:80	Active Bucket	16		Byte Address		Descri	otion	
		Counter 3			95:92	Read Co	mmand Co	ounter.	
					91:88	Write Co	ommand C	counter.	
					87:84	De-Alloc Counter	•	Command	
					83:80	Reserve zero.	d. Shall be	e cleared to	
LMDATA-16	191:96	Active Latency Stamp	96	1	latency ever value of FFF Latency Star	d contains a Timestamp for when a event occurred for each counter. A FFFFFFFF_FFFFFFF means the Stamp is not valid. The Active Latency ses the data format for Timestamp as in NVMe.			
					Byte Address	Bucket	Counter	Description	
					191:184	0	Read	Active Latency Stamp 0	

Requirement ID	Byte Address	Field	# of Bytes	Field Description					
				183:176	0	Write	Active Latency Stamp 1		
				175:168	0	De- allocate/ TRIM	Active Latency Stamp 2		
				167:160	1	Read	Active Latency Stamp 3		
				159:152	1	Write	Active Latency Stamp 4		
				151:144	1	De- allocate/ TRIM	Active Latency Stamp 5		
				143:136	2	Read	Active Latency Stamp 6		
				135:128	2	Write	Active Latency Stamp 7		
				127:120	2	De- allocate/ TRIM	Active Latency Stamp 8		
				119:112	3	Read	Active Latency Stamp 9		
				111:104	3	Write	Active Latency Stamp 10		
				103:96	3	De- allocate/ TRIM	Active Latency Stamp 11		
LMDATA-17	215:192	Active Measured Latency	24	This is the measured latency that caused the counter to increment. A value of 0000h means this field is invalid. A value of 0001h represent 1 millisecond. A value of 0002h represents 2 milliseconds.					
				Byte Address	Bucket	Counter	Description		
				215:214	0	Read	Active Measured Latency 0		

Requirement ID	Byte Address	Field	# of Bytes		Field Description					
					213:212	0	Write	Active Measured Latency 1		
					211:210	0	De- allocate/ TRIM	Active Measured Latency 2		
							209:208	1	Read	Active Measured Latency 3
				-	207:206	1	Write	Active Measured Latency 4		
				1	205:204	1	De- allocate/ TRIM	Active Measured Latency 5		
				-	203:202	2	Read	Active Measured Latency 6		
					201:200	2	Write	Active Measured Latency 7		
					199:198	2	De- allocate/ TRIM	Active Measured Latency 8		
					197:196	3	Read	Active Measured Latency 9		
				-	195:194	3	Write	Active Measured Latency 10		
							Active Measured Latency 11			
LMDATA-18	217:216	Active Latency Stamp Units	2	When bit is set to 1b the Active Latency Stamp was based on receiving the NVMe Timestamp. When bit is cleared to 0b the Active Latency Stamp was based on power on hours since the NVMe Timestamp was not received.						

Requirement ID	Byte Address	Field	# of Bytes	Field Description						
					Bit	Bucket	Counter	Description		
					15:12	N/A	N/A	Reserved. Shall be cleared to zero.		
					11	3	De- allocate/T RIM	Active Latency Stamp Unit [11]		
					10	3	Write	Active Latency Stamp Unit [10]		
					9	3	Read	Active Latency Stamp Unit [9]		
				8 2 De- Active Later allocate/T Stamp Unit						
					7	2	Write	Active Latency Stamp Unit [7]		
					6	2	Read	Active Latency Stamp Unit [6]		
					5	1	De- allocate/T RIM	Active Latency Stamp Unit [5]		
					4	1	Write	Active Latency Stamp Unit [4]		
					3	1	Read	Active Latency Stamp Unit [3]		
					2	0	De- allocate/T RIM	Active Latency Stamp Unit [2]		
				1 0 Write Active Latency Stamp Unit [1]						
				0 0 Read Active Latency Stamp Unit [0]						
LMDATA-19	239:218	Reserved	22	2 Shall be cleared to zero.						
LMDATA-20	255:240	Static Bucket Counter 0	16	This is a snapshot of the Active Bucket Counter 0 which is moved to this field when the Active						

Requirement ID	Byte Address	Field	# of Bytes	Field Description				
				Bucket Timer equals the Active Bucket Threshold.	imer			
				Byte Description				
				255:252 Read Command Counter.				
				251:248 Write Command Counter.				
				247:244 De-Allocate/TRIM Commar Counter.	ıd			
				243:240 Reserved. Shall be cleared zero.	to			
LMDATA-21	271:256	Static Bucket Counter 1	16	This is a snapshot of the Active Bucket C 1 which is moved to this field when the Bucket Timer equals the Active Bucket T Threshold.	Active			
				Byte Description				
				271:268 Read Command Counter.				
				267:264 Write Command Counter.				
				263:260 De-Allocate/TRIM Commar Counter.	ıd			
				259:256 Reserved. Shall be cleared zero.	to			
LMDATA-22	287:272	Static Bucket Counter 2	16	This is a snapshot of the Active Bucket C 2 which is moved to this field when the Bucket Timer equals the Active Bucket T Threshold.	Active			
				Byte Description				
				287:284 Read Command Counter.				
				283:280 Write Command Counter.	-			
				279:276 De-Allocate/TRIM Commar Counter.	ıd			
				275:272 Reserved. Shall be cleared zero.	to			
LMDATA-23	303:288	Static Bucket Counter 3	16	This is a snapshot of the Active Bucket Count 3 which is moved to this field when the Active				

Requirement ID	Byte Address	Field	# of Bytes		Field Description				
				1	Bucket Time Threshold.	er equals	the Active	Bucket Timer	
				Byte Description					
					303:300	Rea	d Commai	nd Counter.	
					299:296	Wri	te Comma	nd Counter.	
					295:292	De-A	locate/TRI Count	M Command ter.	
					291:288	Reser	ved. Shall zero	be cleared to	
LMDATA-24	399:304	Static Latency Stamp	96	\	which is mo Bucket Time Threshold. This field co atency ever value of FFF Latency Star Stamp uses defined in N Byte	ved to the requals ntains a to occurrent FFFF_FF mp is not the Time	is field wh the Active imestamp ed for each FFFFFFh m valid. The	Static Latency	
					Address 399:392	0	Read	Static Latency Stamp 0	
					391:384	0	Write	Static Latency Stamp 1	
					383:376	0	De- allocate/ TRIM	Static Latency Stamp 2	
					375:368	1	Read	Static Latency Stamp 3	
					367:360	1	Write	Static Latency Stamp 4	
					359:352	1	De- allocate/ TRIM	Static Latency Stamp 5	

Requirement ID	Byte Address	Field	# of Bytes	Field Description												
				351:344	2	Read	Static Latency Stamp 6									
				343:336	2	Write	Static Latency Stamp 7									
				335:328	2	De- allocate/ TRIM	Static Latency Stamp 8									
				327:320	3	Read	Static Latency Stamp 9									
				319:312	3	Write	Static Latency Stamp 10									
				311:304	3	De- allocate/ TRIM	Static Latency Stamp 11									
LMDATA-25	423:400	Static Measured Latency	24	Active Buck Timer Thres	ich is movet Timer shold. 000h me	ved to this equals the ans this fie sents 1 mi	field when the Active Bucket Id is invalid. A Ilisecond. A									
				Byte Address	Bucket	Counter	Description									
				423:422	0	Read	Static Measured Latency 0									
													421:420	0	Write	Static Measured Latency 1
											419:418	0	De- allocate/ TRIM	Static Measured Latency 2		
				417:416	1	Read	Static Measured Latency 3									

Requirement ID	Byte Address	Field	# of Bytes	Field Description					
				415:414	1	Write	Static Measured Latency 4		
				413:412	2 1	De- allocate/ TRIM	Static Measured Latency 5		
				411:410	2	Read	Static Measured Latency 6		
				409:408	3 2	Write	Static Measured Latency 7		
				407:406	5 2	De- allocate/ TRIM	Static Measured Latency 8		
				405:404	1 3	Read	Static Measured Latency 9		
				403:402	2 3	Write	Static Measured Latency 10		
				401:400	3	De- allocate/ TRIM	Static Measured Latency 11		
LMDATA-26	425:424	Static Latency Stamp Units	2	Units whi	ch is move cket Timer	d to this fie	Latency Stamp Id when the Active Bucket		
				When bit is set to 1b the Static Latency Stamp was based on receiving the NVMe Timestamp and the offset from this. When bit is cleared to 0b the Static Latency Stamp was based on power on hours since the NVMe Timestamp was not received.					
				Bit Bucket Counter Description					
				15:12	N/A	N/A	Reserved. Shall be		

Requirement ID	Byte Address	Field	# of Bytes	Field Description					
							cleared to zero.		
				11	3	De- allocate/T RIM	Static Latency Stamp Unit [11]		
				10	3	Write	Static Latency Stamp Unit [10]		
				9	3	Read	Static Latency Stamp Unit [9]		
				8	2	De- allocate/T RIM	Static Latency Stamp Unit [8]		
				7	2	Write	Static Latency Stamp Unit [7]		
				6	2	Read	Static Latency Stamp Unit [6]		
				5	1	De- allocate/T RIM	Static Latency Stamp Unit [5]		
				4	1	Write	Static Latency Stamp Unit [4]		
				3	1	Read	Static Latency Stamp Unit [3]		
				2	0	De- allocate/T RIM	Static Latency Stamp Unit [2]		
				1	0	Write	Static Latency Stamp Unit [1]		
				0	0	Read	Static Latency Stamp Unit [0]		
LMDATA-27	435:426	Reserved	10	O Shall be cleared to zero.					
LMDATA-37	447:436	Latency Monitor Debug Telemetry Log Size	12	This is the number of dwords in the Latency Monitor Debug Log. This value is in dwords.					

Requirement ID	Byte Address	Field	# of Bytes	Field Description							
LMDATA-28	449:448	Debug Log Trigger Enable	2	This controls what counters can cause a debug log event to be triggered. When set to 1b the first time the bucket/counter combination is incremented a debug log is triggered. When cleared to 0b a debug log will not be triggered when the bucket/counter combination is incremented.							
				Bit	Default Value	Bucket	Counter	Description			
				15:12	N/A	N/A	N/A	Reserved. Shall be cleared to zero.			
				11	0b	3	De- allocat e/TRIM	Active Log Enable [11]			
				10	0b	3	Write	Active Log Enable [10]			
				9	0b	3	Read	Active Log Enable [9]			
				8	0b	2	De- allocat e/TRIM	Active Log Enable [8]			
				7	0b	2	Write	Active Log Enable [7]			
				6	0b	2	Read	Active Log Enable [6]			
				5	0b	1	De- allocat e/TRIM	Active Log Enable [5]			
				4	0b	1	Write	Active Log Enable [4]			
				3	0b	1	Read	Active Log Enable [3]			
				2	0b	0	De- allocat e/TRIM	Active Log Enable [2]			

Requirement ID	Byte Address	Field	# of Bytes	Field Description					
				1	0b	0	Write	Active Log Enable [1]	
				0	0b	0	Read	Active Log Enable [0]	
LMDATA-29	451:450	Debug Log Measured Latency	2	When a debug log is triggered, this is the measured latency for the Latency Stamp that caused the debug log to trigger. A value of 0000h means this field is invalid. A value of 0001h represents 1ms. A value of 0002h represents 2 milliseconds. A value of FFFFh means the Debug Log Measured Latency saturated at the max.					
LMDATA-30	459:452	Debug Log Latency Stamp	8	This is t debug I		cy Stamp	associa	ated with the	
LMDATA-31	461:460	Debug Log Pointer	2		III be set Telemetr			ency Monitor	
LMDATA-32	463:462	Debug Counter Trigger Source	2	set to 1 counter the Deb to 0b th debug I be set. Source Latency Counte	b the dek that trig oug Count is is not to og. No m When th is 0b the Stamp, I r Trigger	oug log is gered the cer Trigge the count ore than e Debug Lo Debug Lo Source is	valid, a e debug er Sourc ter that i 1 bit in Counte og Laten g Point not val	r Source bit is and this is the glog. When the bit is cleared triggered the nothing field shall transport Trigger noy, Debug Log er and Debug lid.	
				Bit	Bucke	t Cou	nter	Description	
				15:12 N/A N/A Reserved. Shall be cleared to zero.					
				11 3 De- Debug allocate/T Counter Trigger Source 11					

Requirement ID	Byte Address	Field	# of Bytes		Fiel	d Descriptio	n
				10	3	Write	Debug Counter Trigger Source 10
				9	3	Read	Debug Counter Trigger Source 9
				8	2	De- allocate/T RIM	Debug Counter Trigger Source 8
				7	2	Write	Debug Counter Trigger Source 7
				6	2	Read	Debug Counter Trigger Source 6
				5	1	De- allocate/T RIM	Debug Counter Trigger Source 5
				4	1	Write	Debug Counter Trigger Source 4
				3	1	Read	Debug Counter Trigger Source 3
				2	0	De- allocate/T RIM	Debug Counter Trigger Source 2
				1	0	Write	Debug Counter

Requirement ID	Byte Address	Field	# of Bytes			Field	d Descripti	on
								Trigger Source
					0	0	Read	Debug Counter Trigger Source 0
LMDATA-33	464	Debug Log	1		Bit		Descrip	tion
		Stamp Units			7:1	Reserved	Shall be c	leared to zero.
				0	Stamp wa NVMe Tir from this. Debug Lar power on Timestam	is based on nestamp ar When cle tency Stam hours sinc p was not	Debug Latency receiving the and the offset ared to 0b the p was based on e the NVMe received.	
LMDATA-34	493:465	Reserved	29	5	Shall be o	cleared to	zero.	
LMDATA-35	495:494	Log Page Version	2		This indicates the version of this log page. Shall be set to 0004h.			
LMDATA-36	511:496	Log Page GUID	16	-	Shall be set to 85D45E58D4E643709C6C84D08CC07A92h.			

4.8.10 Device Capabilities (Log Identifier C4h) RequirementsThis log provides the host a consolidated report of critical device-specific support information. This vendor-specific log page, C4h shall be 4096 bytes with the following functional requirements and field format:

Requirement ID	Byte Address	Field	# of Bytes		Field Description
DCLP-1	1:0	PCI Express Ports	2		mber of physical PCI Express ports ted by the device.
DCLP-2	3:2	OOB Manageme nt Support	2		d indicating the OOB Management ces supported by the device. Description
				15	Shall be set to 1b if the device has been tested and found to comply with the OOB Management requirements of this specification.
				14:3	Reserved. Shall be cleared to zero.

				1 0	Shall be set to 1b if NVMe Basic Management Command is supported. Shall be set to 1b if MCTP over PCle VDM is supported. Shall be set to 1b if MCTP over SMBus is supported.	
DCLP-3	5:4	Write	2		indicating the Write Zeroes command	
		Zeroes		•	nents supported by the device.	
		Command		Bit	Description	
		Support		15	Shall be set to 1b if the device has been tested and found to comply with the Write Zeroes command requirements of this specification.	
				14:5	Reserved. Shall be cleared to zero.	
			4	Shall be set to 1b if the requirements of NVMe-IO-6 (Write Zeroes DEAC bit) are met.		
				3	Shall be set to 1b if the requirements of NVMe-IO-5 are met.	
				2	Shall be set to 1b if setting the FUA bit is supported.	
					1	Shall be set to 1b if setting the DEAC bit is supported.
				0	Shall be set to 1b if the Write Zeroes command is supported.	
DCLP-4	7:6	Sanitize Command	2		indicating the Sanitize command	
		Support		Bit	nents supported by the device. Description	
				15	Shall be set to 1b if the device has	
			15	been tested and found to comply with the Sanitize command requirements of this specification.		
		14:5	Reserved. Shall be cleared to zero.			
		4	Shall be set to 1b if Deallocate LBAs is supported.			
				3	Shall be set to 1b if Overwrite is supported.	

				2	Shall be set to 1b if Block Erase is supported.		
				1	Shall be set to 1b if Crypto-Erase is supported.		
				0	Shall be set to 1b if the Sanitize command is supported.		
DCLP-5	DCLP-5 9:8 Dataset 2 Manageme nt	2		indicating the Dataset Management d requirements supported by the			
		Command		Bit	Description		
	Support		15	Shall be set to 1b if the device has been tested and found to comply with the Dataset Management command requirements of this specification.			
				14:2	Reserved. Shall be cleared to zero.		
					1	Shall be set to 1b if Attribute – Deallocate (AD) is supported.	
				0	Shall be set to 1b if the Dataset Management command is supported.		
DCLP-6	11:10	Write Uncorrectab le	2	Bit field indicating the Write Uncorrectable command requirements supported by the device.			
		Command		Bit	Description		
	Support		15	Shall be set to 1b if the device has been tested and found to comply with the Write Uncorrectable command requirements of this specification.			
			14:4	Reserved. Shall be cleared to zero.			
		3	Shall be set to 1b if the SMART / Health Information (Log Identifier 02h) requirements of NVMe-IO-14 are met.				
				2	Shall be set to 1b if the device supports setting uncorrectable on		

				the maximum number of LBAs allowed by the NVMe specification. 1 Shall be set to 1b if the device supports setting uncorrectable on a single LBA. 0 Shall be set to 1b if the Write Uncorrectable command is supported.
DCLP-7	13:12	Fused Operation Support	2	Bit field indicating the fused command pairs requirements supported by the device. Bit Description
				15 Shall be set to 1b if the device has been tested and found to comply with the fused command pair support requirements of this specification.
				14:1 Reserved. Shall be cleared to zero.
				O Shall be set to 1b if the Compare and Write fused command pair is supported.
DCLP-8	15:14	Minimum Valid DSSD Power State	2	Shall be set to the lowest numbered valid DSSD Power State. Setting a DSSD Power State less than this value results in Invalid Field in Command (see <u>DSSDPSS-2 (DSSD Power State is less than the Minimum DSSD Power State)</u>).
DCLP-9	143:16	DSSD Power State Descriptors	128	Byte 16 is reserved and shall be cleared to zero. The device shall populate bytes 17-143 with a single-byte DSSD Power State Descriptor for each DSSD Power State (see Section 4.8.10.2 DSSD Power State Descriptor) starting with DSSD Power State 1. The DSSD Power State Descriptors shall be populated in increasing order of power state number, i.e., byte 17 contains the descriptor for DSSD Power State 1, byte 18 contains the descriptor for DSSD Power State 2, etc. up to byte 143 which contains the descriptor for
DCLP-10	4077:144	Reserved	3934	DSSD Power State 127. Shall be cleared to zero.

DCLP-11	4079:407 8	Log Page Version	2	This indicates the version of the mapping this log page uses. Shall be set to 0001h.
DCLP-12	4095:408 0	Log Page GUID	16	Shall be set to B7053C914B58495D98C9E1D10D054297h.

4.8.10.1 DSSD Power State Requirements

DSSD power states provide an alternative interface to NVMe power management. DSSD and NVMe Power States are numbered in opposite directions – higher numbered DSSD Power States consume more power than lower numbered DSSD Power States, whereas higher numbered NVMe Power States consume less power than lower numbered NVMe Power States.

Selecting an DSSD Power State via a Set Features command (see <u>Section 4.12.13 DSSD Power State</u> (<u>Feature Identifier C7h</u>) <u>Set Feature</u>) causes the device to run at the highest powered NVMe Power State whose Maximum Power (MP) in watts is less than or equal to the number of the DSSD Power State. For example, placing the device in DSSD Power State number 20 causes the device to enter the highest powered NVMe Power State whose Maximum Power (MP) is less than or equal to 20 watts.

In general, a device will have more DSSD Power States than NVMe Power States. Selecting an DSSD Power State whose number is not the Maximum Power (MP) in watts of an NVMe Power State causes the device to drop down to run at the highest powered NVMe Power State whose Maximum Power (MP) does not exceed the number of the DSSD Power State in watts.

For example, suppose that a device supports NVMe Power State 5 that consumes no more than 20 watts Maximum Power (MP) and NVMe Power State 6 that consumes no more than 16 watts Maximum Power (MP). Selecting DSSD Power State 18 (i.e., 18 watts Maximum Power (MP)) causes the device to enter NVMe Power State 6 and consume no more than 16 watts Maximum Power (MP). In this example the device reports 18 as its DSSD Power State and 6 as its NVMe Power State. Selecting NVMe Power State 6 causes the device to report 16 as its DSSD Power State and 6 as its NVMe Power State.

DSSD Power State 0 does not exist, as a device that is consuming 0 watts Maximum Power (MP) is powered off. DSSD Power States that represent a Maximum Power (MP) less than the lowest powered NVMe Power State are invalid. The lowest numbered valid DSSD Power State is indicated in DCLP-8.

4.8.10.2 DSSD Power State Descriptor

The DSSD Power State Descriptor for each DSSD Power State has the following format:

Requirement ID	Bits	Field	Field Description
DSSDPSD-1	7	Valid DSSD Power State	Shall be set to 1b if the number of this DSSD Power State is greater than or equal to the Minimum Valid OCP Power State (see <u>DCLP-8 (Minimum Valid DSSD Power State</u>)).
DSSDPSD-2	6:5	Reserved	Shall be cleared to zero.

DSSDPSD-3	4:0	NVMe Power	Shall be set to the number of the highest powered
		State	NVMe Power State whose Maximum Power (MP) in
			watts is less than or equal to the number of this
			DSSD Power State.

4.8.11 Unsupported Requirements (Log Identifier C5h)

This log provides a host with a consolidated report of all the Requirement IDs that the device does not support. This vendor-specific log page, C5h shall be 4096 bytes with the following functional requirements and field format:

Requirement ID	Byte Address	Field	# of Bytes		Field Description		
URLP-1	1:0	Unsupporte d Count	2	The numbe	r of Unsupported Requirement IDs.		
URLP-2	15:2	Reserved	14	Shall be cle	ared to zero.		
URLP-3	4063:16	Unsupporte d Requiremen ts List	4048	and 253 16- string shall be requirement Entries shall	re shall be populated with between 0 byte zero padded ASCII strings. Each be the Requirement ID of a t that the device does not support. be in alphabetical order. Unused be cleared to zero.		
				Byte Address	Description		
				31:16	First Unsupported Requirement ID entry.		
				47:32	Second Unsupported Requirement ID entry.		
				4063:404 8	253rd Unsupported Requirement ID entry.		
URLP-4	4077:406 4	Reserved	14	Shall be clea	ared to zero.		
URLP-5	4079:407	Log Page	2	This indicates the version of the mapping this			
	8	Version		log page uses. Shall be set to 0001h.			
URLP-6	4095:408 0	Log Page GUID	16	Shall be set C7BB98B7D	to 0324863BB2C23990E9C722Fh.		

4.8.12 Hardware Revision (Log Identifier C6h)

This log provides a host with information regarding the hardware revision of the device and components on the device.

Requirement ID	Description
HWREV-LOG-1	A value of zero shall be interpreted as the field is not populated.
HWREV-LOG-2	A value of zero shall only be used if the corresponding component data is not available.
HWREV-LOG-3	Manufacturer codes shall be clearly documented and disclosed to the customer.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
HWREV-1	0	Global Device	1	Global Device Hardware Revision.
		HW revision		
HWREV-2	1	ASIC Revision	1	ASIC Controller Revision
HWREV-3	2	PCB	1	PCB Manufacture Code
		Manufacturer		
		Code		
HWREV-4	3	DRAM	1	DRAM Manufacture Code
		Manufacturer		
		Code		
HWREV-5	4	NAND	1	NAND Manufacture Code
		Manufacture		
		Code		
HWREV-6	5	PMIC 1	1	PMIC 1 Manufacture Code
		Manufacture		
		Code		
HWREV-7	6	PMIC 2	1	PMIC 2 Manufacture Code
		Manufacture		
		Code		
HWREV-8	7	Other	1	Other Component 1 Manufacture Code
		Component 1		
		Manufacture		
		Code		
HWREV-9	8	Other	1	Other Component 2 Manufacture Code
		Component 2		
		Manufacture		
		Code		
HWREV-10	9	Other	1	Other Component 3 Manufacture Code
		Component 3		
		Manufacture		
		Code		
HWREV-11	10	Other	1	Other Component 4 Manufacture Code
		Component 4		

		Manufacture		
		Code		
HWREV-12	11	Other	1	Other Component 5 Manufacture Code
		Component 5		
		Manufacture		
		Code		
HWREV-13	12	Other	1	Other Component 6 Manufacture Code
		Component 6		
		Manufacture		
		Code		
HWREV-14	13	Other	1	Other Component 7 Manufacture Code
		Component 7		
		Manufacture		
		Code		
HWREV-15	14	Other	1	Other Component 8 Manufacture Code
		Component 8		
		Manufacture		
		Code		
HWREV-16	15	Other	1	Other Component 9 Manufacture Code
		Component 9		
		Manufacture		
		Code		
HWREV-17	63:16	Reserved	48	Shall be cleared to zero.
HWREV-18	79:64	Device	16	Device Manufacturing Date and Lot Code
		Manufacturing		Detailed Information
		Detailed		
		Information		
HWREV-19	95:80	ASIC Detailed	16	ASIC Date and Lot Code Detailed Information
		Information		
HWREV-20	111:96	PCB Detailed	16	PCB Date and Lot Code Detailed Information
		Information		
HWREV-21	127:112	DRAM Detailed	16	DRAM Date and Lot Code Detailed
HVVKEV-21	127:112	Information	10	Information
		iiiioiiiiatioii		IIIIOIIIIauofi
HWREV-22	143:128	NAND Detailed	16	NAND Date and Lot Code Detailed
		Information		Information
	1	1		

HWREV-23	159:144	PMIC 1 Detailed Information	16	PMIC 1 Date and Lot Code Detailed Information
HWREV-24	175:160	PMIC 2 Detailed Information	16	PMIC 2 Date and Lot Code Detailed Information
HWREV-25	191:176	Other Component 1 Detailed Information	16	Other Component 1 Date and Lot Code Detailed Information
HWREV-26	207:192	Other Component 2 Detailed Information	16	Other Component 2 Date and Lot Code Detailed Information
HWREV-27	223:208	Other Component 3 Detailed Information	16	Other Component 3 Date and Lot Code Detailed Information
HWREV-28	239:224	Other Component 4 Detailed Information	16	Other Component 4 Date and Lot Code Detailed Information
HWREV-29	255:240	Other Component 5 Detailed Information	16	Other Component 5 Date and Lot Code Detailed Information
HWREV-30	271:256	Other Component 6 Detailed Information	16	Other Component 6 Date and Lot Code Detailed Information
HWREV-31	287:272	Other Component 7 Detailed Information	16	Other Component 7 Date and Lot Code Detailed Information
HWREV-32	303:288	Other Component 8 Detailed Information	16	Other Component 8 Date and Lot Code Detailed Information

HWREV-33	319:304	Other Component 9 Detailed Information	16	Other Component 9 Date and Lot Code Detailed Information
HWREV-34	351:320	Serial Number	32	Device Serial Number
HWREV-35	383:352	Country of Origin	32	UTF-8 string detailing the device country of origin.
HWREV-35	493:384	Reserved	110	Shall be cleared to zero.
HWREV-36	495:494	Log Page Version	2	This indicates the version of the mapping this log page uses. Shall be set to 0001h.
HWREV-37	511:496	Log Page GUID	16	Shall be set to BCB6821F30CD4ED0B76B31B99F0F57DC.

4.8.13 TCG Configuration (Log Identifier C7h)

TCG Configuration Log shall be 512 bytes size. This log defines the data points related to TCG Opal Security Subsystem Class (SSC) that would be useful to collect for diagnostic purposes. These data points give point-in-time insight into the configuration and runtime state of the device which can be used to explain either a device or host behavior.

TCG-1	TCG Log Persistence Type	Persistence Type
	Α	Persistent across TCG revert: PSID, Admin SP,
		Locking SP
	В	Not persistent across TCG revert

Requiremen t ID	Byte Addres s	Field	# of Byte s		Persistenc e Type	TCG Log Persistanc e Type
TCGL-1	0	State	1	Bit 0: C_PIN_SID Value indicates whether C_PIN_SID object's PIN column value is equal to MSID or not. 0 = MSID value 1 = Not MSID value Bit 1: C_PIN_SID Authentication Blocked indicates whether authentication of C_PIN_SID authority is blocked or not due to Block SID Authentication command 0 = Not blocked 1 = Blocked	1	N/A

				Bit 2: Locking Enabled (feature code 0x0002) indicates whether the Locking SP is currently in 'Manufactured-Inactive' or 'Manufactured' state. 0 = Locking SP not activated i.e., Manufactured-Inactive state 1 = Locking SP activated i.e., Manufactured state Bit 3: Single User Mode Owner indicates the ownership policy for the RangeStart and RangeLength columns of all Locking Objects in Single User Mode 0 = User Authority 1 = Admins Authority All other bits shall be cleared to zero.		
TCGL-2	3:1	Reserved	3	Shall be cleared to zero.	N/A	N/A
TCGL-3	4	Locking SP Activation Count	1	Count of transitions of the Locking SP from 'Manufactured-Inactive' to 'Manufactured' since the last power cycle.	2	A
TCGL-4	5	TPer Revert Count	1	Count of successful invocations of the Revert method on the Admin SP which causes the entire TPer to revert to Original Factory State, since the last power cycle.	2	А
TCGL-5	6	Locking SP Revert Count	1	Count of successful invocations of the Revert method on the Locking SP which causes the Locking SP to transition from 'Manufactured' to 'Manufactured-Inactive', since the last power cycle.	2	A
TCGL-6	7	Number of Locking Objects	1	The number of Locking Objects supported in the Locking table including the Global Locking Object. If the Locking SP is inactive, then this value shall be cleared to zero.	1	N/A
TCGL-7	8	Number of Single User Mode Locking Objects	1	The current number of Locking Objects in the Locking table that are in Single User Mode including the Global Locking	1	N/A

				Object. If the Locking SP is inactive, then this value shall be cleared to zero.		
TCGL-8	9	Number of Range Provisioned Locking Objects	1	The current number of non-Global Locking Objects with non-zero RangeLength value. If the Locking SP is inactive, then this value shall be cleared to zero.	1	N/A
TCGL-9	10	Number of Namespace Provisioned Locking Objects	1	The current number of non-Global Locking Objects with non-zero NamespaceID value. If the Locking SP is inactive, then this value shall be cleared to zero.	1	N/A
TCGL-10	11	Number of Read Locked Locking Objects	1	The current number of provisioned non-Global Locking Objects with ReadLockEnabled set to True and ReadLocked set to True. If the Locking SP is inactive, then this value shall be cleared to zero.	1	N/A
TCGL-11	12	Number of Write Locked Locking Objects	1	The current number of provisioned non-Global Locking Objects with WriteLockEnabled set to True and WriteLocked set to True. If the Locking SP is inactive, then this value shall be cleared to zero.	1	N/A
TCGL-12	13	Number of Read Unlocked Locking Objects	1	The current number of provisioned non-Global Locking Objects with ReadLockEnabled set to True and ReadLocked set to False. If the Locking SP is inactive, then this value shall be cleared to zero.	1	N/A
TCGL-13	14	Number of Write Unlocked Locking Objects	1	The current number of provisioned non-Global Locking Objects with WriteLockEnabled set to True and WriteLocked set to False. If the Locking SP is inactive, then this value shall be cleared to zero.	1	N/A
TCGL-14	15	Reserved	1	Shall be cleared to zero.	N/A	N/A
TCGL-15	19:16	SID Authenticatio n Try Count	4	The Tries value for the C_PIN_SID Credential Object which indicates the number of failed authentication attempts for that object since the last power cycle, successful authentication or TPer revert.	1	N/A

TCGL-16	23:20	SID Authenticatio n Try Limit	4	The TryLimit value for the C_PIN_SID Credential Object which indicates the maximum number of failed authentication attempts for that object.	1	N/A
TCGL-17	27:24	Programmatic TCG Reset Count	4	The count of Programmatic TCG Resets received by the device since the last power cycle.	3	А
TCGL-18	31:28	Programmatic Reset Lock Count	4	The count of state transitions for all provisioned non-Global Locking Objects in the following conditions: • Read Lock Transition when ReadLockedEnable = True and ReadLocked transitions from False to True. • Write Lock Transition when WriteLockedEnable = True and WriteLocked transitions from False True. The count shall increment for both explicit and implicit Programmatic Resets since the last power cycle.	3	A
TCGL-19	35:32	TCG Error Count	4	The count of TCG errors reported to the host.	3	А
TCGL-19	493:36	Reserved	458	Shall be cleared to zero.	N/A	N/A
TCGL-20	495:49 4	Log Version	2	Shall be set to 0001h.	N/A	N/A
TCGL-21	511:49 6	Log Page GUID	16	Shall be set to 54E02A9DFA5447C083E6E07EBD24400 6.	N/A	N/A

4.8.14 TCG History (Log Identifier C8h) RequirementsThis defines the requirements for recording TCG History Entries.

Requirement ID	Description							
TCGHST-LOG-1	ists the last 84 TCG commands executed on the device. This is a circular buffer							
ICGHS1-LOG-1	where the 1st and 85th entries are placed in TCG History Entry 0.							
TCGHST-LOG-2	When the drive is first shipped from the factory, there are no entries recorded.							
	An entry shall be recorded whenever any of the following TCG commands are							
TCGHST-LOG-3	completed:							
TCGH31-LOG-3	Level 0 Discovery							
	Start Session							

•	Authenticate method (entries only recorded when the authority
sn	ecified is not locked out)

- Close Session by the host when it sends an End-Of-Session token
- · Properties method
- Stack Reset
- TPer Reset
- · Get method
- Set method
- GenKey method
- Random method
- Activate method
- Revert method
- RevertSP method
- Reactivate method
- Erase method
- Block SID Authentication
- Assign method
- Deassign method

Redundant TCG commands shall not generate a new entry to prevent the scrolling out of useful information. An entry shall be considered redundant if it meets ALL the criteria below:

- Power cycle count is the same; and
- Active firmware revision remains the same; and
- TCG command is the same as the previous one; and
- TPer state remains the same (i.e., there is no change either in the device behavior or does not change host visible state); and
- The Result field has not changed.

TCGHST-LOG-4

Following are examples of commands that will not generate a new entry:

- Setting attribute of a TCG Object to a value which is same as the current value
- Getting or setting value for an informative attribute of a TCG object like CommonName of a Locking Object
- Getting or setting data from/to byte tables
- Unsuccessful authentication attempt that will return AUTHORITY_LOCKED_OUT status

TCGHST-LOG-5 TCG History's log page format shall follow the requirements below.

4.8.15 TCG History (Log Identifier C8h)

This vendor-specific log page, C8h shall be 4096-bytes with the following functional requirements and field format. This log page is organized into a header with total counts of TCG commands sent to device, followed by a circular buffer of up to 84 entries with TCG command details. Any unused entries shall be cleared to zero.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
TCGHL-1	0	Log Identifier	1	Shall be set to C8h.
TCGHL-2	3:1	Reserved	3	Shall be cleared to zero.
TCGHL-3	7:4 TCG History Entry Count		4	Shall indicate the number of TCG commands that resulted in the generation of a TCG Command History Entry. Shall be cleared to zero on factory exit.
	55:8	TCG History Entry 0	48	Contains the first TCG History entry.
TCGHL-4				
	4039:3992	TCG History Entry 83	48	Contains the last TCG History entry.
TCGHL-5	4077:4040	Reserved	38	Shall be cleared to zero.
TCGHL-6	TCGHL-6 4079:4078 Log Page Version		2	Indicates the version of the mapping this log page uses. Shall be set to 0001h.
TCGHL-7	4095:4080	Log Page GUID	16	Shall be set to 88D7909696D04E27949009C6704B513E.

4.8.15.1 TCG History Entry Format

This defines TCG History Entry format.

Requirement	Byte	Field	# of	Field Description	Persistence	Feature
ID	Address	Field	Bytes	Field Description	Туре	Classification
TCGHE-1	0	Entry Version Number	1	Indicates the version of this entry format used in the device. Shall be set to 01h.	N/A	N/A
TCGHE-2	1	Entry Length (EL)	1	Indicates the length in bytes of the entry log event data. Shall be set to 30h.	N/A	N/A
TCGHE-3	3:2	Power Cycle Count	2	Shall indicate the power cycle count in which the TCG command occurred.		А
TCGHE-4	7:4	TCG Command Count	4	Shall increment every time a TCG command is completed regardless of the result and an entry is recorded per TCGHST- LOG-3 and TCGHST-		A

				LOG-4. This value shall be cleared to zero when the device is shipped from the factory.		
TCGHE-5	15:8	TCG Command Completion Timestamp	8	Shall indicate the Timestamp of when the TCG command is completed. The format of this field shall be as defined in section 5.21.1.14 Timestamp (Feature Identifier 0Eh) of the NVMe 1.4b specification.	2	А
TCGHE-6	23:16	Invoking ID	8	The 8-byte UID of the table, object, or SP upon which the method is being invoked.	2	A
TCGHE-7	31:24	Method ID	8	The 8-byte UID of the method being invoked.	2	Α
TCGHE-8	33:32	ComId	2	The 2-byte ComID specified by the host in the command.	2	А
TCGHE-9	34	Protocolld	1	The Protocol Id specified by the host in the command.	2	А
TCGHE-10	35	Status	1	The TCG status on completion of the command.	2	А
TCGHE-11	37:36	Process Time	2	Time in milliseconds it took to process the command.	2	А
TCGHE-12	47:38	TCG Command Specific Context	10	Additional context for a TCG command. If a command has no additional context this shall be cleared to zero. Any unused bytes shall be cleared to zero.	2	А

4.8.15.2 TCG Command Specific ContextThis defines the additional command specific context for specific TCG commands (TCGHE-12).

4.8.15.2.1 Authenticate method

Byte Address	Field	# of Bytes	Field Description
45:38	45:38 Authority ID	8	The 8-byte UID of the authority on which the
45.56	Authority ID	8	authenticate method is being invoked.
			The value of the Tries column of the C_PIN
46	Tries Count	1	object corresponding to the authority after the
			authenticate method completes.
47	Reserved	1	Shall be cleared to zero.

4.8.15.2.2 Activate method

Holzotziz Honraco Hierinou					
Byte Address	Field	# of Bytes	Field Description		
38	Range Start Range Length Policy	1 1	The value of the RangeStartRangeLengthPolicy parameter passed to the Activate method.		
47:39	Reserved	9	Shall be cleared to zero.		

4.8.15.2.3 Reactivate method

Byte Address	Field	# of Bytes	Field Description
38	Range Start Range Length Policy		The value of the RangeStartRangeLengthPolicy parameter passed to the Reactivate method.
47:39	Reserved	9	Shall be cleared to zero.

4.8.15.2.4 Assign method

Byte Address	Field	# of Bytes	Field Description				
41:38	Namespace Id	4	The value of the NamespaceID parameter passed to the Assign method.				
47:42	Reserved	6	Shall be cleared to zero.				

4.8.15.2.5 Block SID Authentication command

10:13:23 Block SID / Willendication command							
Byte Address	Field	# of Bytes	Field Description				
38	Clear Events	1	The value of the Clear Events parameter passed to the Block SID Authentication command.				
47:39	Reserved	9	Shall be cleared to zero.				

4.8.16 Vendor Unique Telemetry String Log (Log Identifier C9h)

The Vendor Unique Telemetry String Log enables mapping of Vendor Unique Static Identifiers and/or Debug Class/Event Identifiers combinations to ASCII strings.

4.8.16.1 Telemetry String Log Requirements

Requirement ID	Description
TELSLG_1	All Vendor Unique Static Identifiers contained in Data Area 1 and Data Area 2 shall be contained in this log.
TELSLG_2	String Identifier Table entries shall be in numeric order such that the smallest Vendor Unique Static Identifier is at the lowest address.
TELSLG_3	All Debug Event Class/Event Identifier combinations contained in Data Area 1 and Data Area 2 shall be contained in this log.
TELSLG_4	String Event Table entries shall be in numeric order such that the smallest Debug event Class is at the lowest address.
TELSLG_5	String Event Table entries shall be in numeric order such that for a single Debug Event Class the smallest Event Identifier is at the lowest address.
TELSLG_6	In the ASCII table characters which are not valid (beyond the length of the ASCII length) shall be set to space <space>.</space>

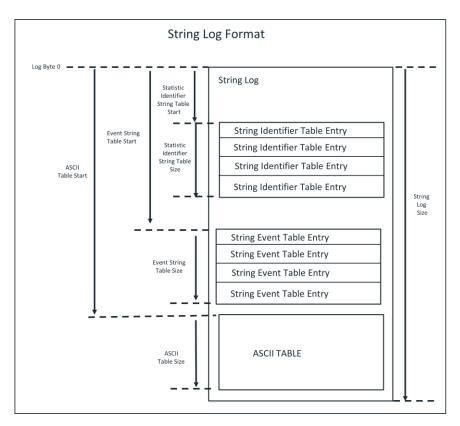
4.8.16.2 Telemetry String Log Format

This vendor-specific log page size shall be based on String Log Size Upper and String Log Size Lower which can be found in Data Area 1 or this log. The following is the format of the Telemetry String Log:

Requirement ID	Byte Address	Field	# of Bytes	Field Description
TELSTR-LOG-1	0	Log Page Version	1	Shall be set to 01h.
TELSTR-LOG-2	15:1	Reserved	7	Shall be cleared to zero.
TELSTR-LOG-3	31:16	Log Page GUID	16	Shall be set to B13A83691A8F408B9EA495940057AA44h.
TELSTR-LOG-4	39:32	String Log Size (SLS)	8	Shall be set to the number of DWORDS in the String Log.
TELSTR-LOG-5	63:40	Reserved	24	Shall be cleared to zero.
TELSTR-LOG-6	71:64	Statistics Identifier String Table Start	8	Shall be set to the number of DWORDS from byte 0 of this log page to the start of the Statistics Identifier String Table.
TELSTR-LOG-7	79:72	Statistics Identifier String Table Size	8	Shall be set to the number of DWORDS in the Statistics Identifier String Table.
TELSTR-LOG-8	87:80	Event String Table Start	8	Shall be set to the number of DWORDS from byte 0 of this log page to the start of the Event String Table.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
TELSTR-LOG-9	95:88	Event String Table Size	8	Shall be set to the number of DWORDS in the Event String Table.
TELSTR-LOG- 10	103:96	ASCII Table Start	8	ASCII Table Start (ASCTS). This is the number of DWORDS from byte 0 of this log page until the ASCII Table Starts.
TELSTR-LOG- 13	119:112	VU Reason Start	8	This is the start of the VU reason code ASCII string.
TELSTR-LOG- 14	121:120	VU Reason Size	2	This is the Size of the VU reason code ASCII string in dwords
TELSTR-LOG- 15	127:122	Reserved	6	Reserved. Cleared to 0.
TELSTR-LOG- 16	111:104	ASCII Table Size	8	ASCII Table Size. This is the number of DWORDS in the ASCII Table.
TELSTR-LOG- 17	(SITS*4) + (String Identifier Table Size *4)-1: (SITS*4)	String Identifier Table	SITS*4	The format of the String Identifier Table can be seen below.
TELSTR-LOG- 18	(SETS*4) + (String Event Table Size *4)-1: (SETS *4)	String Event Table	SETS*4	The format of the String Event Table can be seen below.
TELSTR-LOG- 19	(ASCTS *4)+ (ASCI Table Size *4)-1: ASCTS *4	ASCII Table	ASCTS *4	The format of the ASCII can be seen below.

A diagram of the String Log format can be seen below.



4.8.16.3 Statistics Identifier String Table Entry

The Statistic Identifier String Table enables translating from vendor unique statistic identifiers to ASCII labels. The format of an entry for the Statistic Identifier String Table Entry is below.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
STR-ID-1	1:0	Vendor Specific Statistic Identifier	2	Shall be set the Vendor Unique Statistic Identifier number.
STR-ID-2	2	Reserved	1	Shall be cleared to zero.
STR-ID-3	3	ASCII ID Length	1	Shall be set the number of ASCII Characters that are valid. This is a zero-based value so a value of Oh is 1 character.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
STR-ID-4	11:4	ASCII ID offset	8	Shall be set to the offset from DWORD 0/Byte 0 in the log to the start of the ASCII data of this identifier. This value is in DWORDs.
STR-ID-5	15:12	Reserved	4	Shall be cleared to zero.

4.8.16.4 Event Identifier String Table Entry

The Event Identifier String Table enables translating from vendor unique event identifiers to ASCII labels. The format of an entry for the Event Identifier String Table Entry is below.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
STR-EV-1	0	Debug Event Class	1	Shall be set the Vendor Unique Event Identifier class.
STR-EV-2	2:1	Event Identifier	2	Shall be set the Vendor Unique Event Identifier number.
STR-EV-3	3	ASCII ID Length	1	Shall be set to the number of ASCII Characters that are valid. This is a zero-based value so a value of 0h is 1 character.
STR-EV-4	11:4	ASCII ID offset	8	Shall be set to the offset from DWORD 0/Byte 0 in the log to the start of the ASCII data of this identifier. This value is in DWORDs.
STR-EV-5	15:12	Reserved	4	Shall be cleared to zero.

4.8.16.5 ASCII String Example

Below is an example of how the ASCII ID Length/Decode example:

ASCII ID Length = 0Ch

Byte	Data Byte	ASCII Character
400	54h	T
401	45h	Е
402	53h	S
403	54h	T
404	20h	<space></space>
405	45h	E
406	58h	X
407	41h	A
408	4Dh	M
409	50h	P
410	4Ch	L
411	45h	Е
412	21h	!

413	31h	1
414	32h	2
415	33h	3

In this example the length is 0Ch, which is 12 decimal. This is a zero-based count and thus there are 13 characters to print. The first 13 characters shall be printed. Thus, the message to print is: "TEST EXAMPLE!"

The ASCII characters of 1, 2 and 3 are not printed as they are beyond the length of the ASCII String as they belong to the next string entry.

4.9 Host and Controller Initiated Telemetry Logs

The following requirements define an OCP standardized format for Data Area 1 and Data Area 2 for both Telemetry Host-Initiated Log (Log Identifier 07h) and Telemetry Controller-Initiated Log (Log Identifier 08h).

4.9.1 Theory of Operation

This feature is designed to enable both customers and suppliers to have increased visibility into monitoring and debugging devices.

4.9.2 Data Partitioning Overview

The data provided by the device for debugging is broken into two categories in this proposal. There is data that impacts I/O and data that does not impact I/O. The data generated by the device for monitoring and/or debugging which does not impact I/O (performance/latency) for active commands in progress goes into Data Area 1. The data generated by the device for monitoring and/or debugging which impacts I/O (performance/latency) for active commands in progress goes into Data Area 2. It should be noted that the data format in the host-initiated telemetry and the controller-initiated log is the same format and the information reported in both host-initiated and controller-initiated Data Areas 1 and 2 shall be the same reported data.

4.9.3 Statistic Area

The Statistic Area contains a group of Statistic Descriptors. The Statistic Descriptors may be counters or other statistics where each statistic is a value with a static size. The attributes associated with each of these statistics are Statistic Identifier, Persistence Type and the length of the data field associated with the Statistic Identifier.

4.9.4 Event FIFO

The Event FIFO is a queue that contains events that are generated. There are a total of up to 16 independent Event FIFO queues that may be configured between Data Area 1 and Data Area 2. It should be noted that the ordering relationship of events in the event FIFO is determined by the device.

4.9.5 Existing NVMe Logs

There are many existing NVMe Logs that are useful for monitoring the device. These logs have been overlayed into Data Area 1. This is done to enable all the monitoring information to be gathered when polling the telemetry log.

4.9.6 Debug Structure Overview Summary

The debug structure for Data Area 1 and 2 can be seen in the figure below.

Data Area 1

Copy of Existing NVMe Logs

Statistics Area 1

X number of Event FIFOs

Data Area 2

Statistics Area 2

Y number of Event FIFOs

4.9.7 Telemetry Data Requirements

The following applies to telemetry logging as the ability to quickly debug failures is required:

Requirement ID	Description
TEL-1	The device shall track the operational/event history and any critical parameters that can be used to debug issues.
TEL-2	The supplier shall provide a table that categorizes the reason identifiers that are a super set of the panic IDs in EREC-4 (Panic ID).
TEL-3	The device shall not lose debug data relevant to the current operating state due to any legal operation. Telemetry data including SMART / Health Information (Log Identifier 02h) and SMART / Health Information Extended (Log Identifier C0h) shall be persisted across power loss, all resets, Format command, Sanitize command, or device entering any protected mode (e.g., read only or panic mode).
TEL-4	The Reason Identifier field (in Telemetry Controller and Host Initiated Logs) shall be the most recent failure identifier and shall not be cleared by a power cycle or reset.

Requirement ID	Description						
TEL-5	The table below provides the specifications for the controller-initiated and the host-initiated log page Data Areas 1 and 2. Implementation of Data Areas 3 and 4 are optional.						
	Data Area	Purpose	Profile 0 Data Area Size	Latency Impact to IO			
	1	Periodic logging for monitoring trends/problems	16384 bytes	< 1ms max			
	2	Logging for debug items that impact latency	16384 bytes	>1ms max			
l	3	Optional Vendor Unique	-	-			
	4	Optional Vendor Unique	-	-			
TEL-6		l set the Telemetry Host-Initia -Initiated Log (Log Identifier 0					
TEL-7	The device shall set the Telemetry Controller-Initiated Data Area 1 Last Block field of the Telemetry Controller-Initiated Log (Log Identifier 08h) to 0020h as the factory default.						
TEL-8		The device shall set the Telemetry Host-Initiated Data Area 2 Last Block field of the Telemetry Host-Initiated Log (Log Identifier 07h) to 0040h as the factory default.					
TEL-9	The device shall set the Telemetry Controller-Initiated Data Area 2 Last Block field of the Telemetry Controller-Initiated Log (Log Identifier 08h) to 0040h as the factory default.						
TEL-10	Information in Data Area 1 shall be updated in the background at least once every ten minutes. Collection of the data in Data Area 1 shall not impact I/O latency by mor than 1ms.						
TEL-11	If the device supports an encrypted log for debug this may be contained in Data Area 3 and/or 4.						
TEL-12	The number of Timestamp Events inserted into the Event FIFOs shall be sufficient to debug.						
TEL-13		The information in the Controller-Initiated Telemetry Log and Host Initiated Telemetry Log shall be the same reported data.					
TEL-14		rror ID in the TELRI-1 Reason le etry AEN event.	dentifier field shall (cause a Controller			
TEL-15	When the device zero value.	ce encounters a failure/error t	he Error ID in TELRI	-1 shall be a non-			

Requirement ID	Description
TEL-16	Decode of Telemetry Data in Data Area 1 and Data Area 2 as defined in this specification shall be supported through the OCP based NVMe CLI tool. And shall meet the requirements for SEC-22.
TEL-17	Data Area 1 and Data Area 2 shall be supported per this specification.
TEL-18	A minimum of two Telemetry Profiles shall be supported.
TEL-19	Telemetry Profile 0 shall be the default profile from the factory.
TEL-20	Telemetry Profile 1 shall be sized for maximum debuggability.
TEL-21	The device shall support TP4109 to enable the host to access specific host telemetry.
TEL-22	On a firmware update the vendor unique fields shall not be re-purposed or removed from the telemetry string log. This is to ensure on a firmware update that the telemetry log may still be decoded correctly.

4.9.8 Telemetry Reason Identifier FormatThe format of the Reason Identifier shall be as follows:

Requirement ID	Byte Address	# of Bytes	Field		Fi	ield Description	
TELRI-1	63:0	64	Error ID	Err or	The device shall set a unique Error ID defining the persistent or transient error at the time of log capture.		
TELRI-2	71:64	8	File ID	file	File name or hash of the source file where the error occurred. Clear to zero if not applicable.		9
TELRI-3	73:72	2	Line Number	wł	Line Number in the source file where the error occurred. Clear to zero if not applicable.		ar
					Bit	Description	
					7:4	Reserved. Shall be cleared to zero.	
TELRI-4	74	1	cleared to zero. 3 VU Reason Extension Field i valid.				
				2	Shall be set to 1b if the Error ID is valid. Shall be cleared to 0b if		

Requirement ID	Byte Address	# of Bytes	Field	Field Description
				Error ID is not valid.
				1 Shall be set to 1b if the File ID is valid. Shall be cleared to 0b if File ID is not valid.
				O Shall be set to 1b if the Line Number is valid. Shall be cleared to 0b if Line Number is not valid.
TELRI-5	95:75	21	Reserved	Shall be cleared to zero.
TELRI-6	127:96	32	VU Reason Extension	Vendor Unique reason code.

4.9.9 Debug Profiles

There are many possible ways to configure Data Area 1, Data Area 2, the Statistic Areas and Event FIFOs. Depending on the problem being investigated different configurations of these fields may be desired. Debug profiles is the mechanism that has been created to address this challenge. The device will list the number of debug profiles supported. The host may then configure the profile based on the problem being investigated.

4.9.10 Statistic Descriptor

The format of the Statistic Descriptor is below.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
STATF-1	1:0	Statistic Identifier	2	Shall contain the identifier that defines the data format of this entry.
STATF-2	2	Persistence Type	1	Shall contain the corresponding Persistence Type for this data entry.
STATF-3	3	Statistic Data Size	1	Shall contain the number of DWORDS that is used by the Statistic Specific Data field.
STATF-4	(Statistic Data Size *4)+3:4	Statistic Specific Data	Statistic Data Size *4	Shall contain data specific extended information for this Statistic Data Entry type, if this exists.

4.9.11 Statistic Identifiers

The definitions of the Statistic Identifiers are below. Statistic Identifier's which provide value in debugging the device should be implemented. The latency impact of collecting a given statistic will determine which data area that statistic will go into based TEL-5.

Requirement ID	Statistic Identifier	Recommended Persistence Type	# of DWORDS	Statistic Specific Data Field	Field Description
STATI-1	0001h	1	1	Outstanding Admin Commands	Number of outstanding Admin commands submitted by the host which have not been processed by the controller. Pulled from Submission Queue but not yet pushed to the Completion Queue. This count shall not include Asynchronous Event Request (AER) commands.
STATI-2	0002h	1	1	Host Write Bandwidth	The percentage of the current write bandwidth allowed to the NAND backend due to host writes.
STATI-3	0003h	1	1	GC Write Bandwidth	The percentage of the current write bandwidth allowed to the NAND backend due to internal writes. STATI-2 and STATI-3 shall add to 100%.
STATI-4	0004h	1	1	Active Namespaces	Shall be the number of Active Namespaces attached to the NVM subsystem.
STATI-5	0005h	5	2	Internal Write Workload	Number of outstanding LBAs corresponding to the Internal Write Queue Depth (STATI-7).
STATI-6	0006h	5	2	Internal Read Workload	Number of outstanding LBAs corresponding to the Internal Read Queue Depth (STATI-8).
STATI-7	0007h	5	1	Internal Write Queue Depth	Number of outstanding Write commands submitted by the host which have not been processed by the controller. Pulled from Submission Queue but not yet pushed to the Completion Queue.
STATI-8	0008h	5	1		Number of outstanding Read commands submitted by the host which have not been processed by

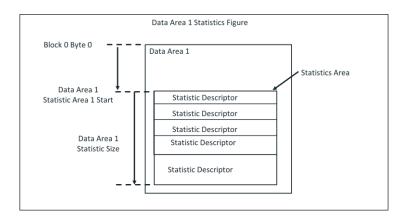
Requirement ID	Statistic Identifier	Recommended Persistence Type	# of DWORDS	Statistic Specific Data Field	Field Description
					the controller. Pulled from Submission Queue but not yet pushed to the Completion Queue.
STATI-9	0009h	5	2	Pending Trim LBA Count	From a device perspective this is the current number of LBAs pending completion of the background trim process due to host Dataset Management – Deallocate commands.
STATI-10	000Ah	4	2	Host Trim LBA Request Count	Number of LBAs that have been requested by Dataset Management – Deallocate commands since last Telemetry Log collection.
STATI-11	000Bh	1	1	Current NVMe Power State	Currently set NVMe Power State Descriptor at the time of this Telemetry Log collection.
STATI-12	000Ch	1	1	Current DSSD Power State	Currently set DSSD Power State Descriptor at the time of this Telemetry Log collection.
STATI-13	000Dh	4	2	Program Fail Count	The number of program operation failure events for the life of the device.
STATI-14	000Eh	4	2	Erase Fail Count	The number of erase operation failure events for the life of the device.
STATI-15	000Fh	4	4	Read Disturb Writes	Number of bytes written due to read disturb relocations for the life of the device.
STATI-16	0010h	4	4	Retention Writes	Number of bytes written due to retention relocation for the life of the device.
STATI-17	0011h	4	4	Wear Leveling Writes	Number of bytes written due to wear leveling for the life of the device.
STATI-18	0012h	4	2	Read Recovery Writes	Number of bytes written due to read recovery for the life of the device.

Requirement ID	Statistic Identifier	Recommended Persistence Type	# of DWORDS	Statistic Specific Data Field	Field Description	
STATI-19	0013h	1	2	GC Writes	Number of bytes written due to garbage collection since last Telemetry Log collection using by reading either host-initiated or controller-initiated log.	
STATI-20	0014h	4	1	SRAM Correctable Count	due to devic	er of correctable errors e SRAM single error ver the device lifetime.
STATI-21	0015h	4	1	DRAM Correctable Count	due to devic	er of correctable errors e DRAM single error ver the life of the device.
STATI-22	0016h	4	1	SRAM Uncorrectabl e Count	Total number of uncorrectable errors due to device SRAM double error detection.	
STATI-23	0017h	4	1	DRAM Uncor rectable Count	Total number of uncorrectable errors due to device DRAM double error detection.	
STATI-24	0018h	4	1	Data Integrity Error Count	Total number of data integrity errors due to FTL metadata integrity checks.	
STATI-25	0019h	4	1	Read Retry Error Count	The number of reads for the device lifetime performed on the flash because of error correction (e.g., Read retries, LDPC iterations, etc.).	
STATI-26	001Ah	4	1	PERST Events Count	Number of PERST events processed by the NVM Subsystem for the lifetime of the device. This count shall only increment if the CC.EN bit is set to 1b.	
STATI-27	001Bh	4	2	Max Die Bad Block		tion is based on a single as the largest number of
					1:0	Worst Die % of bad blocks.

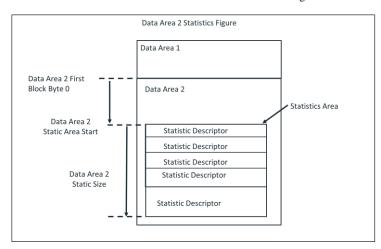
Requirement ID	Statistic Identifier	Recommended Persistence Type	# of DWORDS	Statistic Specific Data Field	Fie	eld Description
					3:2	Worst Die Raw Number of bad blocks
					7:4	Reserved. Cleared to 0h.
STATI-28	001Ch	4	2	Max NAND Channel Bad Block	in a single N	tion is based on the dies AND channel which has umber of bad blocks.
					Byte Address	Field Description
					1:0	Worst NAND Channel % of bad blocks.
					3:2	Worst NAND Channel Number of bad blocks
					7:4	Reserved. Cleared to Oh.
STATI-29	001Dh	4	2	Minimum NAND Channel Bad	in a single N	ntion is based on the dies IAND channel which has t number of bad blocks.
				Block	Byte Address	Field Description
					1:0	Best NAND Channel % of bad blocks.
					3:2	Best NAND Channel Number of bad blocks
					7:4	Reserved. Cleared to Oh.
STATI-30	7FFFh:001 Eh			Reserved		ntifier's between 001Eh re reserved for future
STATI-31	FFFFh:800 0h			Vendor Unique		ntifier's between 8000h re vendor unique.

4.9.12 Statistic Descriptor Location

The Statistic Area location in Data Area 1 can be found by using the Data Area 1 Statistic Area 1 Start and Data Area 1 Statistic Area 1 Size. This can be seen in the Data Area 1 Statistics Figure below.



The Statistic Area location in Data Area 2 can be found by using the Data Area 2 Statistic Area Start and Data Area 2 Statistic Size. This can be seen in the Data Area 2 Statistic Figure below.



4.9.13 Statistic Requirements

Requirement ID	Description
SDL-1	Statistic Area 1 shall not cross from Data Area 1 to Data Area 2.
SDL-2	Bytes in the Statistic Areas that are not contained in a Statistic Descriptor shall be zero.
SDL-3	The decode of the Vendor Unique Statistic Identifiers shall be provided to the customer via the Vendor Unique Telemetry Strings Log page.

4.9.14 Event FIFO Requirements

4.9.14.1 Event Descriptor

The Event Descriptor is used to log debug events in the Event FIFOs.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
EVENTD-1	0	Debug Event Class Type	1	Shall contain the corresponding Event Class Type for this event.
EVENTD-2	2:1	Event ID	2	Shall contain the corresponding Event ID for this event.
EVENTD-3	3	Event Data Size	1	Shall contain the number of DWORDS that is used by the Event Specific Data field.
EVENTD-4	(Event Data Size *4)+3:4	Event Specific Data	Event Data Size *4	Shall contain event specific extended information for this event (if any).

4.9.14.2 Event Classes

This section defines the Event Class information that can be used to debug issues with the device.

4.9.14.2.1 Debug Event Class Types

Debug Event Class Code	Field Description			
00h	Reserved			
01h	Timestamp Debug Class			
02h	PCIe Debug Class			
03h	NVMe Debug Class			
04h	Reset Debug Class			
05h	Boot Sequence Debug Class			
06h	Firmware Assert Debug Class			
07h	Temperature Debug Class			
08h	Media Debug Class			
09h	Media Wear Class			
0Ah	Static Snapshot Class			
7F-0Bh	Reserved			
FF-80h	Vendor Unique Class			

4.9.14.2.2 Timestamp Debug Event Class Format

Requirement ID	Byte Address	Field	# of Bytes	Field Description
EVC-TS-1	0	Timestamp Debug Class	1	Shall be set to 01h.
EVC-TS-2	2:1	Timestamp	2	Event ID Description
		Debug Event		0000h Timestamp Host Command Issued
				0001h Timestamp Snapshot
				0002h Timestamp is Power on Hours
				7FFFh- Reserved 0003h
				FFFFh- Vendor Unique 7FFFh
EVC-TS-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 2h + VU Data Size in DWORDS. If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 2h.
EVC-TS-4	11:4	Timestamp	8	Time stamp value based on Event ID.
EVC-TS-5	(Event Data Size *4)+11 :12	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.

4.9.14.2.3 PCIe Debug Event Class Format

1.9.14.2.5 PCIE Debug Event Class Format								
Requirement ID	Byte Address	Field	# of Bytes			Field Description		
EVC-PCI-1	0	PCIe Debug Class	1	5	Shall be set t	to 02h.		
EVC-PCI-2	2:1	PCIe Debug	2	1	The device s	hall log PCIe Events as follows:		
		Event			Event ID	Description		
					0000h	Link Up.		
					0001h	Link Down.		
					0002h	PCIe Error Detected.		
					0003h	PERST Asserted.		
					0004h	PERST De-asserted.		
					0005h	Refclk Stable.		
					0006h	Vmain Stable.		

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				0007h Link Speed and Width Negotiated.
				7FFFh- Reserved 0008h
				8000Fh- Vendor Unique FFFFh
EVC-PCI-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 1h + VU Data Size in DWORDS.
				If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 1h
EVC-PCI-4	7:4	PCIe Debug Event Data	4	For PCIe Debug Event ID 7, the device shall log the negotiated Link Speed and Width as follows:
				Byte Field Description
				4 State changed flags:
				 01h = x1 02h = x2 03h = x4 04h = x8 05h = x16 06h - FFh = Reserved

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				7 Reserved. Shall be cleared to
				zero.
				For all other PCIe Debug Event IDs, this field shall
				be cleared to zero.
EVC-PCI-5	(Event	VU Data	VU	Vendor Unique Data. The size of this data is
	Data Size		Data	determined based on the Event Data Size if this
	*4)+7 :8		Size *4	field exists.

4.9.14.2.4 NVMe Debug Event Class Format

Requirement ID	Byte Address	Field	# of Bytes			Field Description		
EVC-NVME-1	0	NVMe Debug Class	1	S	Shall be set	to 03h.		
EVC-NVME-2	2:1	NVMe Debug	2	Т	he device s	hall log NVMe Events as follows:		
		Event			Event ID	Description		
					0000h	CC.EN transitions from 0b to 1b.		
					0001h	CC.EN transitions from 1b to 0b.		
					0002h	CSTS.RDY transitions from 0b to 1b.		
					0003h	CSTS.RDY transitions from 1b to 0b.		
					0004h	Reserved		
							0005h	Create I/O Submission Queue Command or Create I/O Completion Queue Command Processed.
					0006h	Other Admin Queue Command Processed.		
					0007h	An Admin Command Returned a Non-zero Status Code.		
					0008h	An I/O Command Returned a Non-zero Status Code.		
					0009h	CSTS.CFS Set to 1b.		
					000Ah	Admin Submission Queue Base Address Written (AQA) or Admi Completion Queue Based Address (ACQ) written		

Requirement ID	Byte Address	Field	# of Bytes			Field Description	
					000B	Controller Configuration Register (CC) Changed except for the cases that are covered in 0000h and 0001h.	
					000C	Controller Status Register (CSTS) Changed except for the cases that are covered in 0002h and 0003h.	
					7FFFh- 000Dh	Reserved	
					8000Fh- FFFFh	Vendor Unique	
EVC-NVME-3	3	Event Data Size	1		Event Data S Data Size in I	iize in DWORDS shall be 8h + VU DWORDS.	
				е	exist (i.e., th	VU Data, the VU Data field does not e VU Data Size is 0h) and the Event all be set to 8h	
EVC-NVME-4	11:4 NVMe Debug 8 Event Data		8	c	For NVMe Debug Event IDs 07h and 08h, the device shall log the NVMe Debug Event Data as follows:		
					Byte Address	Field Description	
					4	Command Opcode	
					6:5	Status Code in bits 14:0 and bit 15 shall be cleared to 0b.	
					11:7	Reserved. Shall be cleared to 0h.	
						ebug Event ID OBh the device shall e Debug Event Data as follows:	
					Byte Address	Field Description	
					7:4	Controller Configuration Register	
ı					11:8	Reserved. Shall be cleared to 0h.	
						ebug Event ID 0Ch the device shall e Debug Event Data as follows:	

Requirement ID	Byte Address	Field	# of Bytes			Field Description
					Byte Address	Field Description
					7:4	Controller Status Register
					11:8	Reserved. Shall be cleared to 0h.
					or all other hall be clea	NVMe Debug Event IDs, this field red to zero.
EVC-NVME-5	(Event	VU Data	VU			ue Data. The size of this data is
	Data		Data	-		based on the Event Data Size if this
	Size*4)+		Size*4	fi	ield exists.	
	11 :12					

4.9.14.2.5 Reset Debug Event Class Format

Requirement ID	Byte Address	Field	# of Bytes	Field Description
EVC-RST-1	0	Reset Debug Class	1	Shall be set to 04h.
EVC-RST-2	2:1	Reset Debug	2	The device shall log Reset Events as follows:
		Event		Event ID Description
				0000h PCle Conventional Hot Reset.
				0001h Main Power Cycle.
				0002h PERST#.
				0003h PCle Function Level Reset.
				0004h NVM Subsystem Reset.
				7FFFh- Reserved
				8000Fh- FFFFh Vendor Unique
EVC-RST-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 0h + VU Data Size in DWORDS.
				If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 0h
EVC-RST-4	(Event Data Size*4)+3 :4	VU Data	VU Data Size *4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.

4.9.14.2.6 Boot Sequence Debug Event Class Format

Requirement ID	Byte Address	Field	# of Bytes	Field Description						
EVC-BS-1	0	Boot Sequence Debug Class	1	Shall be set to 05h.						
EVC-BS-2	2:1	Boot Sequence	1	The device shall log Boot Sequence Events as follows:						
		Debug Event		Event ID Description						
				O000h Main Firmware Boot Complete. For a single controller subsystem, this is when all boot activities required to allow I/O commands to be processed is completed excluding the enablement of the controller. This is always after the FTL load from NVM Complete, FTL Rebuild Started and FTL Rebuild Completes events.						
				0002h FTL Rebuild Started. This is after FTL Load from NVM has completed, if the FTL table is required to be rebuilt from journaling data, then mark the start.						
				0003h FTL Rebuild Complete. This means the FTL table is ready to fully support I/O commands.						
				7FFFh- Reserved 0006h						
				8000Fh- FFFFh Vendor Unique						
EVC-BS-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 0h + VU Data Size in DWORDS.						

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 0h
EVC-BS-4	(Event Data Size*4)+3 :4	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.

4.9.14.2.7 Firmware Assert Debug Event Class Format

Requirement ID	Byte Address	Field	# of Bytes	Field Description
EVC-ASRT-1	0	Firmware Assert Debug Class	1	Shall be set to 06h.
EVC-ASRT-2	2:1	Firmware Assert Debug	2	The device shall log Firmware Assert Events as follows:
		Event		Event ID Description
				0000h Assert in NVMe Processing Code.
				0001h Assert in Media Code.
				0002h Assert in Security Code.
				0003h Assert in Background Services Code.
				0004h FTL Rebuild Failed.
				0005h FTL Data Mismatch.
				0006h Assert in Other Code.
				7FFFh- Reserved 0006h
				8000Fh- Vendor Unique FFFFh
EVC-ASRT-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 0h + VU Data Size in DWORDS.
				If there is no VU Data, the VU Data field does no exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 0h
EVC-ASRT-4	(Event Data	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
	Size*4)+3			
	:4			

4.9.14.2.8 Temperature Debug Event Class Format

Requirement ID	Byte Address	Field	# of Bytes	Field Description
EVC-TEMP-1	0	Temperature Debug Class	1	Shall be set to 07h.
EVC-TEMP-2	2:1	Temperature Debug Event	2	The device shall log Temperature Events as follows:
				Event ID Description
				0000h Composite Temperature decreases to (WCTEMP - 2)
				0001h Composite Temperature increases to WCTEMP
				0002h Composite Temperature increases to reach CCTEMP.
				7FFFh- Reserved 0006h
				8000Fh- Vendor Unique FFFFh
				Once the event is logged 2 degrees of hysteresis should be applied to avoid additional entries being generated.
EVC-TEMP-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 0h + VU Data Size in DWORDS.
				If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 0h
EVC-TEMP-4	(Event Data Size*4)+3 :4	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.

4.9.14.2.9 Media Debug Event Class Format

Requirement ID	Byte Address	Field	# of Bytes	Field Description		
EVC-MEDIA-1	0	Media Debug Class	1	Shall be set to 08h.		
EVC-MEDIA-2	2:1	Media Debug	2	The device shall log Media Events as follows:		
		Event		Event ID Description		
				0000h XOR (or equivalent) Recovery Invoked.		
				0001h Uncorrectable Media Error		
				0002h Block Marked Bad Due to Program Error.		
				0003h Block Marked Bad Due to Erase Error.		
				0004h Block Marked Bad Due to Read Error.		
				0005h Plane Failure Event.		
				7FFFh- Reserved 0006h		
				8000Fh- Vendor Unique FFFFh		
EVC-MEDIA-3	3	Event Data Size	0	Event Data Size in DWORDS shall be 0h + VU Data Size in DWORDS.		
				If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 0h		
EVC-MEDIA-4	(Event Data Size*4)+3 :4	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.		

4.9.14.2.10 Media Wear Event Class Format

Requirement ID	Byte Address	Field	# of Bytes	Field Description		Field Description
EVC-WEAR-1	0	Media Wear Class	1	Shall be set to 09h. This event shall be logged once every 24 hours.		
EVC-WEAR-2	2:1	Wear Debug Event	2	The device shall log Wear Events as follows: Event ID Description		
					0000h	Media Wear

Requirement ID	Byte Address	Field	# of Bytes	Field Description	
				7FFFh- Reserved 0001h	
				8000Fh- FFFFh Vendor Unique	
EVC-WEAR-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 3h + VU Data Size in DWORDS.	
				If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 3h	
EVC-WEAR-4	15:4	Current Media Wear	12	For Wear Debug Event ID 00h, the device shall log the current wear as follows:	
				Byte Field Description	
				7:4 Host Terabytes Written.	
				11:8 Media Terabytes Written.	
				15:12 Media Terabytes Erased.	
				For all other Wear Event IDs, this field shall be cleared to zero.	
EVC-WEAR-5	(Event Data Size*4)+	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.	
	15 :16				

4.9.14.2.11 Static Snapshot Class
For the Static Snapshot Class. This enables the device to take a snapshot of a statistic descriptor and store this value in the Event FIFO.

Requirement ID	Byte Address	Field	# of Bytes		Field Description
EVC-SNP-1	0	Static Snapshot Class	1	Shall be set to 000Ah. This is a static snapshoof a statistics descriptor.	
EVC-SNP-2	2:1	Static Snapshot	2	The device shall log Static Snap Shop Events as follows:	
		Event		Event ID	Description
				0000h	Snapshot of Statistics Descriptor
				7FFFh- 0001h	Reserved

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				8000Fh- Vendor Unique FFFFh
EVC-SNP-3	3	Event Data Size	1	Event Data Size in DWORDS shall be 0h + VU Data Size in DWORDS. If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 0h
EVC-WEAR-5	(Event Data Size*4)+3 :4	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.

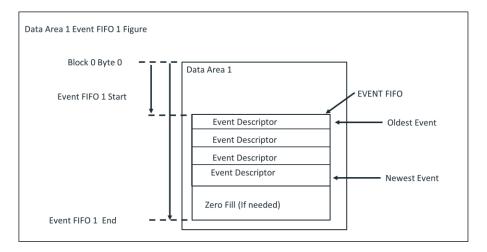
4.9.14.2.12 Vendor Unique Event Class Format

For the Vendor Unique debug class.

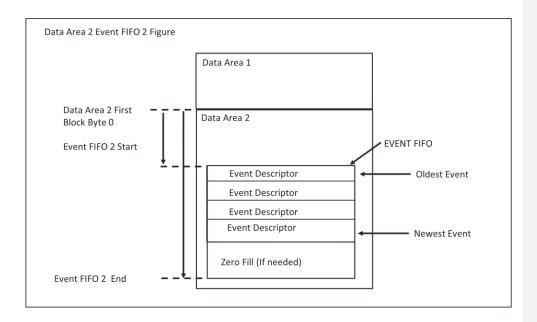
0	Debug VU		
	Class	1	Shall be set to 80-FFh.
2:1	Debug VU Event	2	The device shall log Vendor Unique Events as follows:
			Event ID Description
			0000h Vendor Unique Event 0
			0001h Vendor Unique Event 1
			FFFFh Vendor Unique Event
3	Event Data Size	1	Event Data Size in DWORDS shall be 0h + VU Data Size in DWORDS.
			If there is no VU Data, the VU Data field does not exist (i.e., the VU Data Size is 0h) and the Event Data Size shall be set to 0h
(Event Data Size*4)+3	VU Data	VU Data Size*4	Vendor Unique Data. The size of this data is determined based on the Event Data Size if this field exists.
	3 (Event Data	3 Event Data Size (Event Data Size VU Data Data Size*4)+3	Event 3 Event Data Size (Event Data Size*4)+3 Event VU Data VU Data Size*4

4.9.15 Event FIFO Location

The Event FIFO 1 location in Data Area 1 can be found by using the Event FIFO 1 Start, Event FIFO 1 End. This can be seen in the Data Area 1 Event FIFO Figure below.



The Event FIFO location in Data Area 2 can be found by using the Event FIFO 2 Start, Event FIFO 2 Data End. This can be seen in the Data Area 2 Event FIFO Figure below.



4.9.15.1 Event FIFO Requirements

Requirement ID	Description
EVF-1	The oldest event descriptor shall be at the Event FIFO Start Address.
EVF-2	There shall be no gaps between the data in one descriptor and the next descriptor.
EVF-3	The event FIFO shall only have complete descriptors(i.e., no partial descriptors).
EVF-4	All data contained in the event FIFO that is not contained in an event descriptor shall be cleared to zero.
EVF-5	For a single FIFO, the Event FIFO Start and Event FIFO End shall be in the same Data Area.
EVF-6	Event FIFO Start and End locations shall not overlap with the Statistic Descriptor locations.
EVF-7	The decode of the Vendor Unique Class shall be provided to the customer via the Vendor Unique Telemetry Strings Log page.

4.9.16 Telemetry Data Area

4.9.16.1 Telemetry Data Format

Telemetry Data Area 1 has the following format.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
TELDF-1	511:0	NVM Express Defined	512	The values in these bytes are defined by NVM Express.
TELDF-2	513:512	Major Version	2	This field shall be set to 0003h. A change of the Major Version number indicates that the changes to the Telemety Data Area format decode are not host software backward compatible.
TELDF-3	515:514	Minor Version	2	This field shall be set to 0001h. A change of the Major Version number indicates that the changes to the Telemety Data Area format decode are host software backward compatible.
TELDF-4	519:516	Reserved	4	Shall be cleared to zero.
TELDF-5	527:520	Timestamp	8	Shall be set to the Timestamp when the Telemetry Log (Host Initiated or Controller Initiated) Get Log command was received by the device. The format of this field shall be as defined in Timestamp (Feature Identifier 0Eh) of the NVM Express Specification.
TELDF-6	543:128	Log Page GUID	16	This field shall be set to BA560A9C3043424CBC73719D87E64EFAh.
TELDF-7	544	Number Telemetry Profiles Supported	1	Shall be set to the number of Telemetry Profiles supported by the device. This field is zero based.
TELDF-8	545	Telemetry Profile Selected (TPS)	1	Shall be set to the currently selected Telemetry Profile. This field is zero based.
TELDF-9	551:546	Reserved	6	Shall be cleared to zero.
TELDF-10	559:552	String Log Size (SLS)	8	Shall be set to the number of DWORDS in the String Log.
TELDF-11	667:560	Reserved	8	Shall be cleared to zero.

Requirement ID	Byte Address	Field	# of Bytes	F	Field Description	
TELDF-12	575:568	Firmware Revision	8	Shall be set to the firmware revision reported in the Identify Controller Data Structure.		
TELDF-13	607:576	Reserved	32	Shall be cleared	to zero.	
TELDF-14	615:608	Data Area 1 Statistic Start	8		ontain the DWORD offset of the stic Buffer in Data Area 1 from page.	
TELDF-15	623:616	Data Area 1 Statistic Size	8	This field shall contain the size of the Statistic Buffer in Data Area 1 in DWORDS. If there are no Statistic Descriptors a value of 0h shall be reported.		
TELDF-16	631:624	Data Area 2 Statistic Start	8	This field shall contain the DWORD offset of the start of the Statistic Buffer in Data Area 2. This offset starts from the first byte/block in Data Area 2.		
TELDF-17	639:632	Data Area 2 Statistic Size	8	This field shall contain the size of the Statistic Buffer in Data Area 2 in DWORDS. If there are no Statistic Descriptors a value of 0h shall be reported.		
TELDF-18	671:640	Reserved	32	Shall be cleared	to zero.	
TELDF-19	672	Event FIFO 1 Data Area	1	Event FIFO Data Area	Description	
				00h 01h	Event FIFO 1 does not exist Event FIFO 1 exists in Data Area 1	
				02h	Event FIFO 1 exists in Data Area 2	
				0F-03h	Reserved	
TELDF-20	673	Event FIFO 2	1		_	
		Data Area		Event FIFO Data Area	Description	
				00h	Event FIFO 2 does not exist	

Requirement ID	Byte Address	Field	# of Bytes		Field Description
				01h	Event FIFO 2 exists in Data
					Area 1
				02h	Event FIFO 2 exists in Data
					Area 2
				0F-03h	Reserved
TELDF-21	674	Event FIFO 3	1		
		Data Area		Event FIFO	Description
				Data Area	
				00h	Event FIFO 3 does not exist
				01h	Event FIFO 3 exists in Data Area 1
			02h	Event FIFO 3 exists in Data Area 2	
				0F-03h	Reserved
TELDF-22	675 Event FIFO 4 Data Area	1	Event FIFO Data Area 00h 01h	Description Event FIFO 4 does not exist Event FIFO 4 exists in Data Area 1 Event FIFO 4 exists in Data	
					Area 2
TELDF-23	676	Event FIFO 5	1	0F-03h	Reserved
		Data Area	_	Event FIFO	Description
				Data Area	Bescription
				00h	Event FIFO 5 does not exist
				01h	Event FIFO 5 exists in Data Area 1
				02h	Event FIFO 5 exists in Data Area 2
				0F-03h	Reserved
				UF-0311	Neserveu

Requirement ID	Byte Address	Field	# of Bytes	l	Field Description
TELDF-24	677	Event FIFO 6	1		
		Data Area		Event FIFO Data Area	Description
				00h	Event FIFO 6 does not exist
				01h	Event FIFO 6 exists in Data Area 1
				02h	Event FIFO 6 exists in Data Area 2
				0F-03h	Reserved
TELDF-25	678	Event FIFO 7	1		
		Data Area		Event FIFO	Description
				Data Area	
				00h	Event FIFO 7 does not exist
			01h	Event FIFO 7 exists in Data Area 1	
			02h	Event FIFO 7 exists in Data Area 2	
				0F-03h	Reserved
TELDF-26	679	Event FIFO 8 Data Area	1	Event FIFO Data Area	Description
				00h	Event FIFO 8 does not exist
				01h	Event FIFO 8 exists in Data Area 1
				02h	Event FIFO 8 exists in Data Area 2
				0F-03h	Reserved
TELDF-27	680	Event FIFO 9	1		
		Data Area		Event FIFO Data Area	Description
				00h	Event FIFO 9 does not exist
				01h	Event FIFO 9 exists in Data Area 1

Requirement ID	Byte Address	Field	# of Bytes	I	Field Description
				02h	Event FIFO 9 exists in Data
					Area 2
				0F-03h	Reserved
TELDF-28	681	Event FIFO	1		
		10 Data Area		Event FIFO	Description
				Data Area	
				00h	Event FIFO 10 does not exist
				01h	Event FIFO 10 exists in Data
					Area 1
				02h	Event FIFO 10 exists in Data
					Area 2
				0F-03h	Reserved
TELDF-29	682	Event FIFO	1		
		11 Data Area		Event FIFO	Description
				Data Area	
				00h	Event FIFO 11 does not exist
				01h	Event FIFO 11 exists in Data Area 1
				02h	Event FIFO 11 exists in Data
					Area 2
				0F-03h	Reserved
TELDF-30	683	Event FIFO	1		
		12 Data Area		Event FIFO	Description
				Data Area	
				00h	Event FIFO 12 does not exist
				01h	Event FIFO 12 exists in Data
					Area 1
				02h	Event FIFO 12 exists in Data
					Area 2
				0F-03h	Reserved
TELDF-31	684	Event FIFO	1		
		13 Data Area			

Requirement ID	Byte Address	Field	# of Bytes	ı	Field Description
				Event FIFO	Description
				Data Area	
				00h	Event FIFO 13 does not exist
				01h	Event FIFO 13 exists in Data
					Area 1
				02h	Event FIFO 13 exists in Data
					Area 2
				0F-03h	Reserved
TELDF-32	685	Event FIFO	1		
		14 Data Area		Event FIFO	Description
				Data Area	
				00h	Event FIFO 14 does not exist
				01h	Event FIFO 14 exists in Data
				021	Area 1
				02h	Event FIFO 14 exists in Data Area 2
				0F-03h	Reserved
TELDF-33	686	Event FIFO 15 Data Area	1	Event FIFO	Description
				Data Area	·
				00h	Event FIFO 15 does not exist
				01h	Event FIFO 15 exists in Data Area 1
				02h	Event FIFO 15 exists in Data
					Area 2
				0F-03h	Reserved
TELDF-34	687	Event FIFO	1		
		16 Data Area		Event FIFO	Description
				Data Area	5 5150 46
				00h	Event FIFO 16 does not exist
				01h	Event FIFO 16 exists in Data
				02h	Area 1
				UZN	Event FIFO 16 exists in Data
					Area 2

Requirement ID	Byte Address	Field	# of Bytes	Field Description
			-	0F-03h Reserved
TELDF-35	695:688	Event FIFO 1 Start	8	Shall be set to the DWORD offset of Event FIFO 1 Start from byte 0 of the first block of the selected Data Area.
TELDF-36	703:696	Event FIFO 1 End	8	Shall be set to the DWORD offset of Event FIFO 1 End from byte 0 of the first block of the selected Data Area.
TELDF-37	711:704	Event FIFO 2 Start	8	Shall be set to the DWORD offset of Event FIFO 2 Start from byte 0 of the first block of the selected Data Area.
TELDF-38	719:712	Event FIFO 2 End	8	Shall be set to the DWORD offset of Event FIFO 2 End from byte 0 of the first block of the selected Data Area.
TELDF-39	727:720	Event FIFO 3 Start	8	Shall be set to the DWORD offset of Event FIFO 3 Start from byte 0 of the first block of the selected Data Area.
TELDF-40	735:728	Event FIFO 3 End	8	Shall be set to the DWORD offset of Event FIFO 3 End from byte 0 of the first block of the selected Data Area.
TELDF-41	743:736	Event FIFO 4 Start	8	Shall be set to the DWORD offset of Event FIFO 4 Start from byte 0 of the first block of the selected Data Area.
TELDF-42	751:744	Event FIFO 4 End	8	Shall be set to the DWORD offset of Event FIFO 4 End from byte 0 of the first block of the selected Data Area.
TELDF-43	759:752	Event FIFO 5 Start	8	Shall be set to the DWORD offset of Event FIFO 5 Start from byte 0 of the first block of the selected Data Area.
TELDF-44	767:760	Event FIFO 5 End	8	Shall be set to the DWORD offset of Event FIFO 5 End from byte 0 of the first block of the selected Data Area.
TELDF-45	775:768	Event FIFO 6 Start	8	Shall be set to the DWORD offset of Event FIFO 6 Start from byte 0 of the first block of the selected Data Area.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
TELDF-46	783:776	Event FIFO 6 End	8	Shall be set to the DWORD offset of Event FIFO 6 End from byte 0 of the first block of the selected Data Area.
TELDF-47	791:784	Event FIFO 7 Start	8	Shall be set to the DWORD offset of Event FIFO 7 Start from byte 0 of the first block of the selected Data Area.
TELDF-48	799:792	Event FIFO 7 End	8	Shall be set to the DWORD offset of Event FIFO 7 End from byte 0 of the first block of the selected Data Area.
TELDF-49	807:800	Event FIFO 8 Start	8	Shall be set to the DWORD offset of Event FIFO 8 Start from byte 0 of the first block of the selected Data Area.
TELDF-50	815:808	Event FIFO 8 End	8	Shall be set to the DWORD offset of Event FIFO 8 End from byte 0 of the first block of the selected Data Area.
TELDF-51	823:816	Event FIFO 9 Start	8	Shall be set to the DWORD offset of Event FIFO 9 Start from byte 0 of the first block of the selected Data Area.
TELDF-52	831:824	Event FIFO 9 End	8	Shall be set to the DWORD offset of Event FIFO 9 End from byte 0 of the first block of the selected Data Area.
TELDF-53	839:832	Event FIFO 10 Start	8	Shall be set to the DWORD offset of Event FIFO 10 Start from byte 0 of the first block of the selected Data Area.
TELDF-54	847:840	Event FIFO 10 End	8	Shall be set to the DWORD offset of Event FIFO 10 End from byte 0 of the first block of the selected Data Area.
TELDF-55	855:848	Event FIFO 11 Start	8	Shall be set to the DWORD offset of Event FIFO 11 Start from byte 0 of the first block of the selected Data Area.
TELDF-56	863:856	Event FIFO 11 End	8	Shall be set to the DWORD offset of Event FIFO 11 End from byte 0 of the first block of the selected Data Area.
TELDF-57	871:864	Event FIFO 12 Start	8	Shall be set to the DWORD offset of Event FIFO 12 Start from byte 0 of the first block of the selected Data Area.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
TELDF-58	879:872	Event FIFO 12 End	8	Shall be set to the DWORD offset of Event FIFO 12 End from byte 0 of the first block of the selected Data Area.
TELDF-59	887:880	Event FIFO 13 Start	8	Shall be set to the DWORD offset of Event FIFO 13 Start from byte 0 of the first block of the selected Data Area.
TELDF-60	895:888	Event FIFO 13 End	8	Shall be set to the DWORD offset of Event FIFO 13 End from byte 0 of the first block of the selected Data Area.
TELDF-61	903:896	Event FIFO 14 Start	8	Shall be set to the DWORD offset of Event FIFO 14 Start from byte 0 of the first block of the selected Data Area.
TELDF-62	911:904	Event FIFO 14 End	8	Shall be set to the DWORD offset of Event FIFO 14 End from byte 0 of the first block of the selected Data Area.
TELDF-63	919:912	Event FIFO 15 Start	8	Shall be set to the DWORD offset of Event FIFO 15 Start from byte 0 of the first block of the selected Data Area.
TELDF-64	927:920	Event FIFO 15 End	8	Shall be set to the DWORD offset of Event FIFO 15 End from byte 0 of the first block of the selected Data Area.
TELDF-65	935:928	Event FIFO 16 Start	8	Shall be set to the DWORD offset of Event FIFO 16 Start from byte 0 of the first block of the selected Data Area.
TELDF-66	943:936	Event FIFO 16 End	8	Shall be set to the DWORD offset of Event FIFO 16 End from byte 0 of the first block of the selected Data Area.
TELDF-67	1023:944	Reserved	80	Shall be cleared to zero.
TELDF-68	1535:1024	SMART / Health Information	512	This shall be a copy of the SMART / Health Information (Log Identifier 02h) data.
TELDF-69	2047:1536	SMART / Health Information Extended	512	This shall be a copy of the SMART / Health Information Extended (Log Identifier C0h) data.

4.10 Self-Test RequirementsTo normalize the reporting of Self-Test data, the following Segment Numbers are defined.

Requirement ID		Description			
SELFTST-1	The device sha	all use the following segment numbers:			
	Segment Number	Description			
	1	SMART or Health status for Critical Warnings.			
	2	Hold up capacitor check.			
	3	Metadata validation.			
	4	NVM Integrity to check for data mis-compares.			
	5	Check DRAM Health.			
	6	Check SRAM Health.			
	200:7	Reserved.			
	255-201	Vendor Unique. Any Vendor Unique Segment Numbers shall be clearly documented and disclosed to the customer.			

4.11 Firmware Update RequirementsThis defines the requirements for firmware update in the device.

Requirement ID	Description
FWUP-1	A firmware activation history log shall be recorded (see <u>Section 4.8.6 Firmware Activation History (Log Identifier C2h) Requirements)</u> .
FWUP-2	Other than media end-of-life, devices shall not have any restrictions on the number of firmware downloads supported.
FWUP-3	The Firmware Commit command with the following Commit Action (CA) codes shall be supported: • 000b – Download only. • 001b – Download and activate upon reset. • 010b – Activate upon reset. • 011b – Activate immediately without reset.
FWUP-4	Firmware Image Download Command shall be supported.
FWUP-5	Obsolete.
FWUP-6	The device shall support a minimum of 2 read/write slots for firmware update and may support up to 7.
FWUP-7	For firmware commit action 011b (firmware activation without reset), the device shall complete the firmware activation process and be ready to accept host I/O and NVMe Admin commands within 1 second from the receipt of the Firmware Commit command. The Maximum Time for Firmware Activation (MTFA) field shall not exceed Ah.

Requirement ID	Description
FWUP-8	When attempting to downgrade to incompatible firmware revision, the device shall return Firmware Activation Prohibited (13h) status to a Firmware Commit command. All lower security version firmware images shall be considered incompatible.
FWUP-9	The firmware image in each valid firmware slot shall have multiple copies of that firmware image for reliability. A single corrupted copy of a firmware image shall not result in the device no longer functioning.
FWUP-10	Firmware activation shall not cause user data to be lost or destroyed.
FWUP-11	Firmware activation without reset shall preserve the current state of the device (e.g., Opal locking state, Set Features, Timestamp, Log Page contents, etc.).

4.12 De-Allocation Requirements

Requirement ID	Description
TRIM-1	The device shall support the Deallocate attribute of the Dataset Management command.
TRIM-2	For data that has been deallocated the NVMe Specification requires it to be 0, 1, or unchanged when read. Data returned shall only be 0, 1 or unchanged on a sector-by-sector basis.
TRIM-3	If data has been de-allocated and neither read nor written to before an unsafe power down event happens, then the data shall be 0, 1 or unchanged when read after that unsafe power down event.
TRIM-4	De-allocated addresses shall provide the performance and reliability benefits of overprovisioned space.
TRIM-5	The device shall support Garbage Collection during periods of no I/O (Idle GC).
TRIM-6	Read latency shall not change more than 5% from baseline when the host is issuing De-Allocate/TRIM commands.
TRIM-7	Read latency shall not change more than 5% from baseline when the device is performing Idle GC.
TRIM-8	If data has been de-allocated and subsequently read or written to, then the data shall not change as a consequence of an unsafe power down event.

4.13 Sector Size and Namespace Support

Requirement ID	Description
SECTOR-1	Obsolete. Replaced by <u>SECTOR-4</u> (512-byte and 4096-byte logical block sizes).

Requirement ID	Description	
SECTOR-2	Obsolete. Replaced by <u>SECTOR-4 (512-byte and 4096-byte logical block sizes)</u> .	
SECTOR-3	The device shall have one Namespace whose size is the maximum capacity as shipped from the factory.	
SECTOR-4	The device shall support 512-byte and 4096-byte logical block sizes.	

4.14 Set/Get Features Requirements

4.15 General Feature Requirements

Requirement ID	Description	
GETF-1	For any Get Feature Identifier defined in this section, Selection (SEL) values 00b to 11b in Dword 10 shall be supported.	
	If the feature requested by Set Feature is not supported, then a status error code of 02h (Invalid Field in Command) shall be returned.	

4.15.1 DSSD Set Feature Requirements

The table below defines the scope for all DSSD specific Set Features:

Feature Identifier	Scope	Feature Name	Reference Section
C0h	NVM subsystem	Error Injection	
C1h	NVM subsystem	Clear Firmware Update History	
C2h	NVM subsystem	EOL/PLP Failure Mode	
C3h	NVM subsystem	Clear PCIe Correctable Error Counters	
C4h	NVM subsystem	Enable IEEE1667 Silo	
C5h	NVM subsystem	Latency Monitor	
C6h	NVM subsystem	PLP Health Check Interval	
C7h	NVM subsystem	DSSD Power State	
C8h	NVM subsystem	Set Telemetry Profile	

KEY:

Namespace = The Set Feature affects a specific namespace.

Controller = The Set Feature affects the controller that is processing the command.

NVM subsystem = The Set Feature affects the NVM subsystem.

The device shall support the following additional vendor unique Set /Get Features Identifiers.

4.15.2 Error Injection (Feature Identifier C0h) Set Feature

Feature to inject one or more error conditions to be reported by the device. If multiple Set Features commands for this feature are sent by the host, then only information from the most recent successful command is retained (i.e., subsequent commands replace information provided by previous commands).

Requirement ID	Dword	Field	Bits	Field Description
SERRI-1	0	Command Identifier (CID)	31:16	Shall be set as defined in the NVMe Specification.
SERRI-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
SERRI-3	0	Reserved	13:10	Shall be cleared to zero.
SERRI-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
SERRI-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
SERRI-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
SERRI-7	3:2	Reserved	31:0	Shall be cleared to zero.
SERRI-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
SERRI-9	9:6	Data Pointer (DPTR)	31:0	Shall point to a physically contiguous 4096-byte address range containing 0 to 127 Error Injection Data Structure Entries.
SERRI-10	10	Save (SV)	31	The device shall not support setting this bit to 1b. If the controller receives this Set Features command with the bit set to 1b, then the device shall abort the command with a status of Feature Identifier Not Saveable.
SERRI-11	10	Reserved	30:8	Shall be cleared to zero.
SERRI-12	10	Feature Identifier (FID)	7:0	Shall be set to C0h.

Requirement ID	Dword	Field	Bits	Field Description
SERRI-13	11	Reserved	31:7	Shall be cleared to zero.
SERRI-14	11	Number of Error Injections	6:0	This field shall specify the number of valid Error Injection Data Entries described in the address range pointed to by the Data Pointer (DPTR) field.
SERRI-15	13:12	Reserved	31:0	Shall be cleared to zero.
SERRI-16	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
SERRI-17	15	Reserved	31:0	Shall be cleared to zero.

Requirement ID	Description			
ERRI-1	The maximum number of entries in the Number of Error Injections field shall be 127.			
ERRI-2	A value of 0000000b in the Number of Error Injections field shall clear any outstanding error injection events.			
ERRI-3	The error injections shall not overlap and may be listed in any order (e.g., ordering by error injection type is not required).			
ERRI-4	The host shall clear any unused entries in the Error Injection data structure to zero and the device shall ignore all zeroed entries. The device shall check at least the first four bytes of each Error Injection Entry data structure to determine if it is zeroed.			
ERRI-5	The device shall abort the Error Injection Set Feature command if the request contains an error injection type that is not supported or the Single Instance value for the given Error Injection Type is not valid.			
ERRI-6	Once the trigger conditions specified in an Error Injection Entry are met, the device shall inject the defined error event such that the host can detect the error through either an AEN being sent, the CFS bit being set, or command being aborted.			

4.15.2.1 Error Injection Entry Data Structure

Requirement ID	Byte Address	Field	# of Bytes			Field Description
ERRIE-1	0	Error Entry	1	Error Entry Flags definition:		
		Flags			Bit	Description
					7:2	Reserved. Shall be cleared to zero.
					1	Single Instance: If cleared to 0b, indicates error injection is enabled until disabled. If set to 1b, indicates

Requirement ID	Byte Address	Field	# of Bytes		Field Description
					a single instance error injection where a single error shall be injected. After a single instance error has been created, the error injection is considered disabled.
				0	Error Injection Enable: If cleared to 0b, indicates error injection is disabled. If set to 1b, indicates error injection is enabled.
ERRIE-2	1	Reserved	1	Shall be o	cleared to zero.
ERRIE-3	3:2	Error	2		ection type definition:
		Injection Type		Value	Field Description
		Туре		0000h	
				0001h	,
				0002h	•
				0003h	PLP Defect
				0004h	-0
				0005h	DRAM Corruption Critical Path
				0006h	DRAM Corruption Non-Critical Path
				0007h	NAND Corruption
				0008h	SRAM Corruption
				0009h	HW Malfunction
				000Ah	No More NAND Spares Available
				000Bh	Incomplete Shutdown
				000Ch - FFFFh	Reserved. Shall be cleared to zero.
ERRIE-4	31:4	Error Injection Type Specific Definition	28	Error Inje	ection Type specific definition.

4.15.2.2 Device Panic Error Injection Type

The device shall inject a device panic that the host can detect through either an AEN or the CFS bit being set. For the Device Panic type, a Single Instance value of 0 is not valid. Host shall perform the Panic Reset and Device Recovery actions specified in Error Recovery (Log Identifier C1h).

Requirement ID	Byte Address	Field	# of Bytes				Field Description						
ERRIEDP-1	0	Error Entry	1	С	Device Pa	nic	Error Entry Flags:						
		Flags			Bit		Description						
					7:2	Re	served. Shall be cleared to zero.						
					1	Sh	all be set to 1b.						
					0	Sh	all be set to 1b.						
ERRIEDP-2	1	Reserved	1	S	shall be cl	ea	red to zero.						
ERRIEDP-3	3:2	Error Injection Type	2	S	Shall be se	et t	o the range of 0001h to 000Bh.						
ERRIEDP-4	31:4	Error	28	Е	Device Pa	nic	Error Injection information:						
		Injection Type Specific	ype Specific		Byte Addres	s	Field Description						
		Definition	Definition								31:6		Reserved. Shall be cleared to zero.
					5:4		Number of Reads to Trigger Device Panic (NRTDP): Indicates the number of Read commands the device shall process and complete before triggering a device panic.						

4.15.3 Error Injection (Feature Identifier C0h) Get Feature

This Get Feature returns the set of error injections that are enabled on the device. The attributes specified in Section 4.12.2.2 - Device Panic Error Injection Type are returned in Dword 0 of the completion queue entry and the Error Inject data structure specified in Section 4.12.2.1 - Error Injection Entry Data Structure is returned for each error injection in the data buffer for that command. If there are no currently enabled error injections, the data buffer returned shall contain all zeros. The device shall clear to zero all unused entries in the Error Injection data structure.

4.15.3.1 Error Injection – Get Features Completion Queue Entry Dword 0

Requirement ID	Field	Bits	Field Description
GERRI-1	Reserved	31:7	Shall be cleared to zero.
GERRI-2	Number of Error Injections (NUME)	6:0	This field indicates the number of outstanding enabled error injections returned in the command data buffer (see <u>Section 4.12.2.1 Error Injection Entry Data Structure</u> for the format of the entries).

4.15.4 Clear Firmware Update History (Feature Identifier C1h) Set Feature

Requirement ID	Dword	Field	Bits	Field Description
CFUH-1	0	Command Identifier (CID)	31:16	Shall be set as defined in the NVMe Specification.
CFUH-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
CFUH-3	0	Reserved	13:10	Shall be cleared to zero.
CFUH-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
CFUH-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
CFUH-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
CFUH-7	3:2	Reserved	31:0	Shall be cleared to zero.
CFUH-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
CFUH-9	9:6	Data Pointer (DPTR)	31:0	Shall be cleared to zero.
CFUH-10	10	Save (SV)	31	The device shall not support setting this bit to 1b. If the controller receives this Set Features command with the bit set to 1b, then the device shall abort the command with a status of Feature Identifier Not Saveable.
CFUH-11	10	Reserved	30:8	Shall be cleared to zero.
CFUH-12	10	Feature Identifier (FID)	7:0	Shall be set to C1h.
CFUH-13	11	Clear Firmware Update History Log	31	Set to 1b to clear the Firmware Activation History (Log Identifier C2h). The NVMe CLI plug in command "clear-fwactivate-history" can also perform this operation.

Requirement ID	Dword	Field	Bits	Field Description
CFUH-14	11	Reserved	30:0	Shall be cleared to zero.
CFUH-15	13:12	Reserved	31:0	Shall be cleared to zero.
CFUH-16	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
CFUH-17	15	Reserved	31:0	Shall be cleared to zero.

4.15.5 EOL/PLP Failure Mode (Feature Identifier C2h) Set FeatureThis Set Feature defines the mode to which the device shall transition at End of Life (EOL) or on failure of the Power Loss Protection (PLP) circuitry.

Requirement ID	Description
ROWTM-1	The device shall default from the factory to Read Only Mode (ROM) (01b).

Requirement ID	Dword	Field	Bits	Field Description
SROWTM-1	0	Command Identifier (CID)	31:16	Shall be set as defined in NVMe Specification version 1.4b.
SROWTM-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
SROWTM-3	0	Reserved	13:10	Shall be cleared to zero.
SROWTM-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
SROWTM-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
SROWTM-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
SROWTM-7	3:2	Reserved	31:0	Shall be cleared to zero.
SROWTM-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
SROWTM-9	9:6	Data Pointer (DPTR)	31:0	Shall be cleared to zero.

Requirement ID	Dword	Field	Bits	Field Description
SROWTM-10	10	Save (SV)	31	This bit specifies that the controller shall save the End-of-Life Behavior state so that the state persists through all power states and resets. The device shall support setting this bit to 1b.
SROWTM-11	10	Reserved	30:8	Shall be cleared to zero.
SROWTM-12	10	Feature Identifier (FID)	7:0	Shall be set to C2h.
SROWTM-13	11	End of Life Behavior	31:30	Field to indicate device write behavior at End of Life (EOL) or in the event of loss of PLP functionality. See EOL-5 (available spares) for definition on EOL. Value Field Description Ob Reserved. Shall be cleared to zero. O1b The device shall transition to Read Only Mode (ROM) in the event of PLP failure or at EOL. 10b The device shall transition to Write Through Mode (WTM) in the event of PLP failure and transition to Read Only Mode (ROM) at EOL. 11b The device shall continue to operate as normal in the event of PLP failure and transition to Read Only Mode (ROM) at EOL.
SROWTM-14	11	Reserved	29:0	Shall be cleared to zero.
SROWTM-15	15:12	Reserved	31:0	Shall be cleared to zero.
SROWTM-16	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
SROWTM-17	15	Reserved	31:0	Shall be cleared to zero.

4.15.6 EOL/PLP Failure Mode (Feature Identifier C2h) Get Feature Dword 0 of command completion queue entry.

Requirement ID	Field	Bits	Field Description
GROWTM-1	Reserved	31:3	Shall be cleared to zero.

Requirement ID	Field	Bits		Field Description	
GROWTM -2	End of Life Behavior	2:0	Field to indicate what the device write behavior is configured for at End of Life (EOL) or in the event of loss of PLP functionality. The tables below define the required return values for each Selection (SEL) state. All other bit values are reserved. Current state (Selection (SEL) cleared to 00b):		
			Value	Field Description	
			001b	The device will transition to Read Only Mode (ROM) in the event of PLP failure or at EOL.	
			010b	The device will transition to Write Through Mode (WTM) in the event of PLP failure and transition to Read Only Mode (ROM) at EOL.	
			011b	The device will continue to operate as normal in the event of PLP failure and transition to Read Only Mode (ROM) at EOL.	
			Default state	(Selection (SEL) set to 01b):	
			Value	Field Description	
			001b	Read Only Mode (ROM) is the factory default.	
			010b	The Write Through Mode (WTM) is the factory default.	
			011b	Normal operation is the factory default for PLP failure. Read Only Mode (ROM) is the factory default at EOL.	
			Saved state	(Selection (SEL) set to 10b):	
			Value	Field Description	
			001b	The saved state is Read Only Mode (ROM).	
			010b	The saved state is Write Through Mode (WTM).	
			011b	The saved state is to operate as normal in the event of PLP failure and Read Only Mode (ROM) at EOL.	
			Canabilities	(Selection (SEL) set to 11b):	
			Value	Field Description	

Requirement ID	Field	Bits	Field Description
			This feature is saveable, changeable, and not namespace specific.

4.15.7 Clear PCIe Correctable Error Counters (Feature Identifier C3h) Set Feature

Requirement ID	Dword	Field	Bits	Field Description
CPCIE-1	0	Command Identifier (CID)	31:16	Shall be set as defined in NVMe Specification version 1.4b.
CPCIE -2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
CPCIE -3	0	Reserved	13:10	Shall be cleared to zero.
CPCIE -4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
CPCIE-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
CPCIE-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
CPCIE-7	3:2	Reserved	31:0	Shall be cleared to zero.
CPCIE-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
CPCIE-9	9:6	Data Pointer (DPTR)	31:0	Shall be cleared to zero.
CPCIE-10	10	Save (SV)	31	The device shall not support setting this bit to 1b. If the controller receives this Set Features command with the bit set to 1b, then the device shall abort the command with a status of Feature Identifier Not Saveable.
CPCIE-11	10	Reserved	30:8	Shall be cleared to zero.

Requirement ID	Dword	Field	Bits	Field Description
CPCIE-12	10	Feature Identifier (FID)	7:0	Shall be set to C3h.
CPCIE-13	11	Clear PCle Error Counters	31	Set to 1b to clear all PCIe correctable error counters in the SMART / Health Information Extended (Log Identifier COh). The NVMe CLI plug-in command "clear-pcie-correctable-errors" can also perform this operation.
CPCIE-14	11	Reserved	30:0	Shall be cleared to zero.
CPCIE-15	13:12	Reserved	31:0	Shall be cleared to zero.
CPCIE-16	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
CPCIE-17	15	Reserved	31:0	Shall be cleared to zero.

4.15.8 Enable IEEE1667 Silo (Feature Identifier C4h) Set FeatureThis Set Feature shall return an error if the OPAL Security state is not Manufactured_Inactive.

Requirement ID	Dword	Field	Bits	Field Description
S1667-1	0	Command Identifier (CID)	31:16	Shall be set as defined in NVMe Specification version 1.4b.
S1667-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
S1667-3	0	Reserved	13:10	Shall be cleared to zero.
S1667-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
S1667-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
S1667-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
S1667-7	3:2	Reserved	31:0	Shall be cleared to zero.

Requirement ID	Dword	Field	Bits	Field Description
S1667-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
S1667-9	9:6	Data Pointer (DPTR)	31:0	Shall be cleared to zero.
S1667-10	10	Save (SV)	31	This bit specifies that the controller shall save the IEEE1667 Silo Enable/Disable state so that the state persists through all power states and resets. The device shall support setting this bit to 1b.
S1667-11	10	Reserved	30:8	Shall be cleared to zero.
S1667-12	10	Feature Identifier (FID)	7:0	Shall be set to C4h.
S1667-13	11	Enable IEEE1667 Silo	31	If set to 0b, the IEEE 1667 silo shall be disabled no later than the next power cycle. If set to 1b, the IEEE 1667 silo shall be enabled no later than the next power cycle.
S1667-14	11	Reserved	30:0	Shall be cleared to zero.
S1667-15	13:12	Reserved	31:0	Shall be cleared to zero.
S1667-16	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
S1667-17	15	Reserved	31:0	Shall be cleared to zero.

4.15.9 Enable IEEE1667 Silo (Feature Identifier C4h) Get Feature Dword of command completion queue entry.

Requirement ID	Field	Bits		Field description
G1667-1	Reserved	31:3	Shall be clea	red to zero.
G1667-2	IEEE1667 Silo Enabled	2:0	Selection (SE	elow define the required return values for each EL) state. All other values are illegal. e (Selection (SEL) cleared to 00b): Field Description
			000b	The IEEE1667 silo is currently disabled.
			001b	The IEEE1667 silo is currently enabled.
			Default state	e (Selection (SEL) set to 01b):

Requirement ID	Field	Bits		Field description
			Value	Field Description
			000b	The IEEE1667 silo factory default is disabled.
			001b	The IEEE1667 silo factory default is enabled.
			Saved state	(Selection (SEL) set to 10b):
			Value	Field Description
			000b	The IEEE1667 silo saved state is disabled.
			001b	The IEEE1667 silo saved state is enabled.
			Capabilities	(Selection (SEL) set to 11b):
			Value	Field Description
			101b	This feature is saveable, changeable, and not namespace specific.

4.15.10 Latency Monitor (Feature Identifier C5h) Set Feature This configures the Latency Monitor Feature.

Requirement ID	Dword	Field	Bits	Field description
LMSF-1	0	Command Identifier (CID)	31:16	Shall be set as defined in NVMe Specification version 1.4b.
LMSF-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
LMSF-3	0	Reserved	13:10	Shall be cleared to zero.
LMSF-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
LMSF-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
LMSF-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
LMSF-7	3:2	Reserved	31:0	Shall be cleared to zero.

Requirement ID	Dword	Field	Bits	Field description
LMSF-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
LMSF-9	9:6	Data Pointer (DPTR)	31:0	Shall point to a physically contiguous 4096-byte address range (see <u>Section 4.12.10.1 Latency Monitoring Data Structure Entry</u>).
LMSF-10	10	Save (SV)	31	This bit specifies that the controller shall save the data pointed to by the Data Pointer in LMSF-9 (Data Pointer (DPTR)) so that the data persists through all power states and resets. The device shall support setting this bit to 1b.
LMSF-11	10	Reserved	30:8	Shall be cleared to zero.
LMSF-12	10	Feature Identifier (FID)	7:0	Shall be set to C5h.
LMSF-13	11	Reserved	31:0	Shall be cleared to zero.
LMSF-14	12:13	Reserved	31:0	Shall be cleared to zero.
LMSF-15	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
LMSF-16	15	Reserved	31:0	Shall be cleared to zero.

4.15.10.1 Latency Monitoring Data Structure Entry

This data structure is 4096 bytes with the following functional requirements and field format:

Requirement ID	Byte Address	Field	# of Bytes	Field Description
LMDS-1	1:0	Active Bucket Timer Threshold	2	This is the value that loads the Active Bucket Timer Threshold.
LMDS-2	2	Active Threshold A	1	This is the value that loads into the Active Threshold A
LMDS-3	3	Active Threshold B	1	This is the value that loads into the Active Threshold B
LMDS-4	4	Active Threshold C	1	This is the value that loads into the Active Threshold C
LMDS-5	5	Active Threshold D	1	This is the value that loads into the Active Threshold D

Requirement ID	Byte Address	Field	# of Bytes	Field Description
LMDS-6	7:6	Active Latency Config.	2	This is the value that loads into the Active Latency Configuration.
LMDS-7	8	Active Latency Minimum Window	1	This is the value that loads into the Active Latency Minimum Window.
LMDS-8	10:9	Debug Log Trigger Enable	2	This is the value that loads into the Debug Log Trigger Enable.
LMDS-9	11	Discard	1	Value Description
		Debug Log		00h When cleared to 00h the debug log, if it exists, will not be cleared.
				O1h When set to 01h the debug log will be discarded so another log can be triggered. In addition to this all the fields in the Set Features Data structure are valid which will cause the Latency Monitor feature to be reset and loaded with the values from the Set Features command. This shall discard the Debug Log regardless of whether the Latency Monitoring Feature is enabled or disabled.
				When set to 02h the debug log will be discarded so another log can be triggered. In addition to this none of the other fields of the Set Features Data structure are valid. Thus, only the debug log is discarded, and the Latency Monitor feature is not reset or loaded with any new values from the Set Features command.

Requirement ID	Byte Address	Field	# of Bytes	Field Description
				This shall discard the Debug Log regardless of whether the Latency Monitoring Feature is enabled or disabled. O3h -FFh Reserved. Shall be cleared to zero.
LMDS-10	12	Latency Monitor Feature Enable	1	When set to 01h the Latency Monitor Feature is enabled. When cleared to 00h the Latency Monitor Feature is disabled. All other values are reserved.
LMDS-11	4095:13	Reserved	4083	Shall be cleared to zero.

4.15.11 PLP Health Check Interval (Feature Identifier C6h) Set Feature

This Set Feature defines the test interval that the device shall use to test that it's Power Loss Protection (PLP) circuitry is healthy.

Requirement ID	Dword	Field	Bits	Field Description
SPLPI-1	0	Command Identifier (CID)	31:16	Shall be set as defined in NVMe Specification version 1.4b.
SPLPI-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
SPLPI-3	0	Reserved	13:10	Shall be cleared to zero.
SPLPI-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
SPLPI-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
SPLPI-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
SPLPI-7	3:2	Reserved	31:0	Shall be cleared to zero.

Requirement ID	Dword	Field	Bits	Field Description
SPLPI-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
SPLPI-9	9:6	Data Pointer (DPTR)	31:0	Shall be cleared to zero.
SPLPI-10	10	Save (SV)	31	This bit specifies that the controller shall save the PLP Health Check Interval so that the time interval persists through all power states and resets. The device shall support setting this bit to 1b.
SPLPI-11	10	Reserved	30:8	Shall be cleared to zero.
SPLPI-12	10	Feature Identifier (FID)	7:0	Shall be set to C6h.
SPLPI-13	11	PLP Health Check Interval	31:16	The time interval between PLP health checks in minutes. If cleared to 0000h, then the health check is disabled.
SPLPI-14	11	Reserved	15:0	Shall be cleared to zero.
SPLPI-15	13:12	Reserved	31:0	Shall be cleared to zero.
SPLPI-16	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
SPLPI-17	15	Reserved	31:0	Shall be cleared to zero.

4.15.12 PLP Health Check Interval (Feature Identifier C6h) Get Feature Dword 0 of command completion queue entry.

Requirement ID	Field	Bits		Field description	
GPLPI-1	Reserved	31:16	Shall be clea	Shall be cleared to zero.	
GPLPI-2	PLP Health Check Interval	15:0	The tables below define the required return values for e Selection (SEL) state. All other values are illegal. Current state (Selection (SEL) cleared to 00b):		
			Value	Field Description	
			0000h	The PLP Health Check is currently disabled.	
			xxxxh	The PLP Health Check Interval is currently xxxxh minutes.	
			Default stat	e (Selection (SEL) set to 01b):	

Requirement ID	Field	Bits		Field description
			Value	Field Description
			0000h	The PLP Health Check Interval factory default is disabled.
			000Fh	The PLP Health Check Interval factory default is 000Fh minutes.
			Saved state	Selection (SEL) set to 10b):
			Value	Field Description
			0000h	The PLP Health Check Interval saved state is disabled.
			xxxxh	The PLP Health Check Interval saved state is xxxxh minutes.
			Capabilities	(Selection (SEL) set to 11b):
			Value	Field Description
			0005h	This feature is saveable, changeable, and not namespace specific.

4.15.13 DSSD Power State (Feature Identifier C7h) Set Feature

Requirement ID	Description
DSSDPSS-1	If the host selects an DSSD Power State via a DSSD Power State (Feature Identifier C7h) Set Feature, the device shall accept the command and run at the highest powered NVMe Power State whose Maximum Power (MP) is less than or equal to the number of the DSSD Power State in watts (see DCLP-9 (DSSD Power State Descriptors) and DSSDPSD-3 (NVMe Power State)).
DSSDPSS-2	If the host selects a DSSD Power State via DSSD Power State (Feature Identifier C7h) Set Feature and the number of that DSSD Power State is less than the Minimum DSSD Power State (see DCLP-8 (Minimum Valid DSSD Power State)), the device shall abort the Set Feature command with Invalid Field in Command status.
DSSDPSS-3	The device shall no more than one NVMe Power State Descriptor for each Maximum Power value supported.

This Set Feature causes the device to move the given DSSD Power State:

Requirement ID	Dword	Field	Bits	Field Description
SDSSDPS-1	0	Command Identifier (CID)	31:16	Shall be set as defined in NVMe Specification version 1.4b.
SDSSDPS-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
SDSSDPS-3	0	Reserved	13:10	Shall be cleared to zero.
SDSSDPS-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
SDSSDPS-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
SDSSDPS-6	1	Namespace Identifier (NSID)	31:0	The host should either clear this to zero or set this to FFFFFFFFh. If the host sends any other NSID value, the device shall fail the command with Invalid Field in Command.
SDSSDPS-7	3:2	Reserved	31:0	Shall be cleared to zero.
SDSSDPS-8	5:4	Metadata Pointer (MPTR)	31:0	Shall be cleared to zero.
SDSSDPS-9	9:6	Data Pointer (DPTR)	31:0	Shall be cleared to zero.
SDSSDPS-10	10	Save (SV)	31	This bit specifies that the controller shall persist the DSSD Power State through all power cycles and resets. The device shall support setting this bit to 1b.
SDSSDPS-11	10	Reserved	30:8	Shall be cleared to zero.
SDSSDPS-12	10	Feature Identifier (FID)	7:0	Shall be set to C7h.
SDSSDPS-13	11	Reserved	31:7	Shall be cleared to zero.
SDSSDPS-14	11	DSSD Power State	6:0	DSSD Power State to set in watts.
SDSSDPS-15	13:12	Reserved	31:0	Shall be cleared to zero.
SDSSDPS-16	14	UUID Index	31:0	Shall be set per <u>UUID-3</u> .
SDSSDPS-17	15	Reserved	31:0	Shall be cleared to zero.

4.15.14 DSSD Power State (Feature Identifier C7h) Get Feature

Requirement ID	Description
DSSDPSG-1	If an DSSD Power State (Feature Identifier C7h) Get Feature command is executed and the current NVMe Power State was selected because of a DSSD Power State Set Feature command, the device shall report the DSSD Power State selected by that command (see Section 4.8.10.1 DSSD Power State Requirements for an example).
DSSDPSG-2	If a DSSD Power State (Feature Identifier C7h) Get Feature command is executed and the current NVMe Power State was not selected because of a DSSD Power State Set Feature command, the device shall report the lowest power DSSD Power State whose number is greater than or equal to the Maximum Power in watts of the current NVMe Power State (see Section 4.8.10.1 DSSD Power State Requirements for an example).

Dword 0 of command completion queue entry.

Requirement ID	Field	Bits		Field description
GDSSDPS-1	Reserved	31:7	Shall be clea	red to zero.
GD SSDPS-2	DSSD Power State	6:0	The tables below define the required return values for each Selection (SEL) state. All other values are illegal.	
			Current state	e (Selection (SEL) cleared to 00b):
			Value	Field Description
			XX	The DSSD Power State is currently xx watts as specified by DSSDPSG-1 and DSSDPSG-2.
			Default state	(Selection (SEL) set to 01b):
			Value	Field Description
			xx	The DSSD Power State factory default is xx watts.
			Saved state (Selection (SEL) set to 10b):
			Value	Field Description
			XX	The DSSD Power State saved state is xx watts.
			Capabilities (Selection (SEL) set to 11b):
			Value	Field Description

Requirement ID	Field	Bits	Field description
			This feature is saveable, changeable, and not namespace specific.

4.15.15 Set Telemetry Profile (Feature Identifier C8h) Set Feature

4.15.15.1 Telemetry Profiles

Telemetry profiles enable the following to be configured:

- Data Area 1 Last Block
- Data Area 2 Last Block
- Statistic Area Location and Size
- Event FIFO Start and End locations and number of Event FIFOs

In the telemetry log there is the Number of Telemetry Profiles Supported field. This field enables the device to report the number of Telemetry Profiles supported. There is also a Telemetry Profile Selected field. This reports what profile is currently selected. The Telemetry Profile Selected field can be changed through Set Features. The Telemetry log can then be read to see the format of the Telemetry Profile. Having different profiles enables the device to optimize debug for different situations.

4.15.15.2 Set Telemetry Profile (Feature Identifier C8h) Set Feature

Set Feature to set the Telemetry Profile.

Requirement ID	Dword	Field	Bits	Field Description
TEL-CFG-SF-1	0	Command Identifier (CID)	31:16	Shall be set as defined in NVMe Specification.
TEL-CFG-SF-2	0	PRP or SGL for Data Transfer (PSDT)	15:14	Shall be cleared to 00b.
TEL-CFG-SF-3	0	Reserved	13:10	Shall be cleared to zero.
TEL-CFG-SF-4	0	Fused Operation (FUSE)	9:8	Shall be cleared to 00b.
TEL-CFG-SF-5	0	Opcode (OPC)	7:0	Shall be set to 09h.
TEL-CFG-SF-6	1	Namespace Identifier (NSID)	31:0	Shall be set to FFFFFFFh.
TEL-CFG-SF-7	3:2	Reserved	15:0	Shall be cleared to zero.

Requirement ID	Dword	Field	Bits	Field Description
TEL-CFG-SF-8	5:4	Metadata Pointer (MPTR)	15:0	Shall be cleared to zero.
TEL-CFG-SF-9	9:6	Data Pointer (DPTR)	127:0	Shall be cleared to zero.
TEL-CFG-SF-10	10	Save (SV)	31	This bit shall be set to 1b.
TEL-CFG-SF-11	10	Reserved	30:8	Shall be cleared to zero.
TEL-CFG-SF-12	10	Feature Identifier (FID)	7:0	Shall be set to C8h.
TEL-CFG-SF-13	11	Reserved	31:8	Shall be cleared to zero.
TEL-CFG-SF-14	11	Telemetry Profile Select (TPS)	7:0	The device shall collect debug data per the specified profile number.
TEL-CFG-SF-15	13:12	Reserved	15:0	Shall be cleared to zero.
TEL-CFG-SF-16	14	UUID Index	31:0	Shall be set per UUID-3.
TEL-CFG-SF-17	15	Reserved	31:0	Shall be cleared to zero.

5 PCle Requirements
The following are PCle requirements.

Requirement ID	Description
PCI-1	The device shall support a PCIe Maximum Payload Size (MPS) of 256 bytes or larger.
PCI-2	The device Controller shall support modification of PCIe TLP completion timeout range as defined by the PCIe Base Spec.
PCI-3	The vendor shall disclose the vendor-specific timeout range definition in the "Completion Timeout Ranges Supported" field in the PCI Express Base Specification.
PCI-4	Disabling of PCIe Completion Timeout shall also be supported by the device Controller.
PCI-5	All three PCIe Conventional Resets (Cold, Warm, Hot) shall be supported.
PCI-6	PCIe Function Level Reset shall be supported.
PCI-7	Obsolete. See PCI-5 (PCIe Conventional Resets).
PCI-8	The device shall not expose a BAR4 or a BAR5.
PCI-9	The device shall support MSI-X.

Requirement ID	Description
PCI-10	The MSI-X table shall reside in BARO.
PCI-11	The MSI capability shall be 4-byte aligned.
PCI-12	The device shall support Access Control Services (ACS).

5.1 Boot Requirements

Requirement ID	Description
BOOT-1	The device shall support the UEFI 2.0 or later in-box NVMe driver.
BOOT-2	An option ROM shall not be included.

5.2 PCle Error Logging

The following table indicates where the PCIe physical layer error counters shall be logged. This is in addition to the aggregated PCIe error counters defined in SMART / Health Information Extended (Log Identifier C0h).

Requirement ID	Event	Logging Mechanism	
PCIERR-1	Unsupported Request Error Status (URES)		
PCIERR-2	ECRC Error Status (ECRCES)		
PCIERR-3	Malformed TLP Status (MTS)		
PCIERR-4	Receiver Overflow Status (ROS)		
PCIERR-5	Unexpected Completion Status (UCS)	Uncorrectable Error Status Bogistor Offset	
PCIERR-6	Completer Abort Status (CAS)	Uncorrectable Error Status Register Offset O4h in PCle Base Specification	
PCIERR-7	Completion Timeout Status (CTS)	o in in it die base opeanisation	
PCIERR-8	Flow Control Protocol Error Status (FCPES)		
PCIERR-9	Poisoned TLP Status (PTS)		
PCIERR-10	Data Link Protocol Error Status (DLPES)		
PCIERR-11	Advisory Non-Fatal Error Status (ANFES)	Correctable Error Status Register Offset 10h in PCIe Base Specification	
PCIERR-12	Replay Timer Timeout Status (RTS)		
PCIERR-13	REPLAY_NUM Rollover Status (RRS)	PCIe Correctable Error Count in the SMART /	
PCIERR-14	Bad DLLP Status (BDS)	Health Information Extended (Log Identifier COh) SMART-14.	
PCIERR-15	Bad TLP Status (BTS)	Conjunati 14.	

Requirement ID	Event	Logging Mechanism
PCIERR-16	Receiver Error Status (RES)	

5.3 Low Power Modes

Requirement ID	Description	
LPWR-1	If the device supports Active Power State Management (ASPM), then ASPM shall be disabled after a power cycle or reset.	
LPWR-2	The device shall support the PCIe L1 power state.	

5.4 PCle Eye Capture

Requirement ID	Description		
	A utility shall be provided that will allow the user to capture the internal receive eye of the device to tune the signal integrity of the device to the target platform.		

6 Reliability

6.1 Uncorrectable Bit Error Rate

Requirement ID	Description	
	The device shall support an Uncorrectable Bit Error Rate (UBER) of < 1 sector per 10^{17} bits read.	

6.2 Power On/Off Requirements

6.2.1 Time to Ready and Shutdown Requirements

Requirement ID	Description		
TTR-1	The device shall respond successfully to the Identify command within 1 second of CC.EN being set to 1b provided a Shutdown is not in progress when CC.EN is set to 1b. Some models may allow a longer time (see Section 12 Device Profiles).		
TTR-2	The device shall be able to process I/O commands with a successful completion within 20 seconds of CC.EN being set to 1b. Some models may allow a different time (see Section 12 Device Profiles).		

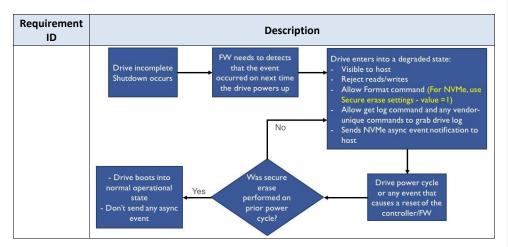
Requirement ID	Description		
TTR-3	The device shall be able to process Admin commands with a successful completion as soon as CSTS.RDY = 1.		
TTR-4	The device shall keep CSTS.RDY = 0 until the device is able to service NVMe Admin commands. Some models may allow a longer time (see Section 12 Device Profiles).		
TTR-5	The Shutdown Notification completion (CSTS.SHST) shall be received within 5 seconds of setting SHN bit.		
TTR-6	The device Controller shall support the CC.SHN (Normal and Abrupt Shutdown Notifications) at a minimum.		
TTR-7	When safe shutdown is completed successfully, the device shall not enter a rebuild/recovery mode on the next power on.		
TTR-8	Shutdown Notification shall trigger flushing of all content within the device's internal (SRAM/ DRAM) cache(s) (if one is present).		
TTR-9	Obsolete. See NVMe-CFG-3 (support reporting of CSTS.CFS).		
TTR-10	Obsolete. Moved to PLP-1 (full power-loss protection).		
TTR-11	Obsolete. Moved to PLP-2 (protection health check).		
TTR-12	Metadata rebuild due to any reason (e.g., unexpected power loss) shall not exceed 120 seconds and the device shall meet its latency requirements after this.		
TTR-13	Obsolete. Moved to PLP-3 (protection health check interval).		
TTR-14	Obsolete. Moved to PLP-4 (protection health check energy).		
TTR-15	In case of a successful Normal shutdown operation (CC.SHN = 1 set by the NVMe device driver), no data loss is tolerated even if PLP has failed.		
TTR-16	An Abrupt shutdown event shall not make the device non-functional under any conditions.		
TTR-17	Obsolete. Moved to PLP-5 (false detection of power loss protection).		
TTR-18	Obsolete. Moved to PLP-6 (capacitor holdup energy margin).		
When the CC.SHN register is written to notify the device to shutdown it shall no assumed that power will be lost even after CC.EN is cleared to 0. Under these conditions the device shall continue to function properly based on the NVMe a PCIe Specifications.			
TTR-20	The device shall be able to successfully respond to Configuration space accesses within 1s from de-assertion of PERST#.		
TTR-21	TTR-21 The device shall enable all AENs required for supporting OCP requirements befo setting CSTS.RDY to 1b.		

6.2.2 Incomplete/Unsuccessful Shutdown

An incomplete/unsuccessful shutdown is a Normal or Abrupt power down that did not complete 100% of the shutdown sequence for any reason that causes the device to be unable to guarantee data/metadata

integrity (e.g., firmware hang/crash, capacitor failure, PLP circuit failure, etc.).

Requirement ID	Description		
INCS-1	When the power-loss protection mechanism fails for any reason while power is applied, the device shall set Critical Warning bit 4 to 1b in the SMART / Health Information (Log Identifier 02h) and transition to the write behavior as defined in the EOL/PLP Failure Mode (Feature Identifier C2h).		
INCS-2	The device shall incorporate a shutdown checksum or flag as the very last piece of data written to flash to detect incomplete shutdown.		
INCS-3	The checksum or flag in INCS-2 shall be used on power-up to confirm that the previous shutdown was 100% successful.		
INCS-4	An incomplete shutdown shall result in an increase in the Incomplete Shutdowns field (SMART-15) in the SMART / Health Information Extended (Log Identifier C0h) and the SMART / Health Information (Log Identifier 02h) Critical Warning field shall have bit 3 set to 1b.		
INCS-5	The device shall still support data eradication via the Sanitize command even if it is operating in Read Only Mode (ROM), and it shall support NVMe Admin commands.		
INCS-6	If the Error Recovery (Log Identifier C1h) is supported, when the device increments the Incomplete Shutdowns field in SMART / Health Information Extended (Log Identifier C0h), it shall use the following recovery procedure at the next power up: Device enters into Panic state (see Section 6.4), returns errors for all I/O commands without accessing the media and reports the Device Recovery Action needed in Error Recovery (Log Identifier C1h) with Device Recovery Action 1 set to 02h (i.e., bit 1 set to 1b and all other bits cleared to zero). See Was the Error Recovery Action 1 set to 02h (i.e., bit 1 set to 1b and all other bits cleared to zero). See Was the Error Recovery Action (Format NVM)		
INCS-7	If the Error Recovery (Log Identifier C1h) is not supported, when the device increments the Incomplete Shutdowns field in SMART / Health Information Extended (Log Identifier C0h), it shall use the following recovery procedure at the next power up:		



6.3 End to End Data Protection

Requirement ID	Description		
E2E-1	All user data and metadata shall be protected using overlapping protection mechanisms throughout the entire read and write path in the device including all storage elements (registers, caches, SRAM, DRAM, NAND, etc.).		
E2E-2	At least one bit of correction and 2 bits of detection is required for all memories. This shall be for all memories regardless of function.		
E2E-3	The entire DRAM addressable space shall be protected with at least one-bit correction and 2 bits of detection scheme (SECDED). This includes but is not limited to the following: • Flash translation layer (FTL). • Mapping tables (including metadata related to deallocated LBAs). • Journal entries. • Firmware scratch pad. • System variables. • Firmware code.		
E2E-4	Silent data corruption shall not be tolerated under any circumstances.		
E2E-5 The device shall include a mechanism to protect against returning the dat wrong logical block address (LBA), including previous copies from the sam the host. It is acceptable if the device stores additional/modified informa provide protection against returning wrong data to the host. Device shall host LBA integrity checking on all transfers to and from the media.			

Requirement ID	Description	
E2E-6	All device metadata, firmware, firmware variables, and other device system data shall be protected by at least a single bit detection scheme.	
E2E-7	Any memory buffers that are utilized to accelerate data transfer (read-ahead buffe for example) shall follow the protection scheme outlined in E2E-5 (wrong logical block address protection).	

6.4 Behavior on Firmware Crash, Panic or Assert

Requirement ID	Description		
CRASH-1	After a firmware crash, panic or assert in which the device can no longer accept Write commands, the device shall allow read access only if it can guarantee data integrity.		
CRASH-2	After a firmware crash, panic or assert, that is not a controller hardware failure, the device shall still support NVMe Admin commands including the ability to read any failure logs from the device to determine the nature of the failure.		
CRASH-3	After the host performs the action specified in Device Recovery Action (see <u>EREC-3</u> (<u>Device Recovery Action</u>)), the device shall allow full read and write access at full performance.		
CRASH-4	Obsolete		
CRASH-5 The device shall have a mechanism (e.g., watchdog timer) to prevent the firmware.			

6.5 Annual Failure Rate (AFR)

Requirement ID	Description		
REL-1 The device shall meet an MTBF of 2.5 million hours (AFR of <= 0.35% per JEC 218) under the following environmental conditions:			•
	Specification	Environment	Requirement
	Tomporatura	Operational	 0°C to 50°C (32°F to 122°F) < 20°C (68°F) per hour gradient
	Temperature	Non- Operational	 -40°C to 70°C (-40°F to 158°F) < 30°C (86°F) per hour gradient
	Humidity	Operational	 10% to 90% non-condensing Yearly weighted average: < 80% RH 90% of year: < 80% 10% of year: 80% to 90%

Requirement ID		Description		
				Maximum dewpoint: 29.4°C (85°F)
			Non- Operational	 5% to 95% non-condensing 38°C (100.4°F) maximum wet bulb temperature
REL-2				f 2.0 million hours (AFR of <= 0.44% per JEDEC JESD
	2		-	mental conditions:
ı		Specification	Environment	Requirement
		Tanananah	Operational	 0°C to 55°C (32°F to 131°F) < 20°C (68°F) per hour gradient
		Temperature	Non- operational	 -40°C to 70°C (-40°F to 158°F) < 30°C (86°F) per hour gradient
			Operational	 10% to 90% non-condensing Maximum dewpoint: 29.4°C (85°F)
		Humidity	Non- operational	 5% to 95% non-condensing 38°C (100.4°F) maximum wet bulb temperature
REL-3	S	upplier shall pro	vide the temper	rature conditions used to determine the MTBF.
REL-4		upplier shall pro equirement REL-		ng curves for the Temperature range shown in (158°F).
REL-5	h 7	ours) shall be m	aintained up to	f 2.5 million hours) and REL-2 (MTBF of 2.0 million a continuous reported composite temperature of than 1% of the device power on time above
REL-6	s r	urfaces, pads, fir eactive coating (ngers, etc. on all e.g., resin packa	raw copper on any component. All copper components shall be covered with a minimally ging material on ICs, gold plating on PCB gs on component leads and IC balls).

6.6 Background Data Refresh

Requirement ID	Description
BKGND-1	The device shall support background data refresh while the device is powered on to ensure there is no data-loss due to power-on retention issues.
BKGND-2	The device shall be designed and tested to support the normal NAND operating temperature.

Requirement ID	Description
BKGND-3	Background data refresh shall cover the entire device and be designed to continuously run in the background and not just during idle periods.

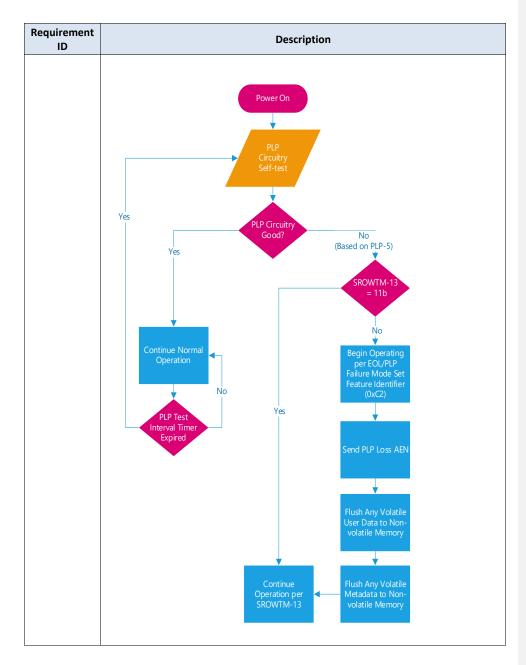
6.7 Wear-leveling

Requirement ID	Description
WRL-1	The device shall utilize the entire Endurance Group media capacity range whenever the device needs to wear-level a block. The device shall not restrict the wear-leveling range to a subset of the Endurance Group media capacity unless otherwise specified. If the device does not support Endurance Groups, it shall wear-level across the entire physical media.

6.8 Power Loss Protection

Requirement ID	Description
PLP-1	The device shall support full power-loss protection for all acknowledged data and metadata.
PLP-2	The Power-loss protection health check shall not impact I/O latency and performance.
PLP-3	Power-loss protection health check shall be performed by the device at power-on (prior to accepting any writes) and at least once every time interval as specified in SPLPI-13 (PLP Health Check Interval).
PLP-4	While performing the power-loss protection health check, the device shall still have enough energy to be able to handle an abrupt power loss properly.
PLP-5	The firmware/hardware algorithm shall deploy safeguards to prevent a false detection of power loss protection failure. Example of a false detection would be a glitch in any of the power loss circuitry readings which would cause a transient event to trigger a false power loss protection failure when the power loss protection hardware is healthy.
PLP-6	The device shall implement a power-loss protection (PLP) health check which can detect the capacitor holdup energy margin reported in the Capacitor Health field specified in SMART-19 (Capacitor Health) in SMART / Heath Information Extended (Log Identifier COh). The PLP health check shall not just check for open/short capacitor conditions but shall measure the true available margin energy.
PLP-7	The factory default PLP Health Check Interval shall be 15 minutes (see GPLPI-2 (PLP Health Check Interval)).

Requirement ID	Description
PLP-8	The default PLP Health Check Interval of 15 minutes (see GPLPI-2 (PLP Health Check Interval)) shall not cause the device to violate REL-1 or REL-2.
PLP-9	The device shall use the following workflow for the PLP Health Check (see INCS-1 (power-loss protection mechanism fails) for PLP AEN details):



6.9 Device Limits

Requirement ID	Description
DEVLMT-1	The device shall not have any architectural restrictions on the number of times any of the following events can occur: • Firmware downloads and activation supported (see FWUP-2 (number of firmware downloads)); or • Changing password when taking/changing ownership via TCG; or • Crypto erase or block erase (format); or • Power cycles; or • Set/get features (including power state changes); or • Log page or debug log retrievals. This is not meant to be a test until fail requirement.

7 Endurance

7.1 Endurance Data

Requirement ID	Description
ENDUD-1	The device documentation shall include the number of physical bytes able to be written to the device assuming a write amplification of 1. The units should be gigabytes (10^9 bytes).
ENDUD-2	The preconditioning steps to test device performance at end of life are: • 50/50 Read/Write workload (by number of I/Os). • 4kiB Read accesses aligned to 4kiB boundaries. • 128kiB Write accesses aligned to 128kiB boundaries. • Random pattern of Read addresses. • Sequential pattern of Write addresses. • 100% active range. • 80% full device (80% data, 20% free space). • 0% compressible data. • Ambient temperature 35°C (95°F). • Short-stroked device if capacity is 2TB or greater (see EOL-2 (method to "short stroke" the device)).

Requirement ID	Description
	The Percentage Used in the SMART / Heath Information (Log Identifier 02h) shall track linearly with bytes written and at 100% it shall match the EOL value specified in ENDUD-1 (number of physical bytes able to be written).

7.2 Retention Conditions

Since there are several factors that impact the device endurance, the table below provides the requirements for the datacenter environment.

Requirement ID	Description
RETC-1	Non-Operational (Powered-off) device data retention time (end of life) shall be at least 1 month at 40°C (104°F). See <u>Section 12 Device Profiles</u> for specific retention requirements. Specific Devices Profiles may have longer data retention time requirements.
RETC-2	Operating (Powered-on) data retention shall be at least 7 years. For purposes of this requirement, the assumption is that the Terabytes Written (TBW) capability of the devices is used linearly over the lifetime. This requirement does not imply any specific warranty period.
RETC-3	The device shall not throttle its performance based on the endurance metric (endurance throttling).

7.3 Shelf Life

Requirement ID	Description
SLIFE-1	A new device may be kept as a datacenter spare and therefore shall be fully functional even if it sits on the shelf for at least 1 year at 20°C (68°F) before getting installed in the server. The device shall be new in box factory state.
SLIFE-2	Shelf-life shall be documented and provided to the customer.

7.4 End-of-Life (EOL)

Requirement ID	Description
EOL-1	Various types of samples are required for EOL testing:
	 Beginning of Life (Short stroked if required by EOL-2).
	2. End of Life (Short stroked if required by EOL-2).
	3. End of Life (Not short stroked if different than #2).
	EOL is defined as the Total Bytes Written (TBW) specification has been surpassed
	(see ENDUD-1 (number of physical bytes able to be written)) or the non-volatile

Requirement ID	Description
	media endurance limit (e.g., NAND cycling limit) has been reached; whichever is earliest.
EOL-2	On 2 TB or larger devices, there shall be a method to "short stroke" the device. Media reserved for background operations shall be proportionally adjusted. Short Stroke firmware capacity shall be reduced to a range of 10%-3% of full capacity. Short stroke shall cover all the channels/dies/planes while maintaining the native performance of the device.
EOL-3	When the Percentage Used field in the SMART / Health Information (Log Identifier 02h) reaches 100%, the device shall notify the host with a SMART / Health Status event.
EOL-4	The device shall continue to operate in a read/write mode until the conditions in EOL-5 are reached.
EOL-5	The device shall switch to Read Only Mode (ROM) when the Available Spare field in the SMART / Health Information (Log Identifier 02h) reaches 0%. A value of 0% represents the device state where there is an insufficient number of spare blocks to support Host writes. After the device switches to read-only mode, bit 2 and bit 3 of the Critical Warning field of Section 5.14.1.2 SMART Attributes in the NVMe specification version 1.4b shall be set to 1b.
	The device shall set bit 0 of the Critical Warning field to 1b in the SMART Attributes specified in Section 5.14.1.2 of the NVMe specification version 1.4b and generate a SMART / Health Status event when the available spares value falls below the available spare threshold.

8 Thermal

8.1 Data Center Altitude

Requirement ID	Description
THERM-1	Support for devices in data centers located at an altitude of up to 10,000 feet above sea level is required (e.g., thermals, cosmic rays, etc.). When considering thermals, there shall be no de-rating up to 6,000 feet above sea level. Above 6,000 feet the derating shall be 0.9° C (1.6° F)/1000ft.
THERM-2	A thermal study with each platform is required and shall be provided to the customer. The thermal design shall be validated up to 35°C (95°F) ambient temperature for the platform with a worst-case airflow of 1.5 meters per second at sea level.

Requirement ID	Description
THERM-3	The device shall operate normally with relative humidity to be between 10% and 90%.

8.2 Thermal Throttling

Requirement ID	Description
TTHROTTLE-1	The device shall implement a thermal throttling mechanism to protect the device in case of a failure or excursion that causes the device temperature to increase above its maximum specified temperature.
TTHROTTLE-2	When the device begins throttling performance due to an over temperature condition, an Asynchronous Event Request shall be completed with the Asynchronous Event Type field set to 001b (SMART / Health status) and the Asynchronous Event Information field set to 01h (Temperature Threshold). The device shall set bit 1 of the SMART / Health Information (Log Identifier 02h) Critical Warning field to 1b.
TTHROTTLE-3	Thermal throttling shall only be engaged under certain failure conditions such as excessive server ambient temperature or beyond the server's fan failure redundancy limit. The required behavior is illustrated below: SSD SMART (Composite) temperature may overshoot up to 77°C for brief durations (< 1% of the SSD life) Typical Steady State SSD Temperature (70°C Max) Typical Steady SSD Temperature (70°C Max) Typical SSD Temperature (70°C Max) Typical SSD Temperatu
TTHROTTLE-4	The firmware algorithm shall deploy safeguards to prevent a false activation of either thermal throttling or thermal shutdown. An example of a false activation would be a glitch in any of the sensor readings which would cause the composite temperature to reach the thermal throttling or thermal shutdown limit.
TTHROTTLE-5	A composite temperature of 77°C (170.6°F) shall be used for throttling.
TTHROTTLE-6	Thermal throttling shall not start based on the rate of temperature increase or slew rate.
TTHROTTLE-7	When the device is in the thermal throttling state and the temperature drops back down below 75°C (167°F), the device shall exit the thermal throttling state and an Asynchronous Event Request shall be completed with the Asynchronous Event Type

Requirement ID	Description
	field set to 001b (SMART / Health status) and the Asynchronous Event Information field set to 01h (Temperature Threshold). The device shall clear bit 1 of the SMART / Health Information (Log Identifier 02h) Critical Warning field to 0b.
TTHROTTLE-8	When the device reaches a critical temperature on any component it shall report a composite temperature of 85°C (185°F) and an Asynchronous Event Request shall be completed with the Asynchronous Event Type field set to 001b (SMART / Health status) and the Asynchronous Event Information field set to 01h (Temperature Threshold) before the device shuts off to protect itself.
TTHROTTLE-9	The device shall report a value of 015Eh (77°C) in the Warning Composite Temperature Threshold (WCTEMP) field of the Identify Controller Data structure.
TTHROTTLE-10	The device shall report a value of 0166h (85°C) in the Critical Composite Temperature Threshold (CCTEMP) field of the Identify Controller Data structure.
TTHROTTLE-11	If the Composite Temperature is greater than or equal to 77°C (170.6°F), the device shall update the Warning Composite Temperature Time field of the SMART / Health Information (Log Identifier 02h) once a minute until one of the following occurs: - The device Composite Temperature falls below 75°C (167°F), or - The device shuts down due to an over Critical Temperature condition, or - The device is power cycled.

8.3 Temperature Reporting

Requirement ID	Description
TRPT-1	The device shall expose the current raw sensor readings from all the sensors on the device.
TRPT-2	The device's device-to-device composite temperature variation shall be no more than +/- 1 degrees C. Two different devices shall not report a composite temperature greater than 2 degrees apart under the same environmental conditions, slot location, and workload.
TRPT-3	A single device's composite temperature shall not vary by more than +/-1°C (1.8°F) degrees once it is in a steady state under the same environmental conditions, slot location, and workload.
TRPT-4	The supplier shall provide to the customer the equation, settings, and thresholds used to calculate the composite temperature.
TRPT-5	When calculating the composite temperature, the device shall take into account the temperature of all of the major thermal components (SOC, DRAM, NAND, PMIC, etc.).

8.4 Thermal Shutdown

Requirement ID	Description
THRMS-1	The device shall shut down to protect itself against data loss or damage due to
	extreme temperatures. The shutdown temperature value shall be at a composite
	temperature of 85°C (185°F) or higher. Shutdown shall preserve all user data.

9 Form Factor Requirements

9.1 Generic Form Factor Requirements

Requirement ID	Description
GFF-1	The device shall be compliant to PCIe base specification 4.0 (or later).
GFF-2	Vendor shall provide a PCIe compliance report.
GFF-3	The device shall support lane reversal with all lanes connected or partially connected lanes (e.g., a x4 device shall support it for x4, x2, and x1 connections).
GFF-4	The device shall train to x1 when only one upstream port is available, to x2 when the upstream device provides only 2 lanes per device and to x4 when 4 lanes are present.
GFF-5	The device shall support hot swap on form factors that support hot swap.
GFF-6	A CAD file of each supported form factor shall be provided to the customer.

9.2 Power Consumption Measurement Methodology

Requirement ID	Description
PCM-1	The device Max Average Power (MAP) consumption for any workload shall not exceed the Maximum Power (MP) of the current NVMe Power State over a 1s window with a sampling rate of 2ms or better. The measurement duration shall be at least 15 minutes on a pre-conditioned device. This requirement defines the measurement methodology for Maximum Sustained Device Power as defined in SFF TA-1009 revision 3.0.
PCM-2	The device peak power for any workload shall be measured over a 100uS window with a sampling interval of 4uS or smaller. The measurement duration shall be at least 15 minutes on a pre-conditioned device.
PCM-3	For devices, whose max average power consumption is less than or equal to 25W the peak power shall be no more than 1.5x the max average power. For devices,

Requirement ID	Description
	whose max average power consumption is greater than 25W but less than or equal to 29W the peak power shall be no more than 37.5W. For devices, whose max average power consumption is greater than 29W, the peak power shall be no more than 1.3x the max average power. The max average power is defined in PCM-1.

9.3 Power Levels

Requirement ID	Description
PWR-1	The Power Management (Feature Identifier 02h) shall be supported and the NVMe Power State Descriptor table in Identify Controller Data Structure bytes 3071:2048 shall be filled out per the NVMe 1.4b specification.
PWR-2	Obsolete. See <u>DCLP-9 (DSSD Power State Table Descriptors)</u> and <u>Section 4.8.10.2</u> <u>DSSD Power State Descriptor</u> .
PWR-3	The method of measurement for Maximum Average Power (MAP) is defined in PCM-1 (device max average power). MAP values are reported in the Maximum Power (MP) field of NVMe Power State Descriptors.
PWR-4	Power state entries above the maximum rated power envelope of the device shall not be populated in the NVMe Power State Descriptor table in Identify Controller Data Structure bytes 3071:2048.
PWR-5	The Set Features for Power Management (Feature Identifier 02h) with the SV bit 31 in Command Dword 10 shall be supported so that the power level can be set and will be saved across power cycles.
PWR-6	The device, regardless of form factor or capacity, shall have an idle power of 5 Watts or less per European regulation.
PWR-7	The device shall not consume more power than the PCI-SIG Slot Capabilities register Slot Power Limit regardless of other settings (e.g., DSSD Power State, NVMe Power State).

9.4 M.2 Form Factor Requirements

Requirement ID	Description
FFM2-1	The device shall adhere to the M.2 specification with a size of 22mm x 110mm.
FFM2-2	The bottom-side height shall not exceed 1.5mm.
FFM2-3	The top-side height shall not exceed 3.2mm. Some models may need to be thinner (see <u>Section 12 Device Profiles</u>).
FFM2-4	The device shall use an M key.

FFM2-5	The device shall support a minimum of PCIe Gen4 x4.
FFM2-6	The device shall support driving an activity LED through the connector via LED_1#.
FFM2-7	The LED should be lit solidly when power is applied and flashing when there is traffic going to the SSD.
FFM2-8	The device shall not use any pins that are defined in the m.2 specification for vendor unique functionality.
FFM2-9	The device shall support a protection scheme that protects against NAND block level failures.
FFM2-10	The protection scheme must also support NAND plane level failures without data or metadata loss.
FFM2-11	The Label shall be placed on the top side of the device.
FFM2-12	The device electricals shall follow the SMBus connection as described below and in PCI SIG M.2 3.0 1.2 or later.
FFM2-13	The device's SMBus protocol shall comply to version 3.1 (see http://smbus.org/specs/SMBus 3 1 20180319.pdf).
FFM2-14	The default max average power for M.2 devices shall not exceed 8.25W and the peak power shall comply to PCM-3 (peak power limit).

9.5 E1.S Form Factor Requirements

Requirement ID	Description			
FFE1S-1	The device shall adhere to the latest revision of SFF-TA-1006.			
FFE1S-2	At a minimum, the device shall support PCIe Gen4 x4.			
FFE1S-3	The device shall support activity and error LEDs.			
FFE1S-4	The activity LED shall be lit solidly when power is applied and flashing when there is traffic going to the device.			
FFE1S-5	The device shall support a protection scheme that protects against NAND block level failures.			
FFE1S-6	The protection scheme must also support NAND plane level failures without data or metadata loss.			
FFE1S-7	The amber LED shall meet the requirements specified in SFF TA-1009. The functioning of the Amber LED shall be independent of the 12V, 3.3Vaux and the state of the PWRDIS pin.			
FFE1S-8	The thermal performance of the 9.5mm, 15mm, and 25mm cases and their associated pressure drops shall be provided.			
FFE1S-9	The PWRDIS pin shall be supported.			

Requirement ID	Description
FFE1S-10	The SMBus electrical connections shall follow the "DC Specification For 3.3V Logic Signaling" as defined in SFF-TA-1009 revision 2.0. Including Vih1 with a max of 3.465V.
FFE1S-11	The device's SMBus protocol shall comply to version 3.1 (see http://smbus.org/specs/SMBus 3 1 20180319.pdf).
FFE1S-12	A x4 device shall only have a 1C connector.

9.6 E1.L Form Factor Requirements

Requirement ID	Description
FFE1L-1	The device shall adhere to the latest revision of SFF-TA-1007.
FFE1L-2	At a minimum, the device shall support PCIe Gen4 x4.
FFE1L-3	The device shall support activity and error LEDs.
FFE1L-4	The activity LED shall be lit solidly when power is applied and flashing when there is traffic going to the device.
FFE1L-5	The device shall support a protection scheme that protects against NAND block level failures.
FFE1L-6	The protection scheme must also support NAND plane level failures without data or metadata loss.
FFE1L-7	The amber LED shall meet the requirements specified in SFF TA-1009. The functioning of the Amber LED shall be independent of the 12V, 3.3Vaux and the state of the PWRDIS pin.
FFE1L-8	The thermal performance of the 9.5mm and 18mm cases and their associated pressure drops shall be provided.
FFE1L-9	The PWRDIS pin shall be supported.
FFE1L-10	The SMBus electrical connections shall follow the "DC Specification For 3.3V Logic Signaling" as defined in SFF-TA-1009 revision 2.0. Including Vih1 with a max of 3.465V.
FFE1L-11	The device's SMBus protocol shall comply to version 3.1 (see http://smbus.org/specs/SMBus 3 1 20180319.pdf).
FFE1L-12	A x4 device shall only have a 1C connector.

9.7 E3 Form Factor Requirements

Requirement ID	Description
FFE3-1	The device shall adhere to the latest revision of SFF-TA-1008.

Requirement ID	Description
FFE3-2	The device shall adhere to the latest revision of SFF-TA-1009.
FFE3-3	The device shall support Separate Refclk Independent SSC Architecture (SRIS) requirements of the PCIe Express Base Specification Revision 3.0 and its ECNs. Devices shall support SRIS detection as described in SFF-TA-1009.
	The SRIS support shall include a clock tolerance of a 5600-ppm difference for separate reference clocks.

9.8 SFF-8639 (U.2/U.3) Form Factor Requirements

9.8 SFF-8639	(U.2/U.3) Form Factor Requirements			
Requirement ID	Description			
FF8639-1	The device shall adhere to the latest revisions of SFF-TA-1001 and PCI Express SFF-8639 Module Specification.			
FF8639-2	The device shall support Separate Refclk Independent SSC Architecture (SRIS) requirements of the PCle Express Base Specification Revision 3.0 and its ECNs.			
	Devices shall support SRIS detection as described in SFF-8639 Module Specification Rev 4.0 or later.			
	The SRIS support shall include a clock tolerance of a 5600-ppm difference for separate reference clocks.			
FF8639-3	Activity LED All 2.5 SFF NVMe devices shall support the activity LED function on Pin 11 of the SFF-8639 connector.			
	Pin 11 shall assert (see <u>FF8639-4 (Active State)</u>) while processing a command, the device shall drive the activity LED signal to an asserted state for 50ms and then to a negated state for 50ms (i.e., The LED is usually off, but flashes on and off while commands are processed).			
	The activity cycle time frame for the blinking (assertion time + de-assertion time) shall be 500 milliseconds.			
	If there is no activity the signal shall be de-asserted.			
FF8639-4	Active State (pin asserted and LED on) is defined as logic "0" (i.e., < 0.3 volts) on Pin 11. Inactive State is defined as logic "1" (i.e., > 3.3 volts) on Pin 11.			
	A device's internally initiated background activity or maintenance routine that is not commanded to be performed from the host shall not cause the LED to be in the Active State (logic "0" level).			

10 Out-of-Band Management Support

10.1 NVMe Basic Management Command (Appendix A) Requirements

Requirement ID	Description						
SMBUS-1	The device shall support the NVMe Basic Management Command as defined in Appendix A of the NVMe Management Interface 1.1b specification:						
		(https://nvmexpress.org/wp-content/uploads/NVM-Express-Management-Interface-1.1b-2020.10.05-Ratified.pdf).					
SMBUS-2	SMBus Bloverride	lock Read protocol and Byte Read protocol shall be supported. As an of the NVMe Management Interface 1.1b specification, SMBus Block Write and Byte Write protocol shall also be supported.					
SMBUS-3		te shall implement the SMBus format as show in <u>Section 10.2 - NVMe Basic</u> nent Command (Appendix A) <u>Data Format</u> .					
SMBUS-4		herwise noted, the default value for the Firmware Update Flags field (Byte SMBus Data structure shall be set to FFh.					
SMBUS-5		re Boot Failure Feature Reporting Supported bit at offset 243 shall be d and set to 1b.					
SMBUS-6		ere is a secure boot failure the device shall report the failure with the behavior:					
	Bit	Description					
	7	Shall be set to 1b. See Command Code 242 (Secure Boot Failure Reporting) for definition.					
	6	Shall be set to 1b. See Command Code 242 (Secure Boot Failure Reporting) for definition.					
	5 Shall be set to 1b if OCP Recovery/ Platform Root-of-Trust for Recovery codes are supported. If this bit is set to 1b then a valid Recovery code shall be entered in byte 244.						
	4:0 Reserved. Shall be cleared to zero.						
SMBUS-7	The device shall take no longer than the CAP.TO timeout value to produce stable SMBus output through the NVMe Basic Management Interface protocol (if supported).						
SMBUS-8	If the device has set a non-zero value in the Panic ID field (Command Code 154, Byte 01h), then the device shall clear the Drive Functional field to 0b (Command Code 0, Byte 01h, Bit 5b).						
SMBUS-9	The device shall generate the PEC values specified for each command code in the SMBus data format described in Section 10.2 - NVMe Basic Management Command (Appendix A) Data Format when the host issues a Block Read.						

Commented [LP3]: Should we update this to 1.2a?

Requirement ID	Description		
SMBUS-10	The device shall check the PEC value sent when the host issues a Block Write and only process the message if the PEC value matches the SMBus data format specified value described in Section 10.2 - NVMe Basic Management Command (Appendix A) Data Format . The device is encouraged to issue a NACK if the PEC value is not correct.		
SMBUS-11	All of the NVME-MI Basic data defined in Section 10.2 shall be returned in bigendian format unless otherwise noted.		
SMBUS-12	The device shall support Platform Root-of-Trust for Recovery codes in SMBUS-6 which are defined in the <u>Recovery Document</u> which is referenced by the <u>OCP</u> <u>Hardware Secure Boot White Paper</u> .		

10.2 NVMe Basic Management Command (Appendix A) Data Format

Command Code (Decimal)	Byte Offset (Decimal)	Description			
0	0	Defined in NVM Expr	ess Manageme	ent Interface 1.	1b.
8	8	Defined in NVM Expr	ess Manageme	ent Interface 1.	1b.
32	32	Payload length of Command Code 32: This is the number of bytes until the PEC code. This shall be set to 10h.			
	48:33	GUID: This is a 16-by	te Global Uniq	ue Identifier.	
			Byte Address	Value	
			33	73h	
			34	89h	
			35	20h	
			36	E5h	
			37	6Bh	
			38	EEh	
			39	42h	
			40	58h	
			41	9Ah	
			42	7Ah	
			43	CEh	
			44	BDh	
			45	B3h	

Command Code (Decimal)	Byte Offset (Decimal)	Description			
			46	5Fh	
			47	00h	
			48	85h	
	49	PEC: An 8-bit CRC ca second SMBus addre the SMBus Specifica	ess and returne		ess, command code, gorithm is defined in
50	50	Payload length of Co additional bytes to r			
	51	Temperature Flags: This field reports the effect of temperature on the device's performance. Temperature Throttling – Bit 7 is set to 1b when the device is throttling performance to prevent overheating. Clear to 0b when the device is not throttling. Bits 6:0 shall be set to 1111111b.			
	52	Max Power Supported (MAP) supported by examples of how to 19h, a 15W device is	this device rou use this is a 50\	nded to the ne V device is 32h	arest watt. Some , a 25W device is
84:53 Configured NVMe Power State: This is a copy of the Descriptor Data Structure of the currently configured is laid out in little endian format.					
88:85 Total NVM Capacity: This field indicates the total usable NV in the NVM subsystem in GB in Hex (2048 GB in total capaci 0000800h). This field is equivalent to the TNVMCAP field in Identify Controller Data Structure.			tal capacity =		
	89	PEC: An 8-bit CRC calculated over the SMBus address, command cod second SMBus address and returned data. The algorithm is defined the SMBus Specification.			
90	90	Payload length of Command Code 90: Indicates number of addition bytes to read before encountering PEC. Shall be set to 04h.			
	91	Firmware Update Flathe current firmware Section 11 Security f	e allows new fir for more inform	mware images ation).	to control whether to be activated (see
			ost, read by dev	scription	
		, written by in	ost, read by det	icc.	

Command Code (Decimal)	Byte Offset (Decimal)	Description			
			1b Unlock Firmware Update Device shall enable Firmware update		
			Ob Lock Firmware Update Device shall block and error on Firmware download and activate commands		
		6	Written by device, read by host:		
			1b Firmware Update Unlocked Device shall allow Firmware download and activate commands		
			Ob Firmware Update Locked Device shall block and error on Firmware download and activate commands		
		5:0	The device shall revert to the default Unlock/Lock state on the next		
		power cycle. If the host attempts a Download Firmware command when the device is in the Firmware Update Locked state, the device shall fail the command with status Operation Denied.			
	94:92	Reserv	ed. Shall be cleared to zero.		
	95	second	PEC: An 8-bit CRC calculated over the SMBus address, command code, second SMBus address and returned data. The algorithm is defined in the SMBus Specification.		
96	96		Payload length of Command Code 96: Indicates number of additional bytes to read before encountering PEC. Shall be set to 38h.		
	104:97	Firmware Version Number: This field shall indicate the activated firmware version that is running on the device after the firmware activation took place. The format of this field shall be as defined in field Firmware Revision (FR) Section 5.15.2.2 Identify Controller Data Structure of the NVMe specification version 1.4b.			
	112:105	currently running firmware image. The supplier increments this number any time a firmware includes a fix for a security issue or critical firmware fix that customer agrees rollback prevention is required. This is a copy of SMART-22 – Security Version Number.			
	152:113				

Command Code (Decimal)	Byte Offset (Decimal)	Description		
	153	PEC: An 8-bit CRC calculated over the SMBus address, command code, second SMBus address and returned data. The algorithm is defined in SMBus Specification.		
154	154	Payload length of Command Code 154: Indicates number of additional bytes to read before encountering PEC. Shall be set to 0Bh.		
	155	Panic Rest Action: See <u>EREC-2 (Panic Reset Action)</u> .		
	156	Device Recovery Action 1: See <u>EREC-3 (Device Recovery Action 1)</u> .		
	164:157	Panic ID: See <u>EREC-4 (Panic ID)</u> .		
	165	Device Recovery Action 2: See <u>EREC-14 (Device Recovery Action 2)</u> .		
	166	PEC: An 8-bit CRC calculated over the SMBus address, command code, second SMBus address and returned data. The algorithm is defined in the SMBus Specification.		
167	167	Payload length of Command Code 167: Indicates number of additional bytes to read before encountering PEC. Shall be set to 20h.		
	199:168	Panic Context Buffer: Vendor may record additional information about the Panic ID reported in Command Code 154. Any unused bytes shall be cleared to zero.		
	200	PEC: An 8-bit CRC calculated over the SMBus address, command code, second SMBus address and returned data. The algorithm is defined in the SMBus Specification.		
201	241:201	Reserved. Shall be cleared to zero.		
242	242	Payload length of Command Code 242: Indicates number of additional bytes to read before encountering PEC. Shall be set to 04h.		
	243	Secure Boot Failure Reporting:		
		Bit Description		
		7 Secure Boot Failure Feature Reporting Supported: When set to 1b the secure boot feature reporting is supported. When cleared to 0b the secure boot failure feature reporting is not supported.		
		6 Secure Boot Failure Status: When cleared to 0b there is no secure boot failure. When set to 1b there is a secure boot failure. This bit shall only be set if the Secure Boot Feature Supported bit is set to 1b and there is a secure boot failure.		
		5 OCP Recovery/ Platform Root-of-Trust for Recovery: When set to 1b, OCP Recovery/ Platform Root-of-Trust for Recovery codes are supported in byte 244. When cleared to 0b OCP Recovery/ Platform Root-of-Trust for Recovery		

Command Code (Decimal)	Byte Offset (Decimal)	Description	
		codes are not supported and byte 244 shall be cleared to zero.	
		4:0 Reserved. Shall be cleared to zero.	
	244	Recovery Code: OCP Recovery/Platform Root-of-Trust for Recovery code.	
	246:245	Reserved. Shall be cleared to zero.	
	247	PEC: An 8-bit CRC calculated over the SMBus address, command code, second SMBus address and returned data. The algorithm is defined in the SMBus Specification.	
248	248	Payload length of Command Code 248: Indicates number of additional bytes to read before encountering PEC. Shall be set to 06h.	
	250:249	Data Format Version Number: Indicates the version of this mapping used in the device. Shall be set to 0004h.	
	254:251	Reserved. Shall be cleared to zero.	
	255	PEC: An 8-bit CRC calculated over the SMBus address, command code, second SMBus address and returned data. The algorithm is defined in the SMBus Specification.	

10.3 NVMe-MI 1.1b Requirements

Requirement ID	Description	
NVMe-MI-1	The device shall support NVMe Management Interface Specification version 1.1b or later.	
NVMe-MI-2	The device shall support MCTP over SMBus.	
NVMe-MI-3	The device shall support MCTP over PCIe VDM.	
NVMe-MI-4	The device shall support SMBUS Fixed and Discoverable.	
NVMe-MI-5	The device shall NACK any SMBus/I2C addresses not listed in the NVM Express Management Interface 1.1b.	
NVMe-MI-6	The device shall support the GET UDID command.	
NVMe-MI-7	The device shall have a VPD that is accessible over SMBus and supports IPMI Platform Management FRU Information. The VPD shall support all required elements that are defined in the NVM Express Management Interface Specification Revision 1.1b.	

Requirement ID	Description
NVMe-MI-8	All mandatory NVMe Management Interface commands defined by the NVMe Management Interface Specification 1.1b shall be supported through MCTP over SMBus and MCTP over PCIe VDM.
NVMe-MI-9	All mandatory NVMe Admin commands defined by the NVMe Management Interface Specification 1.1b shall be supported through MCTP over SMBus and MCTP over PCIe VDM.
NVMe-MI-10	The following NVMe Admin commands shall be supported by MCTP over SMBus, even when the PCIe Links are not active, and MCTP over PCIe VDM. • Firmware Activate/Commit • Firmware Image Download • Sanitize • Security Send • Security Receive • Get Features • Set Features
NVMe-MI-11	The following Log Identifiers shall be supported by MCTP over SMBus, even when the PCIe Links are not active, and MCTP over PCIe VDM. SMART / Health Information Log (02h) Error Information Log (01h) Firmware Slot Information (03h) Device Self-test (06h) Sanitize Status (81h)
NVMe-MI-12	The following Log Identifiers shall be supported by MCTP over PCIe VDM. • Persistent Event Log (0Dh) • Telemetry Host-Initiated (07h) • Telemetry Controller-Initiated (08h)
NVMe-MI-13	The following Feature Identifiers shall be supported by MCTP, even when the PCIe Links are not active, over SMBus and MCTP over PCIe VDM. • Power Management (02h) • Timestamp (0Eh) • Temperature Threshold (04h)

11 Security

11.1 Basic Security Requirements

Requirement ID	Description
SEC-1	The device shall support signed firmware binary update which is checked before firmware is activated. The device firmware shall be authenticated using cryptographic keys on every reboot and during firmware update.
SEC-2	The device shall support XTS-AES-256 (As specified in NIST SP 800-38E, which references IEEE STD 1619) or AES-256-GCM (As specified in NIST SP 800-38D) hardware-based data encryption. AES-256-GCM is the preferred mode. The following AES variants are also acceptable: • AES-256-EAX • AES-256-CTR+HMAC-SHA256 (encrypt-then-MAC) • AES-256-HEH • AES-256-CBC+S
SEC-3	The device shall support anti-rollback protection for firmware. The anti-rollback protection shall be implemented with a security version which is different than the firmware version. If the security version of the firmware being activated is greater or equal to the current security version the firmware may be activated. If the security version of the firmware being activated is not equal or greater than the firmware being activated the firmware update shall fail.
SEC-4	The device shall support Crypto Erase (see <u>NVMe-AD-5 (support Format NVM)</u> and <u>NVMe-AD-7 (support Sanitize)</u>).
SEC-5	The device shall support Secure Boot (see <u>Section 11.2 Secure Boot</u>).
SEC-6	The device shall have a method of identifying a secure boot failure which does not require physical access to the device.
SEC-7	The device's cryptographic module shall be FIPS 140-3 capable per CMVP and shall follow the NIST 800-90 (A, B and C) specification.
SEC-8	The device shall implement only FIPS and NIST approved implementations and algorithms.
SEC-9	The device shall support Key revocation allowing a new key to be used for firmware verification on update. Preferred implementation is to allow for up to 3 key revocations.
SEC-10	TCG devices shall support TCG Opal v2.01 with mandatory support for the Locking feature, the TCG Opal SSC feature, and the Datastore Table feature.
SEC-11	TCG devices shall support TCG Single User Mode feature set Version 1.00, revision 1.00.
SEC-12	TCG devices shall support TCG Configurable Namespace Locking (CNL) feature set Version 1.00, revision 1.00 with mandatory support for the Namespace Global Range Locking object. The Namespace Non-Global Range Locking object may be supported.

Requirement ID	Description
SEC-13	For models that support eDrive, the IEEE 1667 silo shall be supported.
SEC-14	Supplier shall follow the Security Development Lifecycle (SDL), and provide a report with the following for each qualification-ready or production-ready firmware version: • The Threat Model. • Fuzz & Pen Tests. • Static Analysis. • Build Logs and Compiler Security Settings. Additional information about the SDL is available here: https://www.microsoft.com/en-us/sdl/default.aspx
SEC-15	Security audits, including firmware source code review, shall be provided to the customer. This will include Telemetry and debug logs, etc.
SEC-16	All signing keys shall be stored in a Hardware Security Module (HSM) that is either FIPS 140-2 Level 3 (or greater) certified or FIPS 140-3 Level 3 (or greater) certified.
SEC-17	Access/use of signing keys should be restricted to a small set of developers, following the principle of least privilege. Number of people with access and their corresponding roles shall be provided.
SEC-18	All debug ports shall be disabled before the device leaves the factory. Alternatively, the ports shall only be accessible in the field after a successful exchange of a challenge-response mechanism using an asymmetric crypto scheme (refer to NIST SP 800-63). The state shall be reset to inaccessible on any reset or power cycle.
SEC-19	All vendor unique commands, log pages or set features that are not explicitly defined in this specification or approved of in writing by the customer shall be disabled before the device leaves the factory. Alternatively, the commands/log pages/set features shall only be accessible in the field after a successful exchange of a challenge-response mechanism using an asymmetric crypto scheme (refer to NIST SP 800-63). The state shall be reset to inaccessible on any reset or power cycle.
SEC-20	Adversarial testing using red teams shall be conducted before qualification starts. A report of items attempted, and results shall be provided to the customer.
SEC-21	 The vendor shall provide timely notification to the customer of security issues and delivery of fixes to the customer: Vendor shall document all security fixes with each firmware update. Vendor shall notify end customer within 7 days of discovering security issues in the device hardware or firmware. Notification of issues shall include the process and timeline of the vendor's commitment to fix the issue:

Requirement ID	Description	
	 For privately disclosed vulnerabilities, the duration shall be no longer than 90 days. For publicly disclosed vulnerabilities, the duration shall be no longer than 7 days. Vendors shall notify the customers about the known CVEs and security issues and provide security-related updates before public announcement. 	
SEC-22	All Telemetry and debugging logs shall be human readable.	
SEC-23	The device shall not include user data, passwords, keys and any secret or sensitive information in any Telemetry or debug logs.	
SEC-24	All public keys shall be revocable.	
SEC-25	Secure Boot Flow shall be based upon hardware root of trust. All mutable Key(s), Certificate(s) and/or firmware shall be cryptographically bound to the hardware root of trust.	
SEC-26	Secure firmware update flow shall be immutable from exploitation and use immutable public keys.	
SEC-27	If TCG Opal SP has been activated and the host has supplied a locking range password, the device shall use that password as an added source of randomness for its Deterministic Random Number Generator (DRNG). For example, the device may use KDF (PBKDF2) on the user provided locking range password to generate an output of equal length to the required locking range key length plus DRNG seed length. This output can then be utilized in parts, one part as Opal locking range key and the other part as an additional input to the DRNG. If the DRNG implementation does not allow taking additional input, then an alternate option would be to XOR this output (e.g., from PBKDF2 operation) with initial DRNG seed.	
SEC-28	The device shall delete all keys from volatile memory as soon as they are no longer needed for operation during the current power on state.	
SEC-29	The device shall only store host provided passwords, host provided keys, or any host provided secret information in non-volatile memory at any stage in an encrypted form. The encryption key for this protection shall not be stored in non-volatile memory. Device shall not store plaintext/cleartext secrets in any non-volatile memories.	
SEC-30	The supplier must deliver key management and encryption flow diagram details (not source code) which includes: • Encryption algorithms and modes (e.g., RNG, wrapping function, key derivation function). • Key size and password length.	

Requirement ID	Description		
	 Any crypto information that is stored in nonvolatile memory. Critical Security Parameters. Complete details about algorithm inputs (e.g., Initialization vector source and size, salt source and size, unique per device/product line/vendor) 		
SEC-31	The supplier must provide industry certification reports, if available, such as FIPS, NIST for device and device components such as TRNG, RNG, Crypto engine etc.		
SEC-32	Log data and user data (data transferred from the Host in Write Commands) shall be stored on physically separate areas on the device. For example, in the system area and the user data area, respectively.		
SEC-33	The vendor shall provide a comprehensive list of what is and what is not in the logs.		
SEC-34	Obsolete.		
SEC-35	All telemetry and debug logs shall only be writable by device firmware after a successful secure boot.		
SEC-36	TCG devices shall set the default TryLimit to 5 for all TCG Opal authorities. The value of the Tries column shall only be cleared to 0 after a power cycle.		
SEC-37	TCG devices shall support TCG Opal configuration (e.g., Level 0 discovery, ownership, etc.) through the SMBus interface via the NVME-MI Security Send and Security Receive NVMe Admin commands.		
	This shall be supported even when the PCle Links are not active (e.g., PERST# is asserted, secondary bus reset).		
SEC-38	TCG devices shall support TCG Feature Set: Block SID Authentication.		
SEC-39	TCG devices shall enforce a minimum password length (C-PIN PinLength of 16) of 16-bytes for all TCG Opal authorities.		
SEC-40	TCG devices shall allow a password length (C-PIN PinLength of 32) of at least 32-bytes for all TCG Opal authorities.		
SEC-41	The current TCG feature set configuration settings, if any, shall persist through a download of firmware code. This is required regardless of the "default setting state" of the new code being downloaded.		
SEC-42	TCG devices shall support TCG Storage Opal SSC Feature Set: PSID Version 1.00, revision 1.00.		
SEC-43	The PSID shall not be deterministic, and shall comprise at least 128 bits of entropy, and should comprise at least 160 bits of entropy. The entropy shall be unique for each drive.		
SEC-44	The generation method for the PSID shall be documented and provided to the customer.		

Requirement ID	Description			
SEC-45	After the PSID is provisioned in manufacturing, the PSID shall not be persistently stored in a form that makes direct retrieval of the PSID by firmware possible, either on the drive or outside the drive (e.g., storing the PSID on the drive using a cryptographic hash such that it can only be used to verify a PSID input from the host).			
SEC-46		Once manufacturing is complete, the PSID shall not be stored anywhere other than on the physical drive label.		
SEC-47	In addition to supporting ALL mandatory features defined in the corresponding TCG specifications, TCG devices shall also support the features listed in the below table.			
		Feature/Parameters	Value	
		CCC Facture Decementar	Onal 2 (0v0202)	

Feature	Value	
SSC Feature Descr	Opal 2 (0x0203)	
Core Spec (TCG St	orage Architecture)	2.01
	# of SIDs	1
SID	Try Limit	5
	Persistence	FALSE
Number of	Admins	4 (min)
Locking SP	User	8 (min)
Number of	Global	1
Locking Ranges	Additional	8 (min)
Number of Com II	1 (min)	
Data Store size	10 MB (min)	
MBR Table	128 MB (min)	
Configurable Acce	ss Control	Mandatory
Life Cycle support	:	Mandatory
Repurpose (Rever	Mandatory	
Shadow MBR		Shall not be supported
	Single User Mode	Shall be supported
Feature Set	PSK Secure Messaging	Optional
	PSID	Mandatory

Requirement ID	Description			
			Block SID	Mandatory
			Additional Data Store Tables	Mandatory 5 (min) @ 128KB each
SEC-48	The device shall not allow the host to read firmware or boot code from the device.			
SEC-49	All device firmware packages shall be encrypted based on a symmetric encryption and follow SEC-2 and SEC-29 for key storage.			
SEC-50	Device shall only support activation of encrypted firmware images.			
SEC-51	The device shall only store firmware in encrypted format when stored in non-volatile memory.			

11.2 Secure Boot

The device shall support Secure Boot. There are two fundamental things to address for secure boot:

- 1. Secure boot rooted in hardware.
- 2. Core Root of Trust Measurement.

The vendor should follow the recommendations in the <u>TCG Publication for Hardware Requirements for a Device Identifier Composition Engine</u>. DICE coupled with <u>RIOT Core</u> and Source for <u>RIOT</u> can help implement Cryptographic Identity with implicit attestation.

Requirement ID	Description
SBT-1	The device shall comply with the <u>FIPS 186-4 Digital Signature Standard (DSS)</u> and the <u>Open Compute Security Project Publication for Secure Boot Requirements</u> .
SBT-2	For Core Root of Trust measurement, each device shall have a Cryptographic Device Identity.
SBT-3	The <u>TCG DICE standard</u> , or hardware based cryptographic identity shall be implemented.
SBT-4	The device should following the guidance in the <u>Commercial National Security</u> <u>Algorithm Suite</u> regarding quantum resistant algorithms and key sizes.
SBT-5	Secure boot flow shall be immutable for exploitation and use immutable public keys.

11.3 Distributed Management Task Force (DMTF) Security Protocol and Data Model (SPDM)

Requirement ID	Description
SPDM-1	The device shall support firmware measurement and identity authentication per the DMTF SPDM 1.2 or later specifications.
SPDM-2	The device shall support the PCI-SIG Component Measurement and Authentication (CMA) ECN.
SPDM-3	The device shall support SPDM-1 and SPDM-2 via MCTP over SMBus/I2C.
SPDM-4	The device shall support SPDM-1 and SPDM-2 via MCTP over PCIe VDM.
SPDM-5	The device shall support SPDM-1 and SPDM-2 via PCI-SIG Data Object Exchange (DOE).
SPDM-6	The leaf certificate shall include a Subject Alternative Name extension as defined in the CMA ECN.

11.4 Data Encryption and Eradication

Requirement ID	Description
DATAE-1	Obsolete. Duplicate of <u>SEC-2 (XTS-AES-256 or AES-256 hardware-based data</u>
	encryption).

12 Device Profiles

The following are device profiles. This section is intended to be firmware-based configuration settings configured by device suppliers when manufacturing a device. A device may be configured with a mix of A and/or B settings. Each customer shall provide their A/B preference for each configuration setting.

The following conventions are used for the Device Profile Table:

Convention	Definition	
R	Required. This shall be supported.	
0	Optional. This may be supported.	
Р	Prohibited. This shall not be supported.	

Requirement	Description	Configuration Setting		
ID	Description	Α	В	
DP-CFG-1	Factory Default Sector Size.	4096-byte	512-byte	
DP-CFG-2	Number of Namespaces Supported.	NSM-4 (16	NSM-5 (16	
		Namespaces)	<u>Namespaces</u>	
			<u>per TB)</u>	
DP-CFG-3	Retention Time based on <u>RETC-1 (data retention time)</u> .	1 Month	3 Months	
DP-CFG-4	NVMe Basic Management Command Supported.	R	Р	

Requirement	Description	Configuration Setting		
ID	Description	Α	В	
DP-CFG-5	Max M.2 top side height.	2.0mm	3.2mm	
DP-CFG-6	EOL/PLP Failure Mode (Feature Identifier C2h).	Enabled	Disabled	
DP-CFG-7	Write Uncorrectable command support.	0	R	
DP-CFG-8	Time-to-Identify-Ready based on TTR-1.	<= 1 second	<= 10 seconds	
DP-CFG-9	Time-to-I/O-Ready based on TTR-2.	<= 20 seconds	<= 10 seconds	
DP-CFG-10	In addition to the requirements in TTR-4, the device shall keep CSTS.RDY = 0 until the device is able to service I/O commands successfully.	Р	R	

13

Labeling

The following sample label is meant to be used to refer to the label requirements in Section 13.1 - Label Requirements. It is not a model label and any markings on it are informative only. See the specifics in Section 13.1 Label Requirements for actual requirements:

Barcode-1 ("Model Number"_"Serial Number")

Barcode-2 (PSID with no delimiter characters)

Only needed if different from Model Number



Model Number: DSSD-Example-Model-Number

Serial Number: 0321xxxxxxxxxxxxxxxx



PSID: 10A9A3676D3A42A68A024479F83D8771

Manufacturer's Part Number: DSSD-Example-Model-Number-xxxxxxxxxxxxxx

Capacity: xxxxGB FW Ver: xxxxx Storage Device HW Ver: xxxxx

COO: Elbonia Rating: DC 12V 1.5A Vendor Logo





















13.1 Label Requirements

Requirement ID	Description				
LABL-1	The following fields are required information that shall be placed on the label:			label:	
	Item	Format	Text Required	Barcode Required	Barcode Type
	Barcode-1	'Model Number' 'Underscore' 'Serial Number' \n.	No	Yes	2d
	Model Number	See <u>LABL-11</u> (Model Number must match).	Yes	No	N/A
	Serial Number	See LABL-12 (Serial Number must match), LABL-15 (certification logos), and LABL-17 (Serial Number format).	Yes	No	N/A
	Manufacturer' s Part Number	Number used for ordering.	Yes, if different from Model Number	No	N/A
	Capacity	Number of GB or TB.	Yes	No	N/A
	STORAGE DEVICE	Text shall be "STORAGE DEVICE".	Yes	No	N/A
	PSID	TCG-OPAL Spec.	Yes	No	N/A
	Barcode-2	'PSID' \n	No	Yes	2d
	HW Revision		Yes	No	N/A
	Firmware Name & Revision		No	No	N/A
	Regulatory Mark	See <u>LABL-15</u> (certification	logos).	No	N/A
	Country Certification Numbers	See <u>LABL-15</u> (certification	logos).	No	N/A
	Certification Logos	See <u>LABL-15</u> (certification	logos).	No	N/A
	RoHS/ Green	See <u>LABL-15</u> (certification	logos).	No	N/A

Requirement ID	Description				
LABL-2	The Model Number on the shipping label shall match the Model Number used during qualification.				
LABL-3	The minimum fo	nt size shall be 3 points and the	typical size	should be 6	points.
LABL-4		field, if there are space constra ust show "XXXGB" or "XXXTB".	ints, the ma	nufacturer r	nay remove
LABL-5	underscore "_" b Example:	To distinguish Model Number and Serial Number, Barcode-1 shall have an underscore "_" between the Model Number portion and the Serial Number portion. Example:			
		DSSD-Example-Model-Number 321xxxxxxxxxxxxxxxxx			
	Barcod-1 Readou	it: DSSD-Example-Model-Numb	er_0321xxx	(XXXXXXXXXXXX	ΚX
LABL-6		ine with the text "STORAGE DE			
LABL-7	discretion of the such information	The following fields are optional information that can be placed on the label at the discretion of the device maker. Placement is also at the device makers discretion if such information does not interfere with the mandatory information above. No additional barcode shall be present.			
	Item	Format	Text Required	Barcode Required	Barcode Type
	Processor Code (BA)		Optional	No	N/A
	Maker Logo		Optional	No	N/A
	Rated Voltage & Current		Optional	No	N/A
	Production Date	DDMMYYYY: DD (Date), MM (Month), YYYY (Year)	Optional	No	N/A
	Weekly Code	YYWW: YY (Year), WW (Week)	Optional	No	N/A
	Warranty VOID IF REMOVED		Optional	No	N/A
	Makers Own Label Material Number		Optional	No	N/A
	Website, Company Address		Optional	No	N/A

Requirement		Description			
ID		Безаправи			
	SSD		Optional	No	N/A
	Product Series Name		Optional	No	N/A
	SA: Value used within manufacturing		Optional	No	N/A
	PBA: Physical Board Address (identifies the physical configuration of the device)		Optional	No	N/A
	WWN: World Wide Number (unique for each device)		Optional	No	N/A
LABL-8	To ensure that datacenter operations personnel can quickly and easily identify devices that have been ticketed for field replacement, it is mandatory to have the proper identifying fields on the label(s), in the format specified below.				
LABL-9	The label shall not degrade over the standard SSD lifetime under standard operating conditions.				
LABL-10	 For each formfactor, the label shall be placed as specified below: M.2: the label shall be placed on the top side of the device as defined in the PCI-Sig M.2 formfactor specification. E1.S: the label shall be placed on the Primary side of the device as defined in the SFF TA-1006 formfactor specification. E1.L: the label shall be placed on the either the Primary or Secondary side of the device as defined in the SFF TA-1007 formfactor specification. 				
LABL-11	The Model Number in Barcode-1, the Model Number printed on the label and the Model Number returned in Identify Controller Data Structure (CNS 01h, byte offset 63:24) shall all match unless exempted in writing by the customer.				
LABL-12	Serial Number re	The Serial Number in Barcode-1, the Serial Number printed on the label and the Serial Number returned in Identify Controller Data Structure (CNS 01h, byte offset 23:04) shall all match.			
LABL-13	This Hardware Reshall match.	vision printed on the label and	returned by	the NVMe	CLI utility
LABL-14		•	All other electronically readable information shall also match their counterparts printed on the label.		

Requirement ID	Description		
LABL-15	The following certifi	cation logos and their corresponding certifications are required:	
	Regulatory Mark/Text	Description	
	Regulatory Model Number	Unique regulatory Identifier.	
	Made in	Country of Origin.	
	Manufacturer or Brand name	Identification of the responsible party for placing the device into the market.	
	Address of the Manufacturer	Required for devices with the CE mark or UKCA mark.	
	Date of Manufacture	Not needed if embedded in the Serial Number.	
	Serial Number	Alpha-Numeric, 12-20 digits with the first 4 digits indicating: Date of Manufacturing in Work Week and Year WWYY1234567890123456.	
	Z	[Europe] Compliance with EU WEEE directive 2010/19/EU.	
	C€	[Europe] Compliance with EU EMC directive 2014/30/EU and RoHS directive 2011/65/EU.	
		[Australia, New Zealand] Compliance with requirements of the relevant Australian ACMA Standards, under the Radiocommunications Act 1992 and the Telecommunications Act 1997.	
	V©I	[Japan] Compliance with Japan VCCI requirements.	
	XXXX-XX-XX	[Korea] Compliance with requirements of the Radio Research Laboratory Ministry of Information and Communication Republic of Korea.	
	CAN ICES- 3(*)/NMB-3(*)	[Canada] Compliance with Canada standard ICES 003. Where * is either A or B.	
	Æ	[USA] Optional. Compliance with United States Federal Communications Commission requirement.	
	c Nus	[USA] Compliance with UL standards and Canadian Safety Standards.	

Requirement ID	Description		
	[Taiwan] Compliance with Taiwan EMC and RoHS.		
	[China] Compliance with Chinese environmental requirements. Number inside the circle is usually 10 or 20.		
	[Morocco] Compliance with Moroccan EMC standards.		
	UK [United Kingdom] Mandatory after 1/1/2022. Guidance to UKCA marking.		
LABL-16	If the surface of any component or casing will reach a temperature of 70°C (158°F) or greater the following warning logo shall be either printed on the label or placed separately on the device:		
LABL-17	The format of the Serial Number shall be WWYYSerialNumber with no leading spaces (e.g., WWYY1234567890123456).		
LABL-18	The Model Number shall have no leading spaces.		
LABL-19	Barcodes shall be printed using Datamatrix ECC200 or Model 2 QR code only.		
LABL-20	QR codes shall use a minimum of ECC Level M (15%).		
LABL-21	The density of the barcode shall be 10 mil or larger.		
LABL-22	The label shall only be printed on Polyester or Plastic labels using a Wax/Resin ribbon.		
LABL-23	The PSID shall be printed on the label in its direct 32-character alphanumeric representation without any ancillary delimiting characters (e.g., underscore, dash, backslash, forward slash, etc.) and shall exactly match the readout of Barcode-2.		

14 Compliance

14.1 ROHS Compliance

Requirement ID	Description
ROHS-1	The Supplier shall provide component-level reporting on the use of listed materials
	by concentration (ppm) for all homogenous materials.

14.2 ESD Compliance

Requirement ID	Description
	Device manufacturer needs to provide ESD immunity level (HBM- Human Body Model) measured in accordance with IEC-61000-4-2.

15 Shock and Vibration

Below are the shock and vibration specifications for storage devices:

Requirement ID	Description							
SV-1	he non-operational shock requirement is 700G, half-sine, 0.5ms, total 6 shocks, long all three axes (+/-).							
SV-2	The vibration requirement during operation is: 1.8G _{rms} , 5-500-5 Hz, Random Vibe, 20 min along all three axes.							
SV-3	The vibration requirement during non-operation is: 3.13G _{rms} , 5-800-5 Hz, total 6 sweeps along all three axes, 20 minutes per sweep.							
SV-4	 Validation flow for Shock and Vibration: UUT (Unit Under Test), test fixture should be visually inspected and ensured that everything is torqued or secured as needed. Pictures of test fixture with and w/o UUT should be provided. Baseline performance of device should be gathered and used as a reference against post S&V data to ensure no performance impact incurred. Once S&V testing is completed, repeat visual inspection to the UUT and test fixture to ensure no physical damage or performance impact has occurred to the UUT or test fixture. Re-run stress test on the UUT in case of non-op test and provide data indicating no performance impact incurred to the unit 							

16 Sustainability RequirementsThe following are the sustainability requirements for devices.

Requirement ID	Description
SUS-1	A Life Cycle Assessment (LCA) aligned with ISO 14040 for the device shall be provided to the customer.
SUS-2	Recycled content information per material type shall be provided to the customer.

17 NVMe Linux CLI Plug-In Requirements

17.1 NVMe CLI Management Utility

 $The \ NVMeCLI \ utility \ (https://github.com/linux-nvme/nvme-cli/tree/master/plugins/ocp) \ shall \ be \ used \ as \ one \ of \ the \ management \ utilities \ for \ NVMe \ devices.$

Requirement ID	Description
UTIL-1	The SSD supplier must test their SSDs with this utility and ensure compatibility. The following is the minimum list of commands that need to be tested with NVMeCLI: Format. Secure erase. FW update. Controller reset to load FW. Health status. Log page reads including vendor log pages. SMART status. List devices. Get/set features. Namespace management. Identify controller and namespace. Effects log page. Latency Monitoring.
	Latericy Monitoring.

17.1.1 NVMe CLI Plug-In FW Activation History Requirements

Requirement ID	Description						
UTIL-FWHST-1	A table with entries that indicate the history of Firmware activation on the device.						
UTIL-FWHST-2	Using the plugin command in <u>UTIL-NM-4 (vs-drive-info)</u> will retrieve the table.						
UTIL-FWHST-3	Lists the last twenty recorded Firmware Activation History Entries as defined in FWHST-LOG-3. Oldest entries are on top.						
UTIL-FWHST-4	When the device is first shipped from the factory, there are no entries recorded.						
UTIL-FWHST-5	Obsolete. See <u>FWHST-LOG-3</u> (<u>Firmware Activation History Entry shall be recorded</u>).						
UTIL-FWHST-6	Redundant activation events shall not generate a new entry to prevent the scrolling out of useful information. An entry is redundant if it meets ALL the criteria below: 1. POH is within 1 minute from the last RECORDED entry. 2. Power cycle count is the same. 3. Current firmware is the same. 4. New FW activated is the same. 5. Slot number is the same.						

Requirement ID	Description							
	6. Commit Action Type is the same.7. Results are the same.							
UTIL-FWHST-7	Firmware Activation History's output column headers shall follow the requirements below:							

Requirement ID	Firmware Activation History Column Header	Purpose
UTIL-FWHST-8	Firmware Activation Counter	Increments every time a firmware activation is attempted no matter if the result is good or bad. Shall be cleared to zero at factory exit.
UTIL-FWHST-9	Power on Hour	Displays the POH of the SSD when the new firmware activation is completed, and the SSD is running with the new firmware. Accuracy needs to be down to the second.
UTIL-FWHST- 10	Power Cycle Count	Display the power cycle count that the firmware activation occurred.
UTIL-FWHST- 11	Previous Firmware	Displays the firmware that was running on the SSD before the firmware activation took place.
UTIL-FWHST- 12	New Firmware Activated	Displays the activated firmware version that is running on the SSD after the firmware activation took place.
UTIL-FWHST- 13	Slot Number	Displays the slot that the firmware is being activated from.
UTIL-FWHST- 14	Commit Action Type	Displays the Commit action type associated with the firmware activation event.
UTIL-FWHST- 15	Result	Records the results of the firmware activation event. A passing event shall state a "Pass" for the result. A failing event shall state a "Failed" + the error code associated with the failure.

17.1.1.1 NVMe CLI Plug-In FW Activation History Example Outputs

FW Activation Examples:

Host FW download and activation events and initial states:

Initial State: Slot1 = 101

POH 1:00:00, PC 1, FW Commit CA = 011b Slot = 1 FW = 102 POH 2:00:00, PC 1, FW Commit CA = 001b Slot = 1 FW = 103

POH 3:00:00, PC 1, FW Commit CA = 001b Slot = 1 FW = 104

POH 4:00:00, PC 1, FW Commit CA = 001b Slot = 1 FW = 105

Reset

POH 4:00:30 Reset complete, FW 105 activated

POH 5:00:00, PC 1, FW Commit CA = 011b Slot = 1 FW = 106 POH 6:00:00, PC 1, FW Commit CA = 001b Slot = 1 FW = 107 Power Cycle POH 6:01:30 Power cycle complete, FW 107 activated POH 7:00:00, PC 2, FW Commit CA = 001b Slot = 1 FW = 108

NVMe-CLI Plugin Output:

Firmware Activation Counter	Power on Hours	Power Cycle Count	Previous Firmware	New FW Activated	Slot Number	Commit Action Type	Result
1	1:00:00	1	101	102	1	011b	Pass
2	4:00:30	1	102	105	1	001b	Pass
3	5:00:00	1	105	106	1	011b	Pass
4	6:01:30	2	106	107	1	001b	Pass

Repeated Activation Events examples:

Host FW download and activation events and initial states:

Initial State: Slot1=101

POH 1:00:01, PC 1, FW Commit CA=011b Slot=1 FW=102, pass

POH 1:00:10, PC 1, FW Commit CA=0011b Slot=1 FW=102, fail reason #1

POH 1:00:30, PC 1, FW Commit CA=0011b Slot=1 FW=102, fail reason #1 (not recorded)

difference is greater than 1 minute from the last recorded event)

POH 1:01:25, PC 1, FW Commit CA=0011b Slot=1 FW=102, fail reason #2 (recorded as the failure reason changed)

NVMe-CLI Plugin Output:

Firmware Activation Counter	Power on Hours	Power Cycle Count	Previous Firmware	New FW Activated	Slot Number	Commit Action Type	Result
1	1:00:01	1	101	102	1	011b	Pass
2	1:00:10	1	102	102	1	011b	Fail #1
3	1:01:15	1	102	102	1	011b	Fail #1
4	1:01:25	1	102	102	1	011b	Fail #2

18 Revision History

Revision	Date	Release Notes
1.0	03/16/2020	Initial release based on feedback from the industry.
1.0a	06/26/2020	Errata.
2.0	05/18/2021	Additional major features and requirements including Latency Monitoring, Device Capabilities, Unsupported Requirements, Datacenter SSD Power States, Multiple Namespaces, Sanitize, NVMe-MI, Write Zeroes, Compare, Fused, Write Uncorrectable, Device Profiles, SPDM and additional security requirements, etc.

Appendix A - Facebook Specific Items

The following items apply specifically to devices delivered to Facebook.

A.1 Configuration Specifics

Requirement ID	Description							
FB-CONF-1	Obsolete.							
FB-CONF-2		IEEE 1667 shall not be supported. Devices shall not support Enable IEEE1667 Silo (Feature Identifier C4h) Set Feature or Enable IEEE1667 Silo (Feature Identifier C4h) Get Feature.						
FB-CONF-3		For all form factors, SMBus byte 91 bit 6, Firmware Update Enabled bit shall be set to 1b by default from the factory.						
FB-CONF-4	Devices shall not so	upport Error In	jection (Feature Identifier C0h) Set Feature.					
FB-CONF-5	Devices shall not so	upport Error In	jection (Feature Identifier C0h) Get Feature.					
FB-CONF-6	Devices shall not so	upport Error Re	ecovery (Log Identifier C1h).					
FB-CONF-7	All Telemetry and	debugging logs	can be either in binary or ASCII.					
FB-CONF-8	The default power	state shall con	form to the following table:					
	Form Factor	Capacity	Default Power State Upon Factory Exit					
	E1.S	E1.S <= 2TB 6 (12W)						
	>= 4TB 5 (14W)							
FB-CONF-9	Devices shall be configured to Configuration Setting A as shown in Section 12 - Device Profiles.							

A.2 Performance Requirements

The following numbers are the Facebook performance targets for data storage SSD across all form factors. They are provided to serve as a guidance for SSD Vendors. Performance scripts can be found on GitHub at https://github.com/facebookincubator/FioSynth.

The targets are broken down into the following segments:

Requirement ID	Description								
FB-PERF-1	FB-FIO Syr	nth Flash Targets (fo	r all capacities).						
FB-PERF-2	fb-FIOSyn	thFlash TRIM Rate ta	argets.						
FB-PERF-3	IO.go ben	chmark target.							
FB-PERF-4	Fileappen	d benchmark target.							
FB-PERF-5	Sequentia	l write bandwidth.							
FB-PERF-6	Cache ber	nch target.							
FB-PERF-7	All targets	shall be achieved by	y using "kyber" as the I/O scheduler.						
FB-PERF-8	. • • • • • • • • • • • • • • • • • • •	Form Capacity Max Average Power Consumption to Achieve All Performance Targets							
	M.2	2TB and smaller	8.5W						
	E1.S	2TB and 10W E1.S smaller							
		4TB 12W							
			hodology is described in <u>PCM-1 (device max average ower)</u> , and <u>PCM-3 (peak power limit)</u> .						

A.2.1 Performance Targets for FB-FIO Synth Flash - HE_Flash_Short_TRIM_2H20 (for all capacities)

Syntax: fb-FioSynthFlash -w HE_Flash_Short_wTRIM_2H20 -d ALL - f HE_Flash_Short_wTRIM_2H20_results

Workload	Read MiB/s per TB	Write MiB/s per TB	TRIM BW per TB	P99 Read Latency	P99.99 Read Latency	P99.9999 Read Latency	Max Read Latency	P99.99 Write Latency	P99.9999 Write Latency	Max Write Latency
4K_L2R6D WPD_wTRI M	68 MiB/s	72 MiB/s	117 MiB/s	2,000 us	5,000 us	8,500 us	15,000 us	15,000 us	25,000 us	30,000 us
4K_L2R9D WPD_wTRI M	68 MiB/s	93 MiB/s	156 MiB/s	2,200 us	5,500 us	9,500 us	15,000 us	15,000 us	25,000 us	30,000 us
MyRocks_H eavy_wTRI M	210 MiB/s	101 MiB/s	22 MiB/s	2,000 us	5,000 us	8,500 us	15,000 us	10,000 us	20,000 us	25,000 us
Fleaf	320 MiB/s	87 MiB/s	89 MiB/s	3,000 us	6,000 us	10,000 us	15,000 us	20,000 us	25,000 us	30,000 us

A.2.2 Performance Targets for FB-FIO Synth Flash – Cache_2H20 Syntax: fb-FioSynthFlash -w Cache_2H20 -d ALL - f Cache_2H20

Workload	, .	Write MiB/s per TB		P99 Read Latency	P99.99 Read Latency	P99.9999 Read Latency	Max Read Latency	P99.99 Write Latency	P99.9999 Write Latency	Max Write Latency
B_Cache	164 MiB/s	96 MiB/s	0 MiB/s	2,000us	5,500 us	15,000 us	20,000 us	20,000 us	25,000 us	30,000 us

A.2.3 Performance Targets for FB-FIO Synth Flash — Search_2H20

Syntax: fb-FioSynthFlash -w Search_2H20 -d ALL - f Search_2H20

Workload	Read MiB/s per Node	Write MiB/s per Node	TRIM MiB/s per Node	P99 Read Latency	P99.99 Read Latency	P99.9999 Read Latency	Max Read Latency	P99.99 Write Latency	P99.9999 Write Latency	Max Write Latency
SearchLM_ wTRIM	2,550 MiB/s		130 MiB/s	,	10,000 us	15,000 us	20,000 us	20,000 us	25,000 us	30,000 us

A.2.4 Performance Targets for FB-FIO Synth Flash - WSF

Syntax: fb-FioSynthFlash -w WSF -d ALL - f WSF

Workload	, -	Write MiB/s per TB		P99 Read Latency	P99.99 Read Latency	P99.9999 Read Latency	Max Read Latency	P99.99 Write Latency	P99.9999 Write Latency	Max Write Latency
wsf-t- heavy	4.4 MiB/s	35.5 MiB/s	76.9 MiB/s	400 us	2,800 us	3,000 us	3,300 us	3,700 us	4,200 us	5,000 us

A.3 Trim Rate Targets

- This test measures raw trim performance which no background I/O
- 64M trim >= 50GiB/s & <= 10ms P99 trim latency
- 3GB trim >= 500GiB/s & <= 10ms P99 trim latency

A.4 IO.go Benchmark Targets

- This test measures how long the file system is blocked from writing/overwriting a file while a different file is deleted
- Less than 4 file sizes total with latency outliers > 10ms
- No more than 2 latency outliers per file size
- No single latency outlier above 15ms

A.5 Fileappend Benchmark Targets

- This test measures how long the file system is blocked from appending to a file while a different file is deleted.
- No measurable stalls reported by this tool

• Max acceptable latency outlier is 10ms when deleting 1GiB or 2GiB file

A.6 Sequential Write Bandwidth

- Full device (all available user capacity, all namespaces) must be written/filled in 180 minutes or less
- Simple single-threaded sequential write FIO script to fill device

A.7 Cache bench target

- A benchmarking tool that's a supplement for FB FIO Synth Flash tool on measuring performance for cache applications. This is different than the "B Cache" workload in FB FIO Synth Flash.
- Two workloads need to be tested:
 - o Tao Leader
 - o Memcache
- The final allocator and throughput stats from the benchmark will be used to see if the targets are met.
- Send SSD latency versus time file to Facebook using one of the following methods:
 - o Send the raw results log file
 - Run the "extract_latency.sh script and return the raw results log file, ".tsv" and ".png" files
- Vendor NVMe CLI plug-in with "physical NAND bytes written" metric in the SMART / Health Information Extended (Log Identifier C0h) needs to be working to get the write amplification.

Workload	Get	Set		Rea	d Latency	(us)		Write Amp
vvoikioau	Rate	Rate	P50	P90	P99	P99.99	Max	write Amp
Tao Leader	87,000	16,000	100	300	800	3,000	12,000	1.3
Memcache WC	3,200	1,500	300	700	2,000	14,000	15,000	1.4
Workload	Get	Set		Writ	te Latency	(us)		Muito Amon
workload	Rate	Rate	P50	P90	P99	P99.99	P100	Write Amp
Tao Leader	87,000	16,000	30	50	100	700	8,000	1.3
Memcache WC	3,200	1,500	100	200	400	7,000	8,000	1.4

A.8 Max Latency Targets

This requirement aims to ensure the max latency for reads/writes are within certain bounds even as workload rate scales. We expect the workloads contained in this section to not exceed the max latency requirements defined here.

Workload	Max Read Latency (ms)	Max Write Latency (ms)
HE_Flash_Short_wTRIM_Sweep	65	85
Search_Sweep	65	85

Cache_Sweep	65	85

Appendix B - Microsoft Specific Items

The following items apply specifically to Microsoft.

B.1 Configuration Specifics

Requirement ID	Description
MS-CONF-1	E1.S form factor devices and M.2 form factor devices shall be formatted to 512-byte sectors from the factory.
MS-CONF-2	E1.L form factor devices shall be formatted to 4096-byte sectors from the factory.
MS-CONF-3	IEEE-1667 shall be supported.
MS-CONF-4	Obsolete.
MS-CONF-5	Obsolete.
MS-CONF-6	For all devices, SMBus byte 91 bit 6, Firmware Update Enabled bit shall be set to 1b (Firmware Update is Enabled) by default from the factory.

Appendix C – Latency Monitoring Feature Set Theory of Operation

C.1 Overview

Latency outliers are very undesirable in the data center. The goal of this feature is to allow production monitoring of SSD QOS outliers and to debug outlier issues in production. This feature will allow suppliers and hyperscale companies to clearly understand if the outliers are caused by the SSD or other components in the Host system. This feature enables SSD suppliers to effectively debug latency issues efficiently. This feature will enable predicting when latency outliers are growing and likely to impact hyperscale customers. This feature enables many use cases involving understanding and debugging latency issues at scale in a production environment.

C.2 Functional Operation

C.2.1 Latency Monitoring Feature Description

Below is the high-level theory of operation describing how the Latency Monitoring feature works. Latency of an individual command shall be measured from the time a controller fetches the command from the SQ to the time when controller writes the CQ entry for the SQ entry it fetched.

C.2.2 Bucket Description Overview

There are two types of buckets Active Buckets and Static Buckets. Active Buckets are buckets that are updated in real time. Static Buckets are buckets which are loaded with snapshots from the Active Buckets. This is a move from the Active Buckets to the Static Buckets, thus the old values in the Static

Buckets are discarded. The Static Buckets allow hyperscale users to sample the Static Buckets over a fixed time period to gather statistics.

C.2.3 Active Bucket Description

The high-level concept is to create 4 real time buckets groups of active latency tracking command counters. Each bucket will count latency events which exceed a configured latency threshold. Below is a description of each bucket:

Bucket Structure

Bucket Description

- Saturating Read Command Counter
 - Measured Latency
 - Latency Timestamp
- Saturating Write Command Counter
 - Measured Latency
 - Latency Timestamp
- Saturating De-allocate/TRIM Command Counter
 - Measured Latency
 - Latency Timestamp

Each bucket contains the following:

- Saturating Read Command Counter with an associated Measured Latency and Latency Timestamp.
- Saturating Write Command Counter with an associated Measured Latency and Latency Timestamp.
- Saturating De-allocate/TRIM Command Counter with an associated Measured Latency and Latency Timestamp.

For clarity, the opcode to Counter mapping is below:

Bucket Counter	Opcode	Command
Read Command Counter	02h	Read
Write Command Counter	01h	Write

Bucket Counter	Opcode	Command
De-allocate/TRIM Command Counter	09h with	Dataset Management
	Attribute – Deallocate (AD) = 1	

In addition to the command counters there is a Measured Latency data structure and a Latency Timestamp data structure associated with each command counter. The Measured Latency and Latency Timestamp have a direct relationship such that both are updated, or neither are updated. The Measured Latency and Latency Timestamp will be described later in this document.

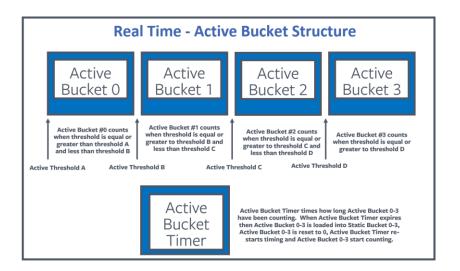
C.2.3.1 Active Command Counter Behavior

The active command counters count Read commands, Write commands, and De-Allocate/TRIM commands which exceed a configured latency threshold. These active command counters count until the command counter saturates or the Active Bucket Timer expires. Below is the behavior for each of these events:

- Active Command Counter Saturation:
 If the Command Counter saturates, the counter shall maintain the active value and not wrap.
- Active Bucket Timer Expiration:
 If the Active Bucket Timer Expires, then the following occurs:
 - The Active Bucket Command Counter values and associated information are moved into Static Bucket Command Counters, the Active Bucket Command Counters are then cleared to zero and restart counting.
 - The active command counters shall count regardless of how the Active Latency Minimum Window is configured.

C.2.3.2 Active Bucket Thresholds

There are multiple Active Command Counter Buckets. The configured latency thresholds determine which Bucket the command counter shall be incremented in. Below is a picture showing how there are multiple Buckets and thresholds for each Bucket.



If the Read, Write, De-allocate/TRIM command completion time is below Threshold A then no counter is incremented. If the threshold is equal or greater than A and less than B, then the corresponding command counter in Active Bucket 0 increments. If it is equal to or greater than B and less than threshold C, then the corresponding command counter in Active Bucket 1 increments. If it is equal to or greater than C and less than threshold D, then the corresponding command counter in Active Bucket 2 increments. If it is equal to or greater than threshold D, then the corresponding command counter in Active Bucket 3 increments. By following this process all latencies greater than threshold A are counted for Read, Write and De-Allocate/TRIM commands. When configuring the Latency Monitor Feature the thresholds shall always be configured such that Active Threshold A < Active Threshold B < Active Threshold D.

C.2.3.3 Active Bucket Timer Behavior

The Active Bucket Timer times how long the Bucket Command Counters have been counting. When the Active Bucket Timer is equal to the Active Bucket Timer Threshold then the following operations shall occur:

- 1. The following data is moved:
 - a. Active Bucket Counters 0 3 is moved to Static Bucket Counters 0 3.
 - b. Active Latency Timestamps are moved to Static Latency Timestamps.
 - c. Active Measured Latencies are moved to Static Measured Latencies.
 - d. Active Latency Timestamp Units are moved to Static Latency Timestamp Units.
- 2. The Active Bucket items shall then be updated as follows:
 - a. Active Bucket Counters 0 3 are cleared to zero.
 - b. Active Latency Timestamps are set to invalid (FFFF_FFFF_FFFFh).
 - c. Active Measured Latencies are cleared to zero.

- d. Active Latency Timestamp Units are cleared to zero.
- e. The Active Latency Minimum Window, if it is running, may be reset or continue to
- f. Active Bucket Timer is cleared to zero and starts the process of counting over.

When looking at the data structures in the Latency Monitor (Log Identifier C3h) it should be noted that the data in item #1 and #2 above is 16-byte aligned, and the data can be moved simply by doing a data move of the entire data structure.

C.2.3.4 Active Latency Timestamp Format

The format of the Latency Timestamp follows the Timestamp data structure which is defined in the NVMe Specification. The Latency Timestamp allows an understanding of where a latency excursion occurred in terms of wall clock time. The Latency Timestamp time reported shall be based on CQ completion.

If the device receives a Timestamp Set Features (Feature Identifier 0Eh), then the device shall use this baseline wall clock time plus the time in milliseconds since the Timestamp was set to determine the Latency Timestamp of the latency event. If the device receives multiple Timestamp Set Feature (Feature Identifier 0Eh) the most recent Timestamp shall be used as the baseline.

If the device does not receive Set Features with a Timestamp, then the Latency Timestamp shall be generated based on Power on Hours.

If the device receives a Set Features with a Timestamp and then the device is powered off. When the device is powered on it shall use the most recent Timestamp it received even if this Timestamp was from before the device was powered off.

The Active Latency Timestamp Units shall be populated when the Latency Timestamp is updated to indicate if the Latency Timestamp used Timestamp with Power on Hours to generate the Latency Timestamp or if only Power on Hours were used to generate the Latency Timestamp.

C.2.3.5 Active Measured Latency and Active Latency Timestamp Updates

The Active Measured Latency is the latency measured from fetching the command in the SQ to updating the CQ. The Active Measured Latency data structure and the Active Latency Timestamp data structure shall be updated atomically. They shall not update independently. Each Command Counter (Read/Write/De-Allocate) has an Active Measured Latency and an Active Latency Timestamp structure associated with it. The Active Latency Configuration is used to configure this feature.

When the Latency Mode in the Active Latency Configuration is cleared to zero then the following behavior shall be followed:

- The Active Measured Latency and Active Latency Timestamp will be loaded the first time the command counter associated with it increments.
- The Active Measured Latency and Active Latency Timestamp will not be loaded again until the Active Measured Latency is reset.

If the Latency Mode is set to 0001h in the Active Latency Configuration, then every time the associated command counter is incremented the Active Measured Latency will report the largest measured latency

based on the associated command counter. The Active Latency Timestamp will report the time when the largest latency occurred.

The Active Latency Minimum window also affects when the Active Measured Latency and the Active Latency Timestamp are updated. This is described in the section on Active Latency Minimum Window.

C.2.3.6 Active Latency Minimum Window

This affects both the Active Measured Latency and the Active Latency Timestamp. This defines the minimum time between updating the Active Measured Latency and the Active Latency Timestamp for a single Active Bucket/Counter combination. The feature is only used if the Active Latency Mode is set to 0001h.

If the Active Latency Minimum Window timer is running and the Measured Latency and Latency Timestamp have been updated, then the Latency Timestamp and Active Measured Latency will not be updated again until the Active Latency Minimum Window timer has expired. Below are some examples of this:

Example 1:

Assume:

- Active Latency Minimum Window of 5 seconds.
- Latency Mode is Configured for Largest Latency.
- Bucket 2 has a threshold range of 40ms to 400ms.

Time in seconds	Read Counter Bucket 2 Latency Event	Active Read Counter Bucket 2 Value	Actual Latency	Active Measured Latency	Latency Stamp	Comment
0	N	0	-	-	_	Actual Latency and Active Measured latency are invalid.
0.5	Y	1	50ms	50ms	0.5 Seconds	First Latency Event. This starts the Active Latency Minimum window. New latency events will not be recorded until the 5 second Active Minimum Window expires at 5.5 seconds.
5.25	Y	2	100ms	50ms	0.5 Seconds	Measured Latency and Latency Timestamp is not updated due to Minimum Window is not expired;

Time in seconds	Read Counter Bucket 2 Latency Event	Active Read Counter Bucket 2 Value	Actual Latency	Active Measured Latency	Latency Stamp	Comment
						however, the Active Read Counter is updated.
6	Y	3	75ms	75ms	6 Seconds	Minimum Window is expired and 75ms is greater than previous number of 50ms, so the Active Measured Latency and Latency Timestamp are updated.

Example 2:

Assume:

- Active Latency Minimum Window of 5 seconds.
- Latency Mode is Configured for First Latency Event.
- Bucket 2 has a threshold range of 40ms to 400ms.

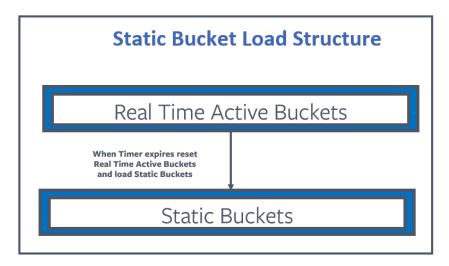
Time in seconds	Read Counter Bucket 2 Latency Event	Active Read Counter Bucket 2 Value	Actual Latency	Active Measured Latency	Latency Stamp	Comment
0	N	0	-	-	_	Actual Latency and Active Measured latency are invalid.
0.5	Υ	1	150ms	150ms	0.5 Seconds	First Latency Event.
10	Υ	2	200ms	150ms	0.5 Seconds	Since the device is in First Latency Event mode, no additional events are recorded.
15	Υ	3	75ms	150ms	0.5 Seconds	Since the device is in First Latency Event mode, no additional events are recorded.

The Active Latency Minimum Window acts as a filter to ensure there are not a large number of events to update the Active Measured Latency and the Latency Timestamp. Thus, if the queue depth is 128

commands deep and there is a latency event, then there are not 128 updates to these data structures. Rather the first event is recorded, and the rest of the events are filtered out. It should be noted that the Active Latency Window is not enforced across power cycles. Thus, after a power cycle the Active Latency Window shall not start until a Bucket Counter is incremented.

C.2.3.7 Static Bucket Description

In addition to the real time buckets there are static buckets. When the Active Bucket Timer reaches its configured threshold (Active Bucket Timer Threshold) the active real time buckets shall be loaded into the static buckets and the active real time buckets shall be reset and start counting from 0. Below is a picture describing this:



C.3 Persistence Across Power Cycles

When either a safe or unsafe power transition happens the counters and associated Latency Monitoring Information shall be saved such that they can be restored on the next power up transition and continue from where the power cycle left off. There are additional details about this in the C.5 Latency Monitoring Feature - Challenging Event Handling section.

C.4 Debug Logs

The Latency Monitoring Feature can also enable debug logs to trigger. The Debug Log Trigger Enable configures which counters shall trigger a debug log the first time the Bucket/Counter combination is incremented. Only a single debug log shall be generated. Once a Latency Monitor debug log is generated, until the Latency Monitor debug log is discarded another Latency Monitor debug log cannot be generated. The Latency Monitor debug log shall be discarded using Set Features for the Latency Monitor or by reading the Latency Monitor Debug Log.

The Set Features for the Latency Monitor has two mechanisms for discarding the Debug Log. One method discards the debug log and resets the Latency Monitor feature to a new set of configured values based on the fields in Set Features. The other method discards the Debug Log and has no effect on any of the other features associated with the Latency Monitor Feature. Thus, the Latency Monitor Feature will keep running undisturbed when the Debug Log is discarded.

When the Latency Monitor debug log trigger event happens, the following data shall be captured: Debug Log Measured Latency, Debug Log Latency Timestamp, Debug Log Trigger Source, Debug Log Timestamp Units, Debug Log Pointer as well as internal information required to debug the issue to root cause.

C.5 Latency Monitoring Feature - Challenging Event Handling

C.5.1 Power Off/On When Latency Monitoring Feature is Enabled

When powering off, the Active Bucket Information (Counters, Measured Latency, Latency Timestamp, Active Bucket Timer) may be slightly off due to concerns with flushing data with unsafe power down. The Active Bucket Information shall maintain coherency compared to itself when flushing data with unsafe power down. When the device powers back on the Latency Monitoring Feature shall restore the Active/Static Bucket/Debug Information including loading the Active Bucket Counter. Once the restoration is complete then the device shall resume the Latency Monitor functionality. The device shall start capturing latency data within 2 minutes of power on. Thus, commands for the first 2 minutes may not be monitored. The Active Latency Window is not enforced across power cycles. Thus, after a power cycle the Active Latency Window shall not start until a Bucket Counter is incremented.

C.5.2 Power Off/On When Latency Monitoring Feature is Disabled

The Latency Monitoring Feature disabled/enabled state shall be persistent across power cycles. When the Latency Monitor Feature is enabled the associated Latency Monitor configuration information in the Latency Monitor Log shall persist across power cycles.

C.5.3 Moving Information from Active to Static Buckets

When moving data from the active buckets to static buckets it can be challenging to track all the information. The Active counter shall restart counting no longer than 3 seconds from moving data from Active to Static Counters.

C.5.4 Firmware Update

When activating new firmware, if the Latency Monitoring Feature is enabled, the firmware activation shall reset the Latency Monitoring Feature just as if a Set Features command to enable the feature was received. The Latency Monitoring Log shall start updating properly within 2 minutes of firmware activation completing. Thus, there are command latencies which could be missed after initially activating new firmware.

C.6 Configuring Latency Monitoring

Set Features is used to configure this feature. When Set Features is used to configure this feature all the data structures in both the Active and Static Buckets are reset. The debug log and related debug information is reset based on the Discard Debug Log Field.